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(54) **SPACE ENVIRONMENTALLY DURABLE
POLYIMIDES AND COPOLYIMIDES**

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This patent is subject to a terminal dis-
claimer.

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8, 2002, now Pat. No. 6,841,652.
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17, 2001.

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C08G 69/26 (2006.01)

(52) **U.S. Cl.** **528/337; 528/352; 528/353**
(58) **Field of Classification Search** **528/337,**
528/352, 353

See application file for complete search history.

(56) **References Cited**
U.S. PATENT DOCUMENTS

6,342,638 B1 * 1/2002 Yoon et al. 568/14
6,841,652 B1 1/2005 Connell et al.

* cited by examiner

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(57) **ABSTRACT**

Polyimides displaying low color in thin films, atomic oxy-
gen resistance, vacuum ultraviolet radiation resistance, solu-
bility in organic solvents in the imide form, high glass
transition (T_g) temperatures, and high thermal stability are
provided. The poly(amide acid)s, copoly(amide acid)s, poly-
imides and copolyimides are prepared by the reaction of
stoichiometric ratios of an aromatic dianhydride with
diamines which contain phenylphosphine oxide groups in
polar aprotic solvents. Controlled molecular weight oligo-
meric (amide acid)s and imides can be prepared by offsetting
the stoichiometry according to the Carothers equation using
excess diamine and endcapping with aromatic anhydrides.
The polyimide materials can be processed into various
material forms such as thin films, fibers, foams, threads,
adhesive film, coatings, dry powders, and fiber coated
prepreg, and uses include thin film membranes on antennas,
second-surface mirrors, thermal optical coatings, and multi-
layer thermal insulation (MLI) blanket materials.

68 Claims, No Drawings

1

SPACE ENVIRONMENTALLY DURABLE POLYIMIDES AND COPOLYIMIDES

CLAIM OF BENEFIT OF APPLICATION

This application is a divisional application of commonly-owned patent application Ser. No. 10/095,340, filed Mar. 8, 2002 now U.S. Pat. No. 6,841,652, which, pursuant to 35 U.S.C. § 119, claimed the benefit of priority from provisional application 60/292,262, with a filing date of May 17, 2001.

ORIGIN OF INVENTION

This invention was made in part by employees of the United States Government and may be manufactured and used by or for the Government of the United States of America for government purposes without payment of any royalties thereon or therefore.

BACKGROUND OF THE INVENTION

Thin films from relatively high molecular weight aromatic polyimides generally exhibit toughness, flexibility, solvent resistance, high glass transition temperatures (T_g) and thermal stability. In many cases these materials, due to their aromatic structure exhibit good ultraviolet (UV) radiation resistance; however they also display significant color (D. Wilson, H. D. Stenzenberger and P. M. Hergenrother, "Polyimides", Blackie and Son, Glasgow and London, 1990). Kapton® polyimide film is a good example of the typical amber color exhibited by thin films. No commercially available polyimides are resistant to degradation by atomic oxygen exposure. The preparation of low color polyimides that are UV resistant has been reported (A. K. St. Clair, T. L. St. Clair and W. S. Slomp "Recent Advances in Polyimide Science and Technology", W. Weber and M. Gupta, eds., Society of Plastics Engineers, Poughkeepsie, N.Y. 1987, pp. 16-36; A. K. St. Clair and W. S. Slomp, *SAMPE Technical Conference Proceedings*, 23, 1991; U.S. Pat. Nos. 4,595,548 and 4,603,061 issued Jun. 17, 1986 and Jul. 29, 1986, respectively to National Aeronautics and Space Administration). However none of these polyimides are resistant to atomic oxygen or oxygen plasma degradation.

Some reports detail the preparation of polyimides which contain phenylphosphine oxide units in the polymer backbone (I. K. Varma, G. M. Fohlen and J. A. Parker, *Journal of Macromolecular Science-Chemistry*, A19(2), 209 (1983); I. K. Varma and B. S. Rao, *Journal of Applied Polymer Science*, 28, 2805 (1983); I. K. Varma, G. M. Fohlen and J. A. Parker *Journal of Polymer Science Polymer Chemistry Edition*, 28, 2017 (1983); P. M. Hergenrother and S. J. Havens, *Journal of Polymer Science, Polymer Chemistry Edition*, 27, 1161 (1987); U.S. Pat. No. 5,145,937 issued 1992 to the National Aeronautics and Space Administration). Recent reports show that phosphine oxide containing poly(arylene ether)s exhibit atomic oxygen and oxygen plasma resistance [C. D. Smith, H. F. Webster, A. Gungor, J. P. Wightman and J. E. McGrath, *High Performance Polymers*, 3(4), 211 (1991); J. W. Connell, J. G. Smith, Jr. and P. M. Hergenrother, *Journal of Fire Science* 11, 137 (1993); J. G. Smith, Jr., J. W. Connell and P. M. Hergenrother, *Polymer*, 35, 2834 (1994)]. This was extended to show that polyimides containing phosphine oxide groups were also atomic oxygen and oxygen plasma resistant [(J. W. Connell, J. G. Smith, Jr. and P. M. Hergenrother, *Polymer*, 36, 5 (1995); J. W. Connell, J. G. Smith, Jr. and P. M. Hergenrother, *Poly-*

2

mer, 36, 13 (1995)]. Other polyimides containing phosphine oxide groups have been reported [J. E. McGrath, H. Grubbs, M. E. Rogers, A. Gungor and W. A. Joseph, *SAMPE Technical Conference Proceedings*, 23, 119 (1991); J. M. Wescott, T. Toon, L. Kiefer and J. E. McGrath, *Polymer Preprints*, 33(2), 235 (1992); Y. N. Lin, S. Joardar and J. E. McGrath, *Polymer Preprints*, 34(1), 515 (1993)]. However, in all of these reports, the polyimides containing phosphine oxide groups exhibited high color that ranged from orange to brown and consequently they exhibited poor optical transparency and relatively high solar absorptivities.

The present invention constitutes new compositions of matter, which exhibit unique and unexpected combinations of properties. It concerns new diamines and dianhydrides that contain phenylphosphine oxide groups and polyimides and copolyimides prepared therefrom. The polymers prepared from these aromatic diamines and aromatic dianhydrides exhibit an unexpected combination of properties that include low color in thin film form (1-2 mils thick), low solar absorptivity, high optical transparency, atomic oxygen resistance, vacuum UV radiation resistance, solubility in organic solvents in the imide form, high T_g , and high thermal stability. These compositions of matter are also useful as adhesives, coatings, films, fibers, foams, moldings, powders, prepregs and composite matrices.

SUMMARY OF THE INVENTION

Polyimides with a unique, heretofore unprecedented combination of properties have been prepared and characterized. The combination of properties includes low color in thin films, atomic oxygen resistance, vacuum ultraviolet radiation resistance, solubility in organic solvents in the imide form, high glass transition (T_g) temperatures and high thermal stability. These materials are based on aromatic diamines and aromatic dianhydrides that contain phenylphosphine oxide groups. Polyimides were prepared by reacting the compounds with appropriate aromatic monomers using a 1:1 stoichiometry. Poly(amide acid)s were prepared by reacting the monomers in polar aprotic solvents. The poly(amide acid) solutions were used to cast thin films and to prepare polyimides by heating the solution in the presence of an azeotropic agent or by treatment with a dehydrating agent and catalyst at room temperature. In some cases the polyimides were synthesized in m-cresol. Copoly(amide acid)s and copolyimides were prepared using these phenylphosphine oxide monomers as well. In many cases, soluble polyimides were obtained. The solubility of the materials in the imide form was dependent upon the polymer chemical structure. Thin films (1-2 mils thick) prepared by solution casting of amide acid or imide solutions exhibited very low color as evidenced by visual observation and measurement of solar absorptivity as well as high optical transparency (>85%). The polyimides exhibited T_g s > 200° C. depending upon chemical structure. Due to their unique combination of properties, these polyimides are useful in a variety of applications on spacecraft in all orbits. Examples of the applications include thin film membranes on antennas, second-surface mirrors, thermal optical coatings, sunshades, various components of deployable spacecraft and multi-layer thermal insulation (MLI) blanket materials. They can be processed into various material forms such as thin films, fibers, foams, threads, adhesive film, coatings, dry powders, and fiber coated prepreg.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

According to the present invention, the objects of the invention herein described can be obtained by synthesizing aromatic diamines (Equations I–VII) and aromatic dianhydrides containing phenylphosphine oxide groups (Equations VIII and IX), as further discussed in detail in this section. The present invention concerns new compositions of matter comprised of aromatic diamines and aromatic dianhydrides containing phenylphosphine oxide groups and polyimides and copolyimides prepared therefrom. These polyimides exhibit a unique and unprecedented combination of properties including low color in thin film form (1–2 mils thick), low solar absorptivity, high optical transparency, atomic oxygen resistance, vacuum ultraviolet (VUV) radiation resistance, solubility in organic solvents in the imide form, high T_g s, and high thermal stability. This combination of properties makes these materials particularly useful in the fabrication of space durable spacecraft components such as multi-layer thermal insulation blankets (MLIs), thermal control coatings, sewing threads, adhesive tape, tethers, optical lenses, protective films, insulating foams, molded parts, and fiber reinforced parts.

The synthesis of the diamines and dianhydrides is a key feature of this invention. They are prepared from commercially available starting materials in two or more steps with relatively good yield and purity (Equations I–IX). The diamines and dianhydrides possess specific features that impart atomic oxygen resistance, low color, low solar absorptivity, high optical transparency, and solubility into the resulting polyimides and copolyimides. The diamines and dianhydrides are subsequently used to prepare poly (amide acid)s, polyimides and random copolyimides that have a particularly desirable combination of properties for applications on spacecraft. It should be understood that, in the context of the claims, the term “diamine-derived” when modifying the term “divalent radical(s),” means divalent radicals derived from diamines according to the teachings disclosed herein, and the term “dianhydride-derived,” when modifying the term “tetraivalent radical(s),” refers to tetraivalent radicals derived from dianhydrides according to the teachings disclosed herein. The products derived therefrom include, but are not limited to, films, fibers, moldings, adhesives, composites, and foams.

The diamine represented in Equation I gives particularly good results when used to prepare poly (amide acid)s, copoly (amide acid)s, polyimides and copolyimides. The poly (amide acid)s, copoly (amide acid)s, polyimides and copolyimides are prepared by the reaction of stoichiometric ratios of an aromatic dianhydride with the diamines in polar aprotic solvents (Equation IX). Controlled molecular weight oligomeric (amide acid)s and imides can be prepared by offsetting the stoichiometry according to the Carothers equation using excess diamine and endcapping with aromatic anhydrides. In an analogous fashion, copoly (amide acid)s and copolyimides were prepared by reacting the novel diamines with another diamine and a dianhydride and by reacting the diamines containing phenylphosphine oxide groups with two different dianhydrides.

Polyimides are prepared from the poly (amide acid) solutions by cyclodehydration using several techniques. For example, poly (amide acid) solutions can be heated in the presence of an azeotroping agent such as toluene using a moisture trap to remove water. The poly (amide acid) solutions can also be treated with dehydrating agents such as pyridine and acetic anhydride at room temperature to effect

imidization. Alternative synthetic routes to prepare the polyimides described herein can be employed such as reacting the diamine and dianhydride in m-cresol containing isoquinoline at elevated temperatures. They can be prepared by reacting the half alkyl ester of an aromatic dianhydride with the diamine containing phenylphosphine oxide groups by melt polymerization or in solvents such as methanol or m-cresol. In addition, the polymerization of monomeric reactants approach can be utilized whereby the half alkyl ester of an aromatic dianhydride is reacted with the diamine containing phenylphosphine oxide groups.

The polymers were characterized for physical and mechanical properties in the form of amide acid solutions, imide powders and thin films. Inherent viscosities ranged from 0.26 to 1.07 dL/g indicating medium to high molecular weight. The T_g s ranged from 203 to 251° C. These values are typical for aromatic polyimides.

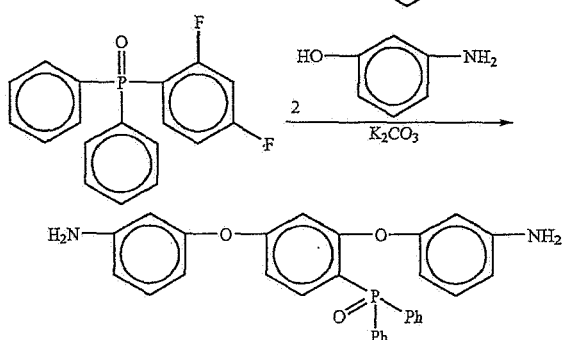
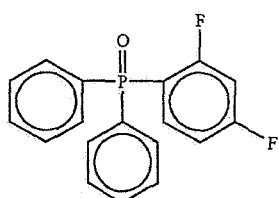
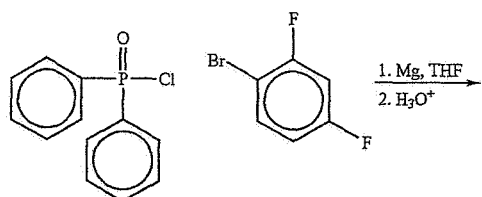
Thin films were cast from amide acid and/or imide solutions and thermally treated in a forced air oven to imidize and/or remove solvent. Most of the films were tough, creasable and exhibited low color. The color of the thin films (~1.5 mil thick) ranged from light yellow to colorless and were dependent upon chemical structure. The films exhibited room temperature tensile strengths and moduli from 79 to 113 MPa and 2.46 to 3.53 GPa, respectively. The elongations to break ranged from 3.1 to 9.7 with one example breaking at 40% elongation. These values are comparable to other aromatic polyimides.

Imidized thin film samples were measured for optical transparency using ultraviolet/visible spectroscopy. Most of the films exhibited optical transparencies in excess of 85% at 500 nm. All films were clear to pale yellow in color depending on the chemical structure and to some degree on film thickness. The films exhibited low solar absorptivities (α) and relatively high thermal emissivities (ϵ). Solar absorptivities were measured on a Aztek Model LPSR-300 spectrophotometer with measurements taken between 250 to 2800 nm with a vapor deposited aluminum on Kapton® as a reflective reference. An Aztek Temp 2000A Infrared reflectometer was used to measure the thermal emissivity.

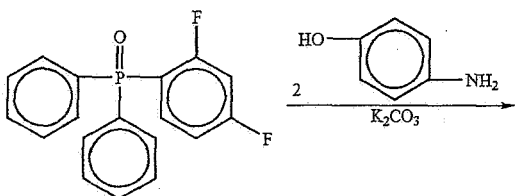
As previously described, the diamines and dianhydrides were used to prepare poly (amide acid)s, copoly (amide acid)s, polyimides and copolyimides. The poly (amide acid)s can be prepared by the reaction of stoichiometric ratios of an aromatic dianhydride with the diamines in polar aprotic solvents. Controlled molecular weight oligomeric (amide acid)s were prepared by offsetting the stoichiometry according to the Carothers equation using excess diamine and endcapping with aromatic anhydrides such as phthalic anhydride or phenylethynylphthalic anhydride. In an analogous fashion, copoly (amide acid)s can be prepared by reacting an aromatic diamine with two different dianhydrides and by reacting the diamine containing phenylphosphine oxide groups and another diamine with a dianhydride. The polymerization of monomeric reactants approach can be utilized whereby the half alkyl ester of an aromatic dianhydride is reacted with an aromatic diamine. Either or both of the reactants can contain phenylphosphine oxide groups. Copolyimides were prepared using the same approach.

Novel aromatic diamines and dianhydrides containing a phenylphosphine oxide group were synthesized according to the reaction schemes depicted in Equations I–VII and VII–IX, respectively. The following equation (I) shows the preparation of the diamine [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (3-APPO), containing a phenylphosphine oxide group according to the present invention:

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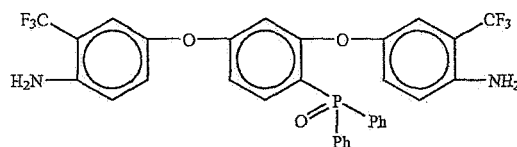


The following Equation (II) shows the preparation of the diamine [2,4-bis(4-aminophenoxy)phenyl]diphenylphosphine oxide (4-APPO):



(II)

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(II)

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-continued

(I)

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The following Equation (III) shows the preparation of the diamine [2,4-bis(4-amino-3-trifluoromethylphenoxy)phenyl]diphenylphosphine oxide (3-AFPPO):

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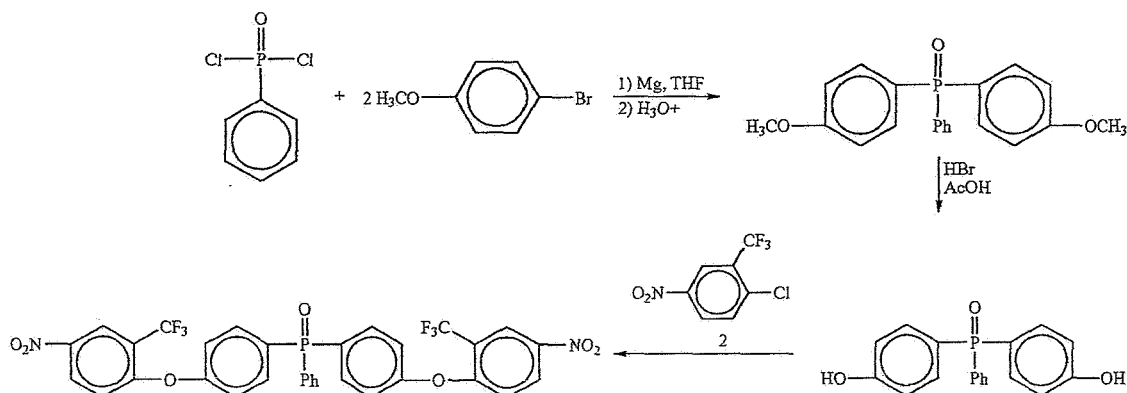
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(II)

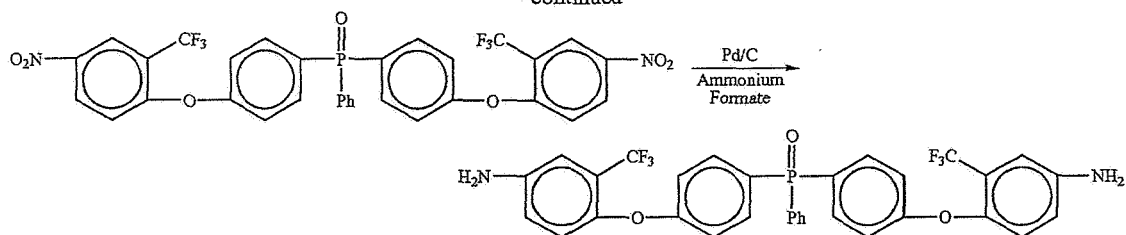
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The following Equation (IV) shows the preparation of bis(2-trifluoromethyl-4-aminophenoxy-4'-phenyl)phenyl phosphine oxide (TFAPO):

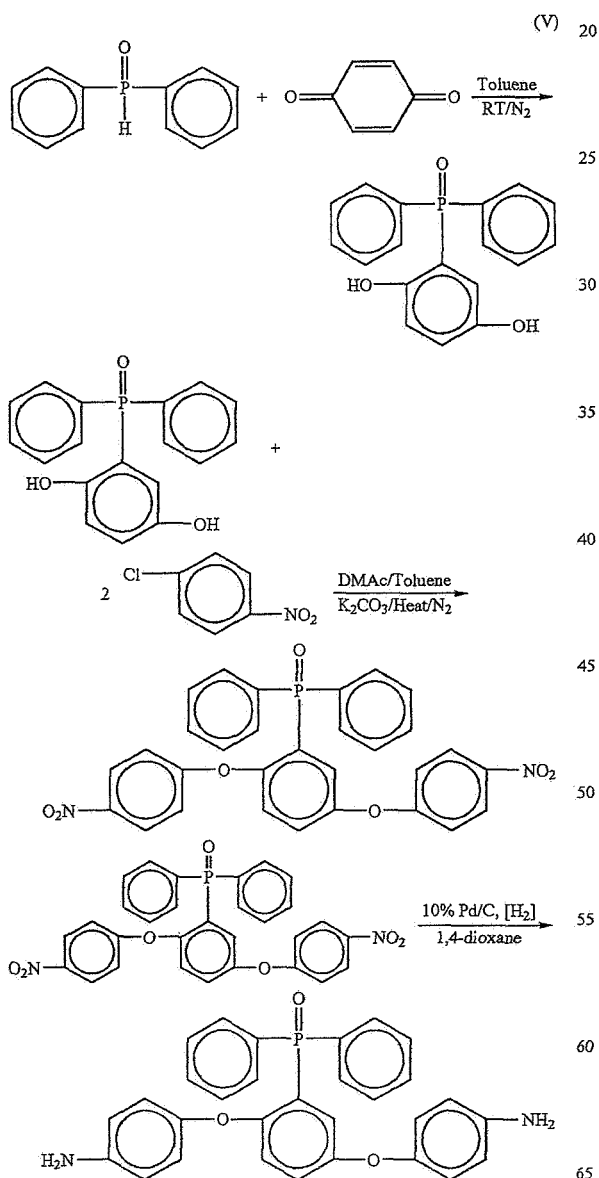
(IV)



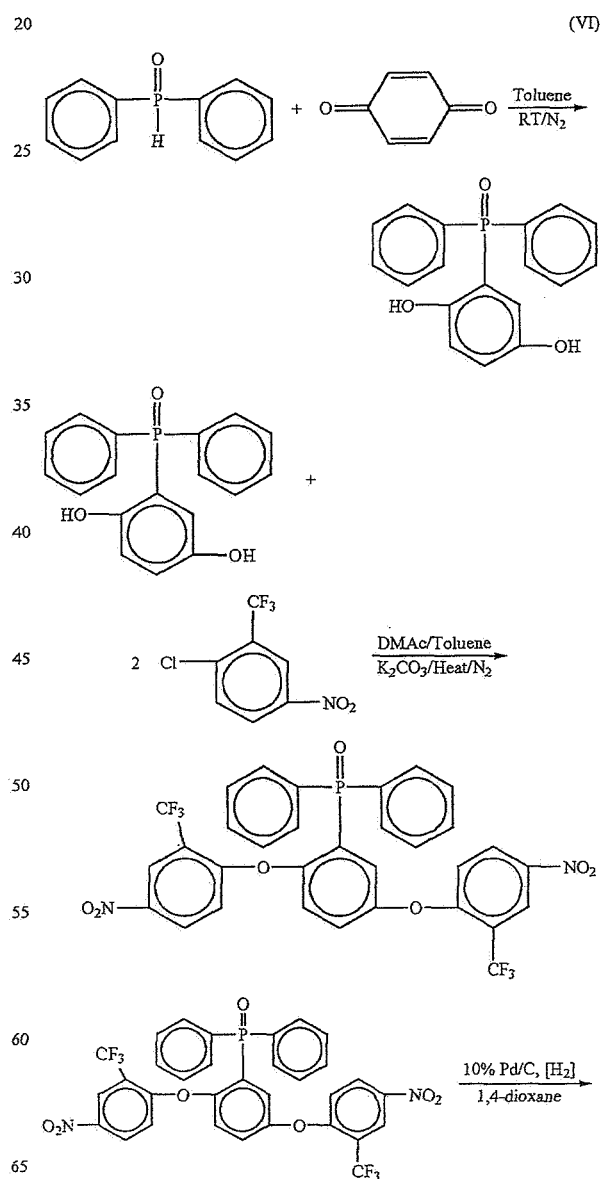
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The following Equation (V) shows the preparation of the diamine [2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine oxide (4,4'-APPO):

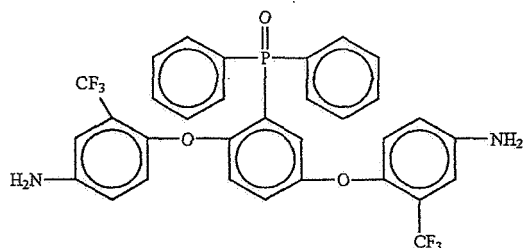


The following Equation (VI) shows the preparation of the diamine [2,5-bis(2-trifluoromethyl-4-aminophenoxy)phenyl]diphenylphosphine oxide (4,4'-TFAPPO):

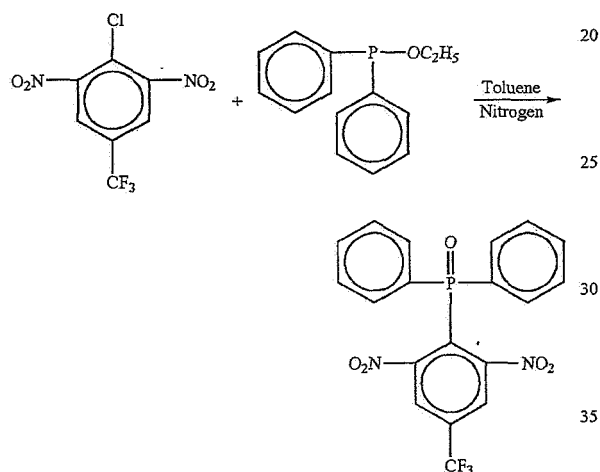


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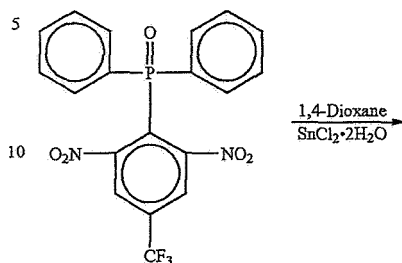


The following Equation (VII) shows the preparation of the diamine (2,6-diamino-4-trifluoromethylphenyl)diphenylphosphine oxide (2,6-APPO):

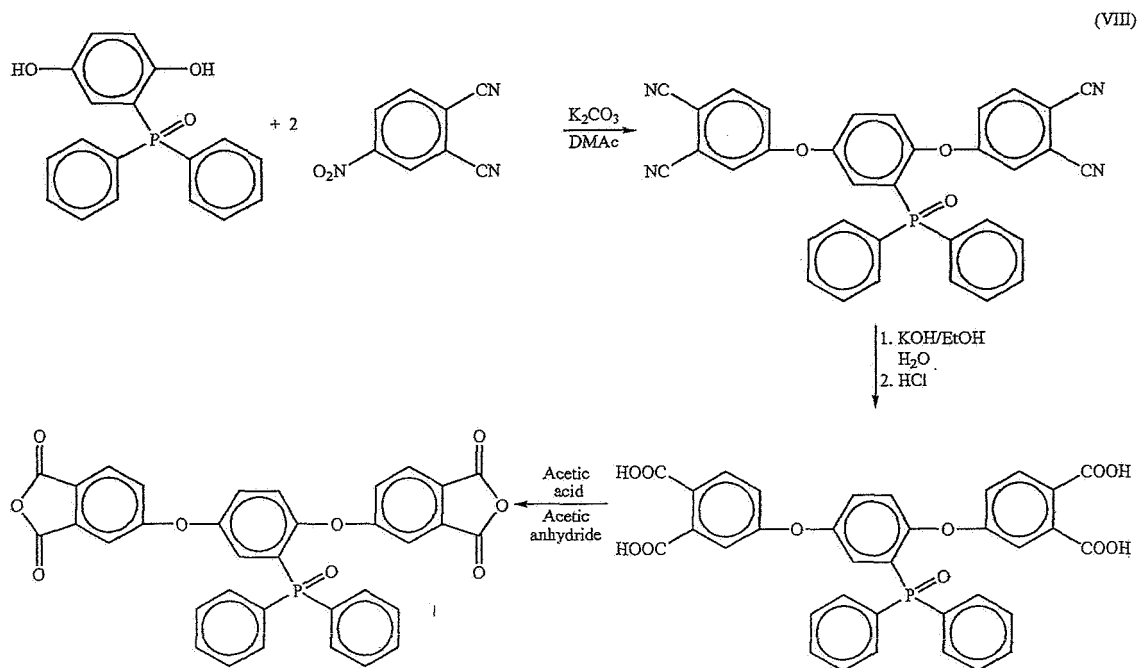


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The following equation (VIII) shows the preparation of the dianhydride [2,5-bis(3,4-dicarboxylphenoxy)phenyl]diphenylphosphine oxide dianhydride (PPODA-1).

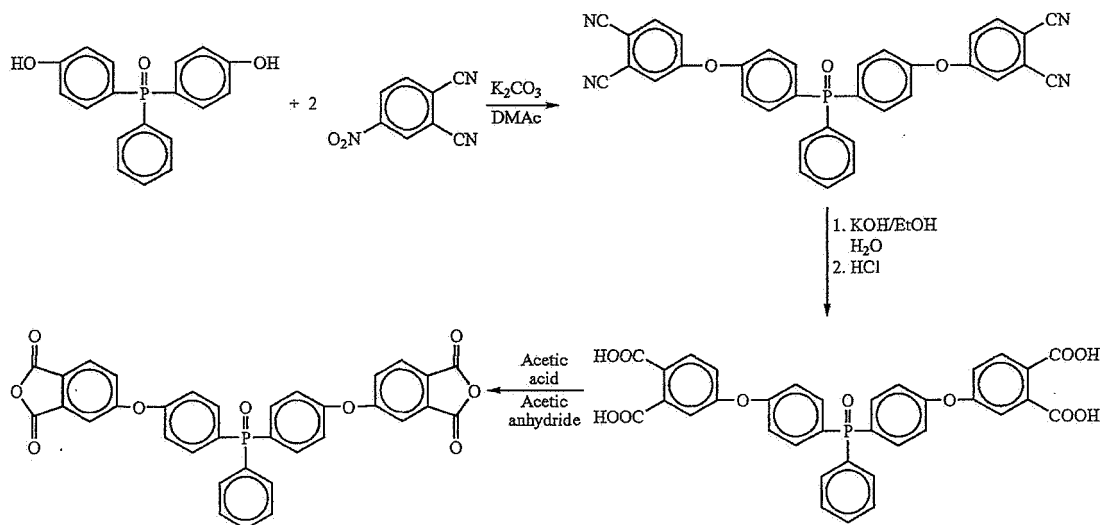


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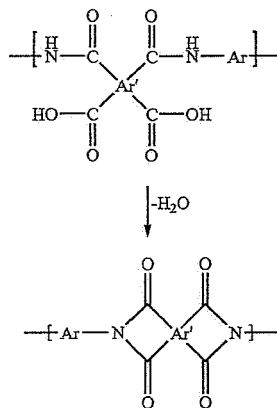
The following Equation (IX) shows the preparation of the dianhydride 4,4'-bis(3,4-dicarboxyphenoxy)phenylphosphine oxide dianhydride (PPODA2):

(IX)

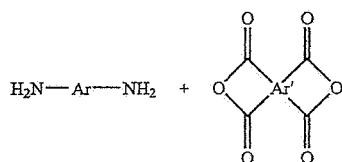


These compounds were characterized using conventional techniques and were found to be consistent with the chemical structures given. The compounds (monomers) were subsequently used to prepare a variety of poly(amide acid)s, copoly(amide acid)s, polyimides and copolyimides that exhibited a unique combination of properties including low solar absorptivity, high optical transparency and atomic oxygen resistance. The diamines were reacted with a variety of aromatic dianhydrides to prepare poly(amide acid)s and polyimides as depicted in Equation X. The molecular weight of the polymers can be controlled by adjusting the stoichiometry of the reactants. Likewise, the polymers can be endcapped with a mono-functional amine such as aniline or a mono-functional anhydride such as phthalic anhydride. Optionally, an endcapping agent that contains other functional groups such as 4-phenylethynyl phthalic anhydride may be used. Examples are given to embody each of these approaches. The following Equation (X) depicts the preparation of poly(amide acid)s and polyimides from the diamines disclosed herein:

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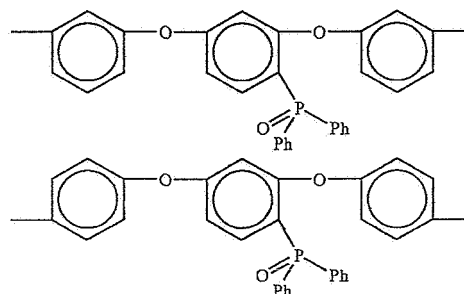
Wherein Ar is represented by:



23° C.
polar aprotic solvent

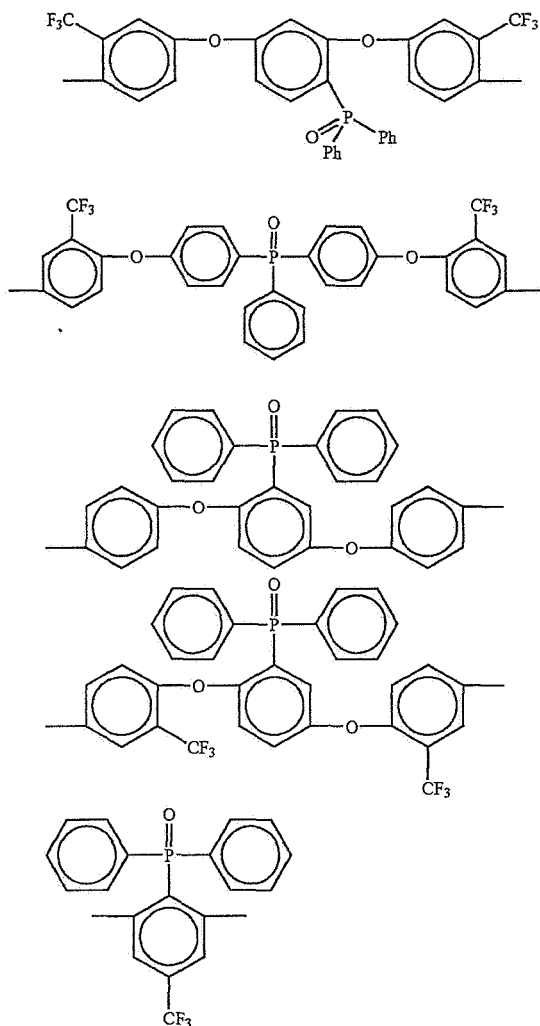
N₂

(X)



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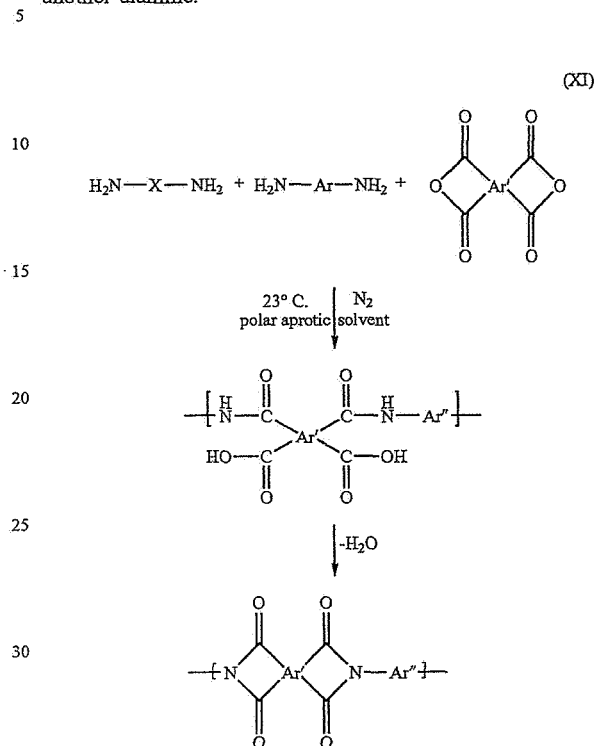


Wherein Ar' can be any tetravalent radical.

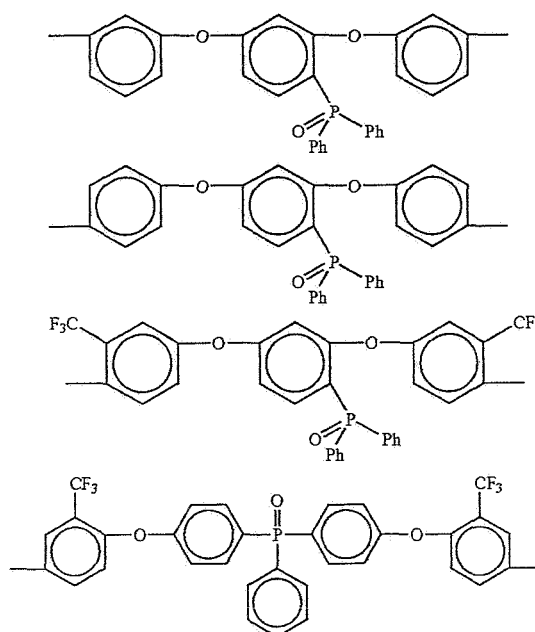
Likewise the diamines disclosed herein can be used to synthesize copoly(amide acid)s and copolyimides as represented in Equation XI. The copolymers can be prepared by reacting one of the novel diamines disclosed herein and another diamine with one aromatic dianhydride. The molecular weight of the copolymers can be controlled by adjusting the stoichiometry of the reactants. Likewise, the polymers can be endcapped with a mono-functional amine such as aniline or a mono-functional anhydride such as phthalic anhydride. Optionally, an endcapping agent that contains other functional groups such as 4-phenylethynyl phthalic anhydride may be used. Copoly(amide acid)s and polyimides can also be prepared by reacting one of the diamines with two different dianhydrides as depicted in Equation XII. The molecular weight of the polymers can be controlled by adjusting the stoichiometry of the reactants. Likewise, the polymers can be endcapped with a mono-functional amine such as aniline or a mono-functional anhydride such as phthalic anhydride. Optionally, an endcapping agent that contains other functional groups such as 4-phenylethynyl phthalic anhydride may be used. Examples

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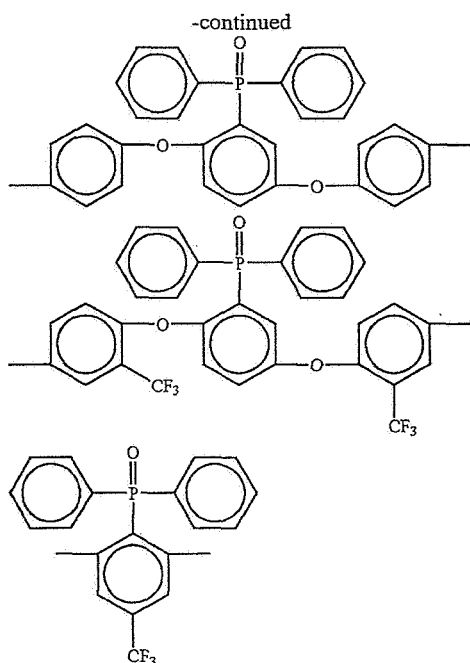
are given to embody each of these approaches. Equation (XI) shows the preparation of copoly(amide acid)s and copolyimides using one of the diamines disclosed herein and another diamine:



Wherein Ar' can be any tetravalent radical,
Wherein Ar'' represents a mixture of Ar and X,
Wherein Ar is represented by:

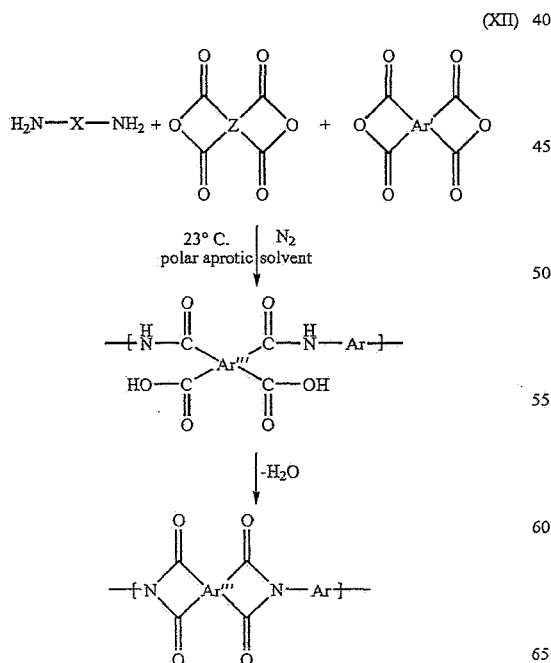


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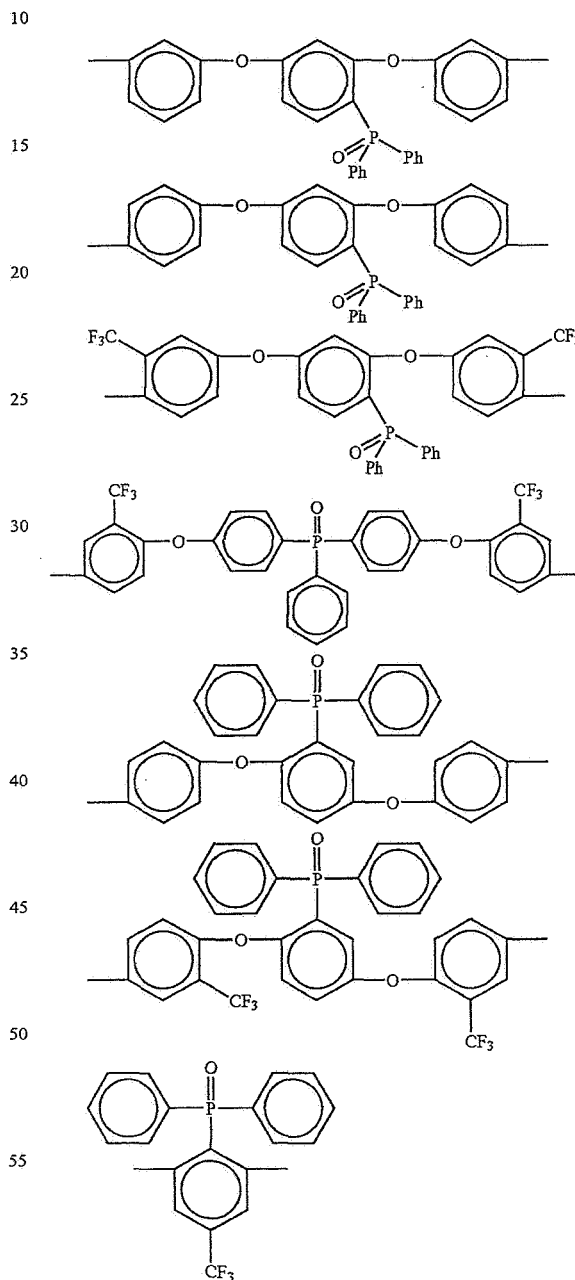
Wherein X can be any divalent radical,
Wherein the molar ratio of Ar to X can range from approximately 1 to 99,
And wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

The following equation (XII) depicts the preparation of 35
copoly(amide acid)s and copolyimides using one of the
diamines disclosed herein and two dianhydrides:



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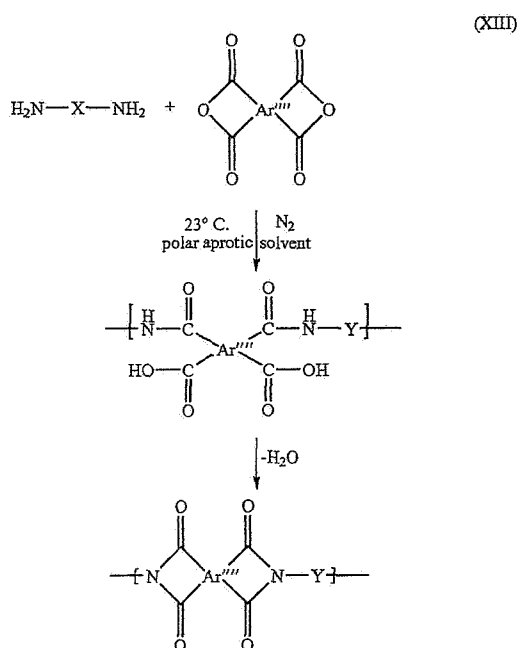
Wherein Ar''' represents a mixture of Ar' and Z,
Wherein Ar' can be any tetravalent radical,
Wherein Z can be any tetravalent radical different from Ar',
Wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole,
Wherein the molar ratio of Ar' to Z can range approximately from 1 to 99,
And wherein Ar is represented by:



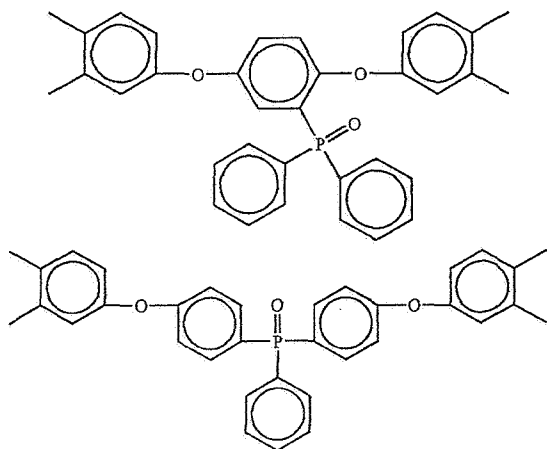
The aromatic dianhydrides disclosed herein were synthesized according to the chemical equations presented in Equations VIII and IX. They were subsequently used to 65
prepare poly(amide acid)s and polyimides as depicted in Equation XIII. It should be noted that these two dianhydrides were also reacted with the aromatic diamines dis-

17

closed herein. The molecular weight of the polymers can be controlled by adjusting the stoichiometry of the reactants. Likewise, the polymers can be endcapped with a mono-functional amine such as aniline or a mono-functional anhydride such as phthalic anhydride. Optionally, an end-capping agent that contains other functional groups such as 4-phenylethynyl phthalic anhydride may be used. Examples are given to embody each of these approaches. The following equation (XIII) depicts the preparation of poly(amide acid)s and polyimides using the dianhydrides disclosed herein and a diamine:



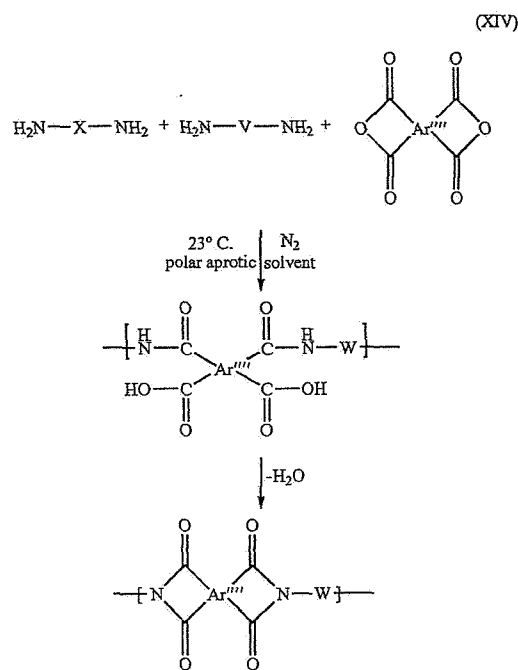
Wherein Ar^{IV} is represented by:



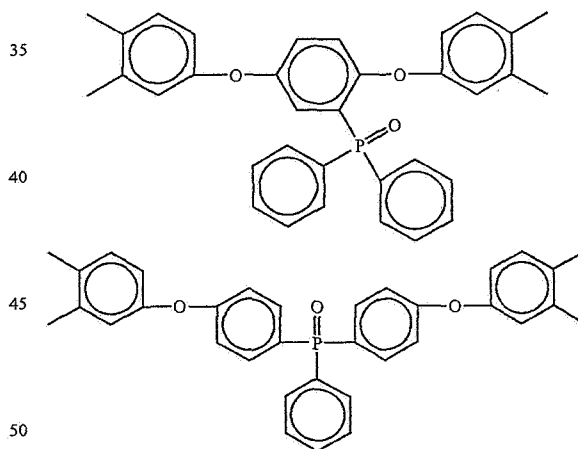
Wherein Y can be any divalent radical

As was the case with the diamines, the novel dianhydrides can be used to make copoly(amide acid)s and copolyimides as depicted in equation (XIV):

18



Wherein Ar^{IV} is represented by:



Wherein W is a mixture of X and V,

Wherein X can be any divalent radical,

Wherein V can be any divalent radical different from X, Wherein the ration of X to V approximately ranges from 1-99;

And wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

The molecular weight of the polymers can be controlled by adjusting the stoichiometry of the reactants. Likewise, the polymers can be endcapped with a mono-functional amine such as aniline or a mono-functional anhydride such as phthalic anhydride. Optionally, an endcapping agent that contains other functional groups such as 4-phenylethynyl phthalic anhydride may be used. Examples are given to embody each of these approaches. In an analogous fashion,

copoly(amide acid)s and copolyimides can be prepared using a combination of one or both of the novel dianhydrides disclosed herein and another dianhydride and any diamine. This is an obvious extension of the embodiments discussed above and no examples are offered

The diamines and dianhydrides disclosed herein impart unique and unexpected properties into poly(amide acid)s and polyimides prepared from them. The poly(amide acid)s were prepared by the reaction of stoichiometric ratios of an aromatic dianhydride with one of the novel diamines in polar aprotic solvents. Controlled molecular weight oligomeric (amide acid)s can be prepared by offsetting the stoichiometry according to the Carothers equation using excess diamine and endcapping with a mono-functional anhydride such as phthalic anhydride. Alternatively, the mono-functional anhydride may contain other functionalities. One example given uses 4-phenylethynyl phthalic anhydride as an endcapping agent. Polyimides can be prepared from the poly(amide acid) solutions by cyclodehydration using several techniques. For example, poly(amide acid) solutions can be heated in the presence of an azeotropic agent such as toluene using a moisture trap to remove water. The poly(amide acid) solutions are also treated with dehydrating agents such as pyridine and acetic anhydride at room temperature to effect imidization. Additional alternative synthetic routes to prepare the polyimides described herein can be employed such as reacting the diamine and dianhydride in m-cresol containing isoquinoline at elevated temperatures. In some of the examples disclosed herein, this route was used. Polyimides can also be prepared by reacting the half alkyl ester of an aromatic dianhydride with the diamine containing phenylphosphine oxide groups by melt polymerization or in solvents such as methanol or m-cresol. In addition, the polymerization of monomeric reactants approach can be utilized whereby the half alkyl ester of an aromatic dianhydride is reacted with the diamine containing phenylphosphine oxide groups.

Polymer characterization is presented in Table 1 and copolymer characterization is presented in Table 2. The inherent viscosities were determined on 0.5% solutions of the poly(amide acid)s in NMP at 25° C. They ranged from 0.26 to 1.07 dL/g indicating moderate to high molecular weight polymers. The T_g s were determined on imidized thin films by differential scanning calorimetry at a heating rate of 20° C./min. The T_g s ranged from 203 to 251° C. These values are typical for aromatic polyimides.

TABLE 1

Polymer Characterization		
Example	η_{inh} , dL/g ^a	T_g , ° C. ^b
10	0.66	230
11	1.01	212
12	0.81	227
13	0.53	251
14	0.97	234
32	0.49	230

TABLE 2

Copolymer characterization, 75% 3-APPO, 25% co-diamine.		
Example	η_{inh} , dL/g ^a	T_g , ° C. ^b
15	1.07	203
16	0.66	216

TABLE 2-continued

Copolymer characterization, 75% 3-APPO, 25% co-diamine.		
Example	η_{inh} , dL/g ^a	T_g , ° C. ^b
17	0.57	218
18	0.57	220
19	0.73	222
20	0.53	224
21	0.39	226
22	0.46	227
23	0.34	233
24	0.42	234
25	0.58	234
26	0.49	237
27	0.57	238
28	0.39	238
29	0.26	240
30	0.28	246
31	0.48	249

Thin films were cast from amide acid and/or imide solutions and thermally treated in a forced air oven to imidize and for solvent removal. All films were tough, creasable, and exhibited low color. The color of the thin films (~1.5 mil thick) ranged from light yellow to colorless and were dependent upon the dianhydride. Thin film mechanical properties are presented in Tables 3 and 4. The films exhibited room temperature tensile strengths and moduli from 79 to 113 MPa and 2.46 to 3.53 GPa, respectively. The elongations at break ranged from 3.1 to 40%. These values are comparable to other aromatic polyimides.

TABLE 3

Room Temperature Thin Film Tensile Properties for Homopolymers			
Example	Tensile Strength, MPa	Tensile Modulus, GPa	Elongation @ break, %
10	87	2.87	3.3
11	97	2.83	4.7
12	82	2.46	40.0

TABLE 4

Room Temperature Thin Film Tensile Properties for Copolymers, 75% 3-APPO, 25% co-diamine.			
Example	Tensile Strength, MPa	Tensile Modulus, GPa	Elongation @ break, %
15	97	3.11	5.0
16	105	2.79	7.9
17	101	3.23	6.3
18	104	2.95	6.6
19	99	3.29	9.5
20	101	3.40	4.1
21	113	3.25	8.7
22	108	2.98	6.2
24	108	3.18	4.9
25	92	2.89	4.3
26	90	3.05	9.6
27	94	2.77	5.0
28	88	2.69	4.3
29	102	3.53	9.7
30	90	3.50	3.9
31	79	3.24	3.1

Imidized thin film samples were measured for optical transparency using ultraviolet/visible spectroscopy. The results are presented in Tables 5 and 6. Most of the films

21

exhibited optical transparencies in excess of 85%. All of these films were colorless to yellow in color depending to some degree on film thickness.

TABLE 5

Optical Transparency of Polyimide Films at 500 nm.		
Example	Thickness, in	Transparency, %
10	0.0017	87
11	0.0016	85
12	0.0020	85
14	0.0024	76
32	0.0025	80

TABLE 6

Optical Transparency of Copolymers, 75% 3-APPO, 25% co-diamine at 500 nm.		
Example	Thickness, in	Transparency, %
15	0.0012	83
16	0.0014	80
17	0.0008	88
18	0.0013	85
19	0.0011	82
20	0.0015	86
21	0.0021	87
22	0.0014	81
23	0.0008	89
24	0.0013	88
25	0.0021	87
26	0.0011	85
27	0.0016	88
28	0.0010	89
29	0.0014	80
30	0.0013	85
31	0.0015	86

The thin films were also characterized for thermal and optical properties. Solar absorptivities (α) were measured on a Aztek Model LPSR-300 spectrophotometer with measurements taken between 250 to 2800 nm with a vapor deposited aluminum on Kapton® as a reflective reference. An Aztek Temp 2000A Infrared reflectometer was used to measure the thermal emissivity (ϵ). An α of less than 0.10 at a thickness level of 0.0010–0.0025 in is exceptionally good. The data for the homopolymers and copolymers is presented in Tables 7 and 8, respectively.

TABLE 7

Solar absorptivities and thermal emissivities of homopolyimide films			
Example	α	ϵ	Thickness, in
10	0.051	0.547	0.0017
11	0.055	0.56	0.0016
12	0.091	0.683	0.0020
13	—	—	—
14	0.096	0.620	0.0024
32	0.063	0.575	0.0025

22

TABLE 8

Solar absorptivities and thermal emissivities of copolyimide films			
Example	α	ϵ	Thickness, in
16	0.068	0.596	0.0014
17	0.058	0.380	0.0008
20	0.070	0.643	0.0015
24	0.059	0.587	0.0013
31	0.057	0.531	0.0015

Thin film (~0.001 in thick) was subjected to several atomic oxygen exposure tests. The first was performed as follows: Thin film obtained from the polyimide described in Example 10 was sputter coated with silver/inconel prior to exposing the film to AO and UV. AO testing was conducted at the NASA Marshall Space Flight Center in the Atomic Oxygen Beam Facility (AOBF). The AOBF system produces AO by exciting an oxygen plasma using microwaves at 2.45 GHz and is confined to the center of the plasma chamber using a strong magnetic field. Ions are accelerated from the plasma and neutralized. The neutralization technique provides a direct measurement of the AO flux that in many other systems is not directly known. Under standard operating conditions, the system is capable of producing an AO flux of 10^{16} atoms/cm²/sec for accelerated testing. The AOBF system produces AO atoms with 5 eV energy. UV testing was conducted at the NASA Goddard Space Flight Center Thermal Engineering Branch with the Multisedes Vacuum System. The system consists of two sorption pumps, a sputter-ion pump, and a sample chamber with 16 testing positions. An AZ Technology LPRS-200 was used to perform the pre-vacuum and post-vacuum reflectance measurements and solar absorptance calculations. The solar absorptance was calculated in accordance with ASTM E903-82. The LPRS measures the reflectance from 250 to 2500 nm of the sample surface at a 15° angle of incidence. The Geir-Dunkle DB-100 Infrared Reflectometer was used to measure the normal emittance of the surface from 5 to 40 μ m. The results from this test are presented in Tables 9 and 10, respectively. It is obvious from the data in Tables 9 and 10 that the film exhibited minimal changes in α , ϵ and weight loss as a consequence of AO and UV exposure. For comparative purposes a film of comparable thickness and dimensions of Kapton® HN was exposed simultaneously. The Kapton® HN film exhibited an erosion of 2.0×10^{-3} cm after exposure to a fluence of only 7.5×10^{20} AO cm⁻².

TABLE 9

Effect of fast AO exposure of polyimide/silver film (Example 10)			
Exposure	α	ϵ	Erosion, cm
None	0.187	0.74	0
1.71×10^{20} AO/cm ²	0.221	0.74	4.1×10^{-4}
2.0×10^{20} AO/cm ²	0.218	0.73	3.2×10^{-4}
2.13×10^{20} AO/cm ²	0.227	0.74	5.0×10^{-4}

23

TABLE 10

Effect of UV exposure of polyimide/silver film (Example 10)			
Exposure	α	ϵ	$\Delta\alpha$
None	0.184	0.820	0
500 ESH	0.205	0.822	0.025
1000 ESH	0.202	0.817	0.018

In another test, thin films of several polyimides were exposed to atomic oxygen in a plasma generated beam system. The effect of various exposures on weight loss and optical transparency at 600 nm were monitored. The films were all of comparable thickness and dimensions. The results are presented in Table 11. CP-1 is a commercially available polyimide derived from 4,4'-perfluoroisopropylidene dianhydride and 2,2-bis(4-(4-aminophenoxy)phenyl) hexafluoropropane. Thus it is of similar chemical structure to the polyimide of Example 10, but it contains no phosphine oxide groups. Kapton®HN is an aromatic polyimide derived from 4,4'-oxydianiline and pyromellitic dianhydride, it does not contain fluorine or phosphorus. The optical transparencies of the three materials prior to exposure were Example 10 (90%), CP-1 (88%) and Kapton®HN (69%).

TABLE 11

Effect of AO exposure on weight loss and optical transparency			
Sample	AO Exposure, AO/cm ²	Weight loss, g	Transparency at 600 nm, %
Example 10	5.0×10^{19}	0.0001	90
CP-1	5.0×10^{19}	0.0010	88
Kapton®HN	5.0×10^{19}	0.0010	70
Example 10	1.5×10^{20}	0.00050	86
CP-1	1.5×10^{20}	0.0035	70
Kapton®HN	1.5×10^{20}	0.0035	58
Example 10	2.5×10^{20}	0.00080	80
CP-1	2.5×10^{20}	0.0065	35
Kapton®HN	2.5×10^{20}	0.0070	35

The results presented in Table 11 further illustrate the exceptional AO resistance of the polyimides described herein. The film from Example 10 exhibits an order of magnitude reduction in weight loss and superior retention of optical transparency compared to similar polyimides. The results described herein detail the preparation of aromatic diamines and dianhydrides and polyimides therefrom that exhibit a low solar absorptivity, high optical transparency and exceptional stability to ultraviolet radiation and atomic oxygen. The unique combination of properties exhibited by the polyimides described herein are not found in any other known polyimide or copolyimide.

EXAMPLES

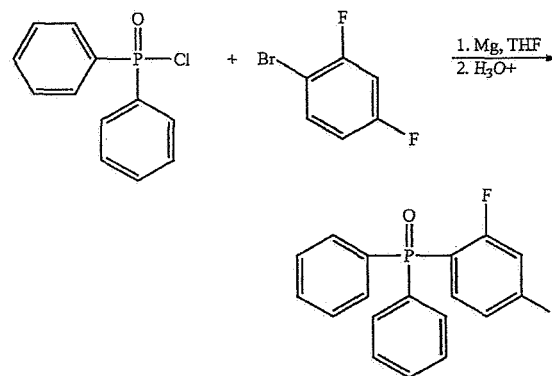
Having generally described the invention, a more complete understanding thereof can be obtained by reference to the following examples that are provided for purposes of illustration only and do not limit the invention.

24

Example 1

Preparation of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide (3-APPO)

Step 1

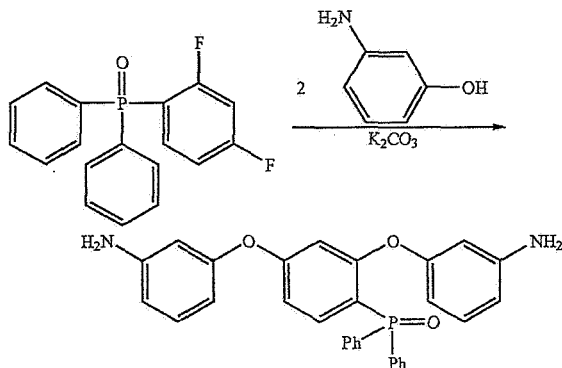
Preparation of 2,4-difluorophenyl diphenylphosphine
oxide

Into a 1 L three neck round bottomed flask equipped with a mechanical stirrer, thermometer, nitrogen gas inlet, pressure equalizing addition funnel, and reflux condenser with drying tube was placed predried magnesium turnings (13.5 g, 0.55 mol) and dry tetrahydrofuran (THF, 50 mL). The mixture was cooled to -5°C . using an ice/water bath. A solution of 1-bromo-2,4-difluorobenzene (107.2 g, 0.55 mol, 20% molar excess) in THF (200 mL) was placed in the pressure equalizing addition funnel and added dropwise over a 1.5 hour period. The mixture was allowed to warm to room temperature. The mixture was stirred at room temperature for 3 hours and the flask was subsequently placed in the ice/water bath to cool the solution to -5°C . A solution of diphenylphosphinic chloride (107.9, 0.46 mol) in THF (100 mL) was added dropwise over a 1 hour period. The reaction mixture was allowed to warm to room temperature and was stirred under nitrogen for 15 hours. The resultant brown solution was poured into a mixture of concentrated ammonium chloride solution (700 mL) to give two layers. The organic layer was extracted successively with water, 5% aqueous sodium bicarbonate, and water and subsequently dried over magnesium sulfate. The THF was removed via rotoevaporation to give a dark red viscous liquid, 142.8 g, 98% crude yield. The viscous liquid was vacuum distilled (product distilled between $178-181^{\circ}\text{C}$.) and a yellow semi-solid was collected (118.6 g, 81% yield). The material was dissolved in 120 mL of hot toluene, treated with charcoal, and filtered while hot through Celite. To the toluene solution was added 120 mL of hexanes. The solution was allowed to cool, with stirring, overnight. A white crystalline material was collected via filtration (100.9 g, 69% yield). The solid exhibited a melting point of $111.1-112.3^{\circ}\text{C}$. as determined by differential scanning calorimetry (DSC) at $10^{\circ}\text{C}/\text{min}$. Anal. Calcd. for $\text{C}_{18}\text{H}_{13}\text{F}_2\text{OP}$: C, 68.79%; H, 4.17%; F, 12.09%; P, 9.86%. Found: C, 68.38%; H, 4.26%; F, 11.17%; P, 10.28%. Mass spectroscopic analysis: $\text{M}+413.2$ [$\text{C}_{20}\text{H}_{13}\text{F}_6\text{OP}+$].

25

Step 2

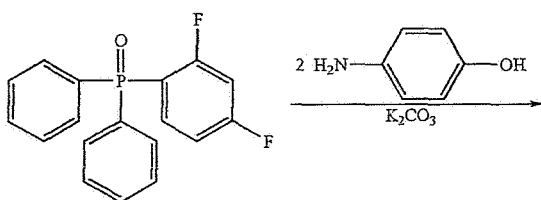
Preparation of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide (3-APPO)



2,4-difluorophenyl diphenylphosphine oxide was prepared as described in Step 1 of Example 1. Into a 500 mL three neck round bottom flask equipped with a mechanical stirrer, thermometer and a Dean-Stark trap equipped with a drying tube was placed 2,4-difluorophenyl diphenylphosphine oxide (39.50 g, 0.1257 mole), 3-aminophenol (28.80 g, 0.2639 mol), potassium carbonate (45.58 g, 0.3298 mol), N-methyl-2-pyrrolidinone NMP, 200 mL) and toluene (115 mL). The mixture was heated to 170° C. while removing water via azeotropic distillation. After 16 hours, the toluene was removed from the reaction and the resulting solution was heated at 170° C. for 4 hours. The reaction mixture was cooled to room temperature and then poured into 1 L of 5% acetic acid (aq) with vigorous stirring. A tan solid formed after stirring for 45 minutes. The crude tan solid was collected via filtration, washed with excess water, and dried in an oven at 110° C. to give 59.11 g (95% crude yield). The solid exhibited a melting point of 179.7–187.6° C. The solid was recrystallized twice from ethanol with charcoal treatment to yield 37 g (60% yield) of a light tan solid. The solid exhibited a melting point of 195.2–196.5° C. as determined by DSC at a heating rate of 10° C./min. Anal. Calcd. for: $C_{30}H_{25}N_2O_3P$: C, 73.16%; H, 5.12%; N, 5.69%; P, 6.29%. Found: C, 72.85%; H, 5.00%; N, 5.69%; P, 6.22%. Mass spectroscopic analysis: $M+492 [C_{30}H_{25}N_2O_3P^+]$

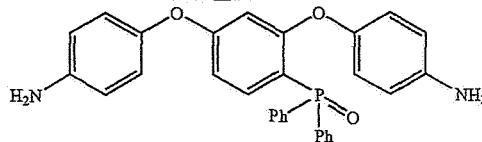
Example 2

Preparation of
[2,4-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide (4-APPO)



26

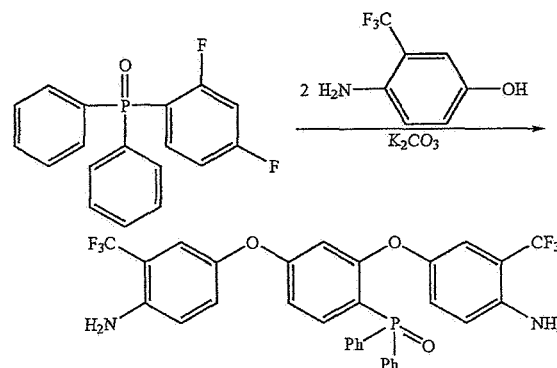
-continued



Into a 500 mL three neck round bottom flask equipped with a mechanical stirrer, thermometer and a Dean-Stark trap equipped with a drying tube was placed 2,4-difluorophenyl diphenylphosphine oxide (12.00 g, 0.0382 mole), 4-aminophenol (8.6673 g, 0.0794 mol), potassium carbonate (13.1682 g, 0.0953 mol), NMP (85 mL) and toluene (25 mL). The mixture was heated to 135° C. while removing water via azeotropic distillation. After 16 hours, the toluene was removed from the reaction and the resulting solution was heated at 165° C. for 4 hours. The reaction mixture was cooled to room temperature and then poured into 1 L of 5% acetic acid (aq) with vigorous stirring. A tan solid formed after stirring for 45 minutes. The crude tan solid was collected via filtration, washed with excess water, and dried in an oven at 110° C. to give 16.76 g (89% crude yield). The solid was recrystallized from a dimethylacetamide/water solution (3:1) and light tan needles were obtained. The solid exhibited a melting point of 271.5–274.7° C. as determined by DSC at a heating rate of 10° C./min. Mass spectroscopic analysis: $M+492 [C_{30}H_{25}N_2O_3P^+]$

Example 3

Preparation of [2,4-bis(3-trifluoromethyl-4-aminophenoxy)phenyl]diphenylphosphine oxide (3-AF-PPO)



2,4-difluorophenyl diphenylphosphine oxide was prepared as described in Step 1 of Example 1. Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, thermometer and a Dean-Stark trap equipped with a drying tube was placed 2,4-difluorophenyl diphenylphosphine oxide (7.1654 g, 0.0228 mole), 4-amino-3-trifluoromethylphenol (8.52 g, 0.0481 mol), potassium carbonate (8.27 g, 0.0598 mol), NMP (35 mL) and toluene (15 mL). The mixture was heated to 135° C. while removing water via azeotropic distillation. After 16 hours, the toluene was removed from

27

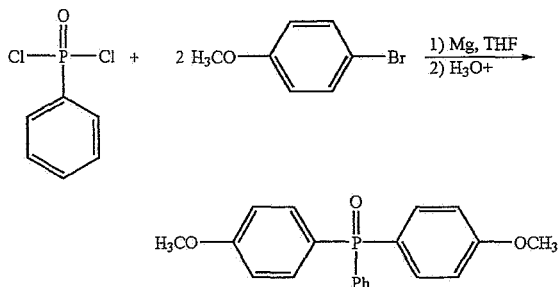
the reaction and the resulting solution was heated at 170° C. for 4 hours. The reaction mixture was cooled to room temperature and then poured into 300 mL of 5% acetic acid (aq) with vigorous stirring. A brown gummy material formed. This material was stirred in warm water, the water decanted, and fresh water added. This process was repeated two more times. A dark brown/grey solid was eventually obtained. No melting point was observed using DSC.

Example 4

Preparation of Bis(2-trifluoromethyl-4-aminophenoxy-4'-phenyl)phenyl phosphine oxide (4-TFAPO)

Step 1

Bis(4-methoxyphenyl)phenyl phosphine oxide

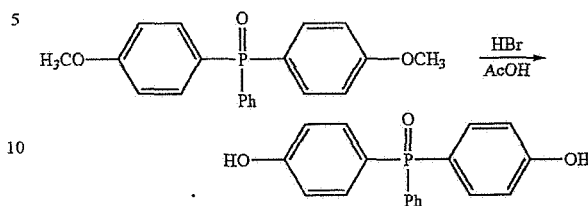


To a 2000 mL three necked round bottom flask equipped with a nitrogen inlet, mechanical stirrer and drying tube was charged magnesium turnings (23.00 g, 0.9463 mol). The magnesium turnings were heated and dried under nitrogen. Once cooled to room temperature, 800 mL THF was added and the mixture cooled to 0–5° C. Bromoanisole (177 g, 0.9463 mol) was added dropwise to the stirred mixture over a three hour period. The mixture was then allowed to warm to room temperature over ~16 hrs to afford a gray cloudy solution. The solution was then cooled to 0–5° C. and phenylphosphinic dichloride (92.26 g, 0.4732 mol) was added dropwise. The solution turned a dark green color and was allowed to warm to room temperature over 16 hours. Aqueous sulfuric acid (~30 mL in 250 mL water) was added to the stirred solution. The mixture turned a yellow color and separated. Water (~600 mL) was then added and the mixture transferred to a separatory funnel. The organic layer was removed and the aqueous layer washed with THF/diethyl ether. This was repeated three times and the organic layer and washings combined. The organic layer was washed three times with a sodium bicarbonate solution (~25 g in 250 mL water) and then three times with water. The organic layer was then dried over magnesium sulfate. The magnesium sulfate was removed by filtration. The THF/diethyl ether was removed via a rotoevaporator to afford a yellow oil (87.23 g, 55% yield). Attempts to crystallize the material were unsuccessful thus it was used as is in the preparation of bis(4-hydroxyphenyl)phenyl phosphine oxide.

28

Step 2

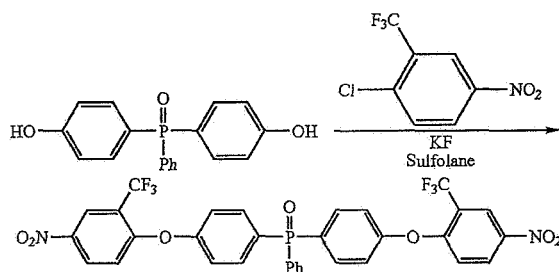
Bis(4-hydroxyphenyl)phenyl phosphine oxide



A mixture of bis(4-methoxyphenyl)phenyl phosphine oxide (59.83 g, 0.1768 mol), 48% hydrobromic acid (400 mL, 3.536 mol), and glacial acetic acid (215 mL) was refluxed for 24 hrs. As the solution cooled to room temperature, the crude product remained in solution. The hydrobromic acid/glacial acetic acid mixture was added to stirred distilled water at room temperature to afford a light pink solid. The crude solid was washed several times in water and dried at ~105° C. to afford 46.4 g (~85% yield). The solid was dissolved in ethanol, treated with activated charcoal, and filtered through Celite 545. Distilled water was added to the stirred warm solution until a 50% aqueous ethanol solution was obtained. The mixture was then allowed to cool to ambient temperature. The product was recovered by filtration and dried under vacuum at 50° C. This recrystallization procedure was repeated an additional time to afford 22.66 g (41% yield) of a white solid, DSC (heating rate of 10° C./min) exotherm at 157° C. with sharp peaks at 227 and 233° C. [literature 233–234° C. (A. E. Senear, W. Valent, and J. Wirth *J. Org. Chem.* 25, 2001, 1960.)]

Step 3

Bis(2-trifluoromethyl-4-nitrophenoxy-4'-phenyl)phenyl phosphine oxide

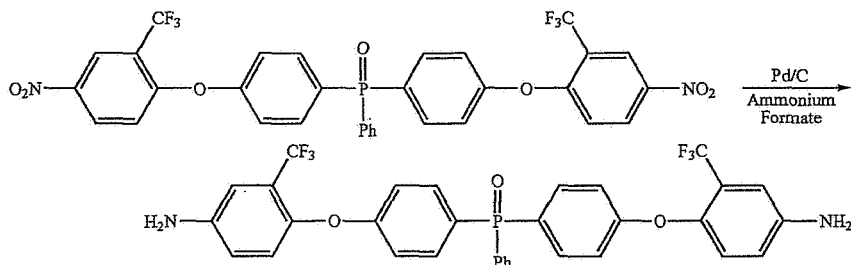


To a 250 mL three necked round bottom flask equipped with a nitrogen inlet, mechanical stirrer, and drying tube was charged bis(4-hydroxyphenyl)phenyl phosphine oxide (8.3530 g, 0.0269 mol), 3-trifluoromethyl-4-chloronitrobenzene (12.1454 g, 0.0538 mol), potassium fluoride (4.2 g, 0.0723 mol) and sulfolane (51.44 g). The mixture was heated under a nitrogen atmosphere at ~130–50° C. for ~16 hr and at ~195° C. for about two hours. The mixture was cooled and added to stirred water to afford a tacky solid. The water was decanted and the tacky solid washed three times in hot water to afford 17.5 g (94%) of an amorphous yellow powder. The solid was taken up in ethanol, charcoaled, and filtered through Celite 545. The solution was added to stirred water to afford a light green solid. The solid was dried at 35° C. under vacuum to afford 14.70 g (79%) of an amorphous solid.

29

Step 4

Bis(2-trifluoromethyl-4-aminophenoxy-4'-phenyl)
phenyl phosphine oxide (TFAPO)



20

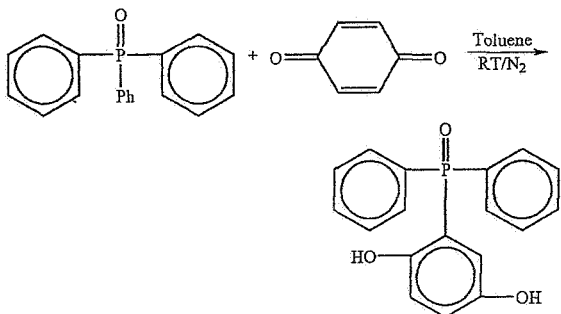
To a 500 mL three necked round bottom flask equipped with a nitrogen inlet, mechanical stirrer, and condenser was charged bis(2-trifluoromethyl-4-nitrophenoxy-4'-phenyl) phenyl phosphine oxide (7.5130 g, 0.0109 mol), 10% palladium on carbon (1.7760 g) and 200 mL of ethanol. To the stirred solution was added ammonium formate (9.5348 g, 0.1512 mol) in several portions. The mixture was stirred at ambient temperature for ~20 hrs and heated at reflux for an additional four hours. The mixture was cooled and the catalyst removed by filtration to afford a colorless filtrate. The filtrate was added dropwise to stirred water to afford a white powder. The powder was recovered and air-dried at ambient temperature to afford 5.54 g of an amorphous powder. The powder was taken up in ethanol, charcoaled and the product reprecipitated in water.

Example 5

Preparation of
[2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide (4,4'-APPO)

Step 1

Preparation of 2,5-dihydroxydiphenylphosphine
oxide



Into a flame dried 2 L three neck round bottomed flask equipped with a mechanical stirrer, nitrogen gas inlet, pressure equalizing addition funnel, and drying tube was charged p-benzoquinone (30.16 g, 0.2790 mol) and toluene (750

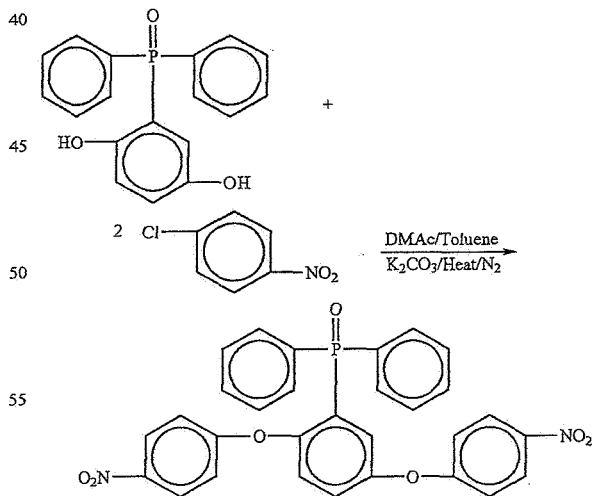
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mL). Once dissolved, diphenylphosphine oxide (56.42 g, 0.2790 mol) in toluene (250 mL) was added dropwise over a half hour to the stirred solution at room temperature under nitrogen. The solution color changed from a dark brown to yellow with the formation of a gum. Upon further stirring,

a grey colored solid formed. The solid was isolated, washed with toluene and diethyl ether, and dried at 110° C. in flowing air to afford 74.0 g (85% crude yield) of an off white solid. The solid exhibited a broad endothermic peak at 208° C. as determined by differential scanning calorimetry (DSC) at a heating rate of 10° C./min. Recrystallization from ethanol afforded a white solid (62.86 g, 73% yield) exhibiting a sharp endothermic peak at 212.48° C. by DSC. [mp 214–215° C., J. M. Brown and S. Woodward, J. Org. Chem., 1991, 56, 6803]

Step 2

Preparation of
[2,5-bis(4-nitrophenoxy)phenyl]diphenylphosphine
oxide



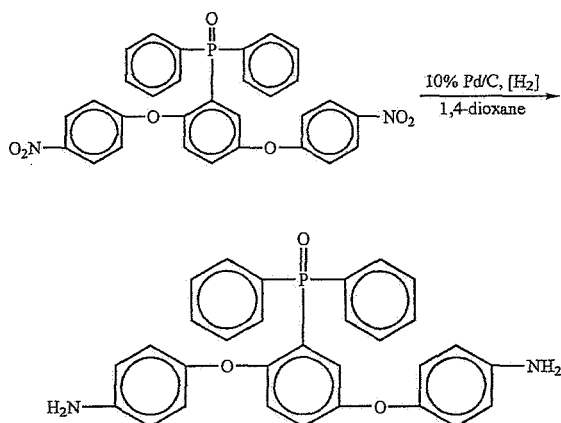
Into a 1 L three neck round bottom flask equipped with a mechanical stirrer, nitrogen inlet, and a Dean-Stark trap was placed 2,5-dihydroxydiphenylphosphine oxide (27.62 g, 0.0890 mol), 1-chloro-4-nitrobenzene (28.05 g, 0.1780 mol), potassium carbonate (28.00 g, 0.2026 mol), N,N-dimethylacetamide (DMAc, 150 mL) and toluene (130 mL). The mixture was heated to a gentle reflux while removing

31

water via azeotropic distillation. After ~4 hours, the toluene was removed from the reaction and the resultant solution heated at ~165° C. for ~16 hours. The reaction mixture was cooled to room temperature and then poured into water with vigorous stirring to afford a light brown solid. The crude solid was collected via filtration, washed twice with hot water, and air dried in an oven at 110° C. to afford 47.6 g (97% crude yield). The solid exhibited a broad endothermic peak at 232.9° C. as determined by differential scanning calorimetry (DSC) at a heating rate of 10° C./min. Recrystallization from ethoxyethanol afforded a yellow solid (39.21 g, 80% yield) exhibiting a sharp endothermic peak at 234.31° C. by DSC. ¹H NMR (DMSO-d₆) δ: 6.8 (1 H, d), 7.3 (1.5 H, m), 7.5 (4 H, m), 7.7 (2 H, m), 8.05 (1 H, d), 8.3 (1 H, d). ¹³C (DMSO-d₆) ppm: 117.705, 118.186, 125.652, 126.325, 126.516, 126.820, 128.646, 128.808, 130.993, 131.296, 131.432, 132.107, 132.144, 132.410, 142.638, 142.903, 151.402, 151.577, 152.194, 152.226, 161.091, 162.177.

Step 3

Preparation of
[2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide (4,4'-APPO)



Into a 250 mL Paar Hydrogenation flask was charged [2,5-bis(4-nitrophenoxy)phenyl]diphenylphosphine oxide (5.4 g, 0.0098 mol) and 1,4-dioxane (100 mL). The solution was warmed to effect dissolution with subsequent cooling to room temperature upon which 10% Pd/C (0.59 g) was added. The mixture was degassed prior to the introduction of hydrogen gas. The mixture was agitated under a hydrogen atmosphere for ~24 hours at room temperature. After degassing the solution, the Pd/C was removed by filtration and the solution added to stirred water to afford an off white solid. The crude solid was collected via filtration, washed with water, and dried at room temperature to, afford 4.1 g (76% crude yield). The solid exhibited a broad endothermic peak at 200.7° C. as determined by DSC at a heating rate of 10° C./min. Recrystallization from aqueous ethanol afforded a tan solid (3.2 g, 80% yield) exhibiting a broad endothermic peak at 204.12° C. by DSC.

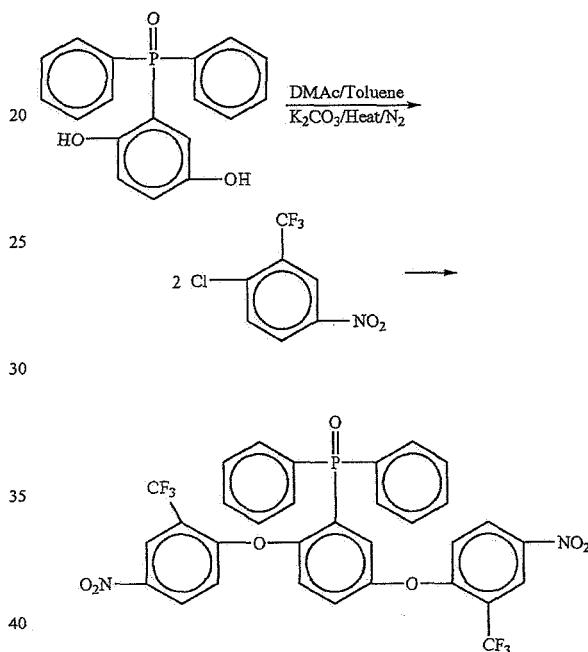
32

Example 6

Preparation of [2,5-bis(2-trifluoromethyl-4-aminophenoxy)phenyl]diphenylphosphine oxide (4,4'-TFAPPO)

Step 1

Preparation of [2,5-bis(2-trifluoromethyl-4-nitrophenoxy)phenyl]diphenylphosphine oxide

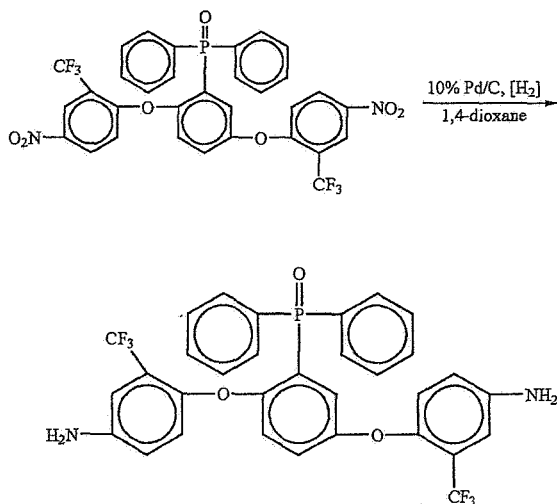


Into a 250 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen inlet, and a Dean-Stark trap was placed 2,5-dihydroxydiphenylphosphine oxide (4.8162 g, 0.0155 mol), potassium carbonate (7.0186 g, 0.0508 mol), N,N-dimethylacetamide (DMAc, 30 mL) and toluene (80 mL). The mixture was heated to a gentle reflux while removing water via azeotropic distillation. After ~4 hours, the toluene was removed and the mixture cooled to room temperature. 2-Chloro-5-nitrobenzotrifluoride (5.6965 g, 0.0412 mol) was added as a powder to the stirred mixture. Heating was continued at ~90° C. under nitrogen for ~16 hours and at ~160° C. for ~7 hours. The reaction mixture was cooled to room temperature and poured into water with vigorous stirring to afford a brown solid. The crude solid was collected via filtration, washed with water, and air dried at room temperature to afford 7.92 g (74% crude yield). The solid exhibited no melting point as determined by differential scanning calorimetry (DSC) at a heating rate of 10° C./min. The solid was recrystallized from aqueous ethanol. No melting point was observed by DSC.

33

Step 2

Preparation of [2,5-bis(2-trifluoromethyl-4-nitrophenoxy)phenyl]diphenylphosphine oxide (4,4'-TFAPPO)



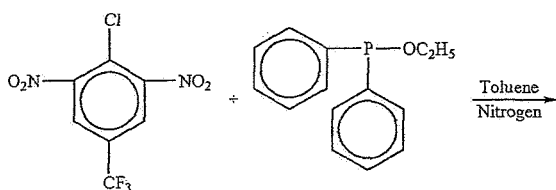
Into a 250 mL Parr hydrogenation flask was charged [2,5-bis(2-trifluoromethyl-4-nitrophenoxy)phenyl]diphenylphosphine oxide (2.55 g, 0.0037 mol), ethanol (25 mL), and 10% Pd/C (0.27 g). The mixture was degassed prior to the introduction of hydrogen gas. The mixture was agitated under a hydrogen atmosphere for ~24 hours at room temperature. After degassing the solution, the Pd/C was removed by filtration and the solution added to stirred water to afford an off white solid. The crude solid was collected via filtration, washed with water, and dried at room temperature to afford 1.23 g (53% crude yield). The solid exhibited no melting peaks as determined by DSC at a heating rate of 10° C./min.

Example 7

Preparation of (2,6-diamino-4-trifluoromethylphenyl)diphenylphosphine oxide (2,6-APPO)

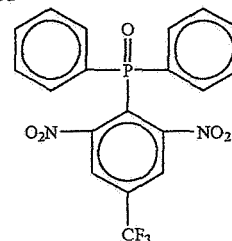
Step 1

Preparation of (2,6-dinitro-4-trifluoromethylphenyl)diphenylphosphine oxide



34

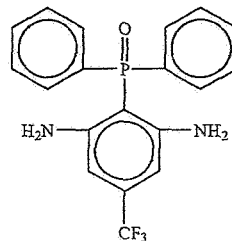
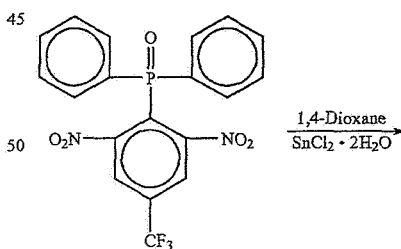
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Into a flame dried 250 mL three neck round bottomed flask equipped with a mechanical stirrer, nitrogen gas inlet, pressure equalizing addition funnel, and condensor fitted with a drying tube was charged 4-chloro-3,5-dinitrobenotrifluoride (11.6078 g, 0.0429 mol) and toluene (45 mL). Once dissolved, the solution was cooled in an ice bath. Ethyl diphenylphosphinite (9.8786 g, 0.0429 mol) in toluene (30 mL) was added dropwise over a half hour to the stirred solution under nitrogen. The solution color changed from a light green to light brown. The reaction was allowed to warm to room temperature with stirring for ~16 hours. The solution was then heated to reflux and maintained for ~1.5 hours. The solution was cooled and a solid precipitated. The crude solid was isolated and air dried at room temperature to afford 14.86 g (79% crude yield) of a light yellow powder. The solid exhibited a sharp endothermic peak at 193.35° C. as determined by differential scanning calorimetry (DSC) at a heating rate of 10° C./min. Recrystallization from ~50% aqueous ethanol afforded a light green powder (13.45 g, 72% yield) exhibiting a sharp endothermic peak at 194.61° C. by DSC. [mp 214–215° C., J. M. Brown and S. Woodward, J. Org. Chem., 1991, 56, 6803]

Step 2

Preparation of (2,6-diamino-4-trifluoromethylphenyl)diphenylphosphine oxide (2,6-APPO)



Into a 500 mL Erlenmeyer flask equipped with a stir bar was placed (2,6-dinitro-4-trifluoromethylphenyl)diphenylphosphine oxide

35

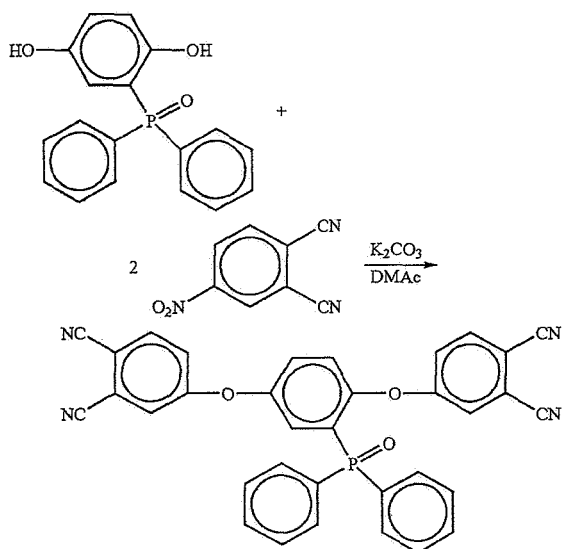
nylphosphine oxide (6.48 g, 0.0149 mol) and 1,4-dioxane (100 mL). The mixture was cooled in an ice bath to -10°C . A solution of stannous chloride dihydrate (31.22 g, 0.1384 mol) in concentrated hydrochloric acid (130 mL) was added dropwise over ~ 1 hour. Once the addition was complete, the mixture was allowed to warm to room temperature with stirring. After ~ 16 hours, the crude amine salt was collected via filtration, added to ice water and basified to a pH of ~ 10 with ammonium hydroxide. The crude solid was isolated by filtration, washed with water, and air dried at room temperature to afford 5.11 g (91% crude yield) of a white powder. The solid exhibited a sharp endothermic peak at 172°C as determined by differential scanning calorimetry (DSC) at a heating rate of $10^{\circ}\text{C}/\text{min}$. Recrystallization from $\sim 50\%$ aqueous ethanol afforded tan plates (3.86 g, 69% yield) exhibiting a sharp endothermic peak at 174.17°C by DSC.

Example 8

Preparation of [2,5-bis(3,4-dicarboxyphenoxy)phenyl]diphenylphosphine oxide dianhydride (PPODA-1)

Step 1

Preparation of [2,5-bis(3,4-dicyanophenoxy)phenyl]diphenylphosphine oxide

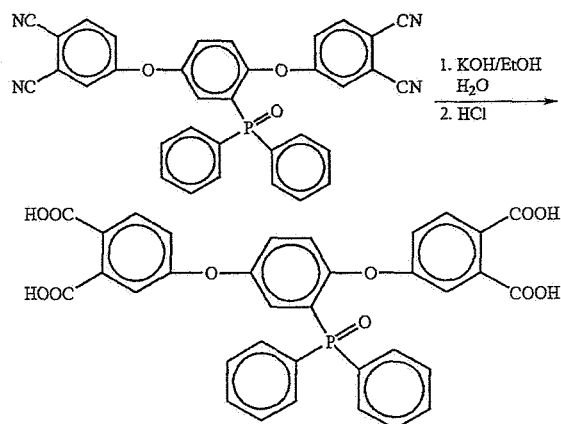


Into a 250 mL three neck round bottomed flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube was placed 4-nitrophthalonitrile (9.9 g, 0.0572 mol), 2,5-dihydroxyphenyl diphenylphosphine oxide (8.87 g, 0.0286 mol), and *N,N*-dimethylformamide (DMAc, 100 mL). The mixture was stirred for 15 minutes at room temperature and then pulverized anhydrous potassium carbonate (9.89 g, 0.0715 mol, 2.5 eq.) was added. The reaction mixture was stirred at room temperature for 24 hours. The reddish-brown reaction mixture was poured into ~ 700 mL of stirred water and the resulting off-white precipitate was collected and washed with water. The solid was stirred in 100 mL of methanol for 10 minutes and was collected and dried for 2 hours in a vacuum oven at 100°C .

36

Step 2

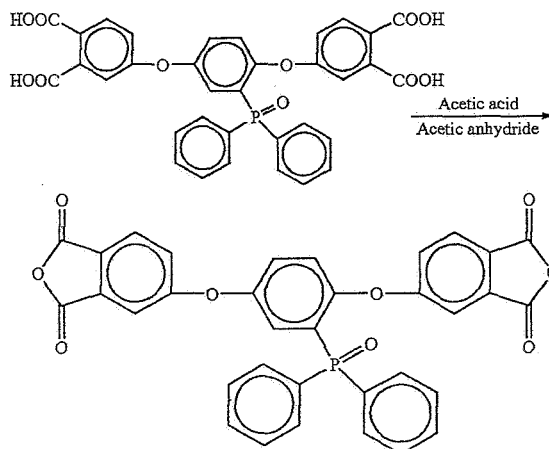
Preparation of [2,5-bis(3,4-dicarboxyphenoxy)phenyl]diphenylphosphine oxide



Into a 250 mL round bottom flask equipped with a magnetic stirrer was placed [2,5-bis(3,4-dicyanophenoxy)phenyl]diphenylphosphine oxide (11.24 g, 0.0213 mol), EtOH (30 mL), potassium hydroxide (11.32 g, 0.1715 mol), and water (30 mL). A condenser was placed on the flask and the mixture was heated to reflux for 24 hours. The reaction was cooled and the ethanol was removed under reduced pressure. The aqueous solution was poured into stirred aqueous HCl and the resulting precipitate was collected and stirred in 1 L of refluxing water. The off-white solid was collected and dried for 2 hours in a vacuum oven at 150°C (12.19 g, 90% yield). The solid exhibited a broad melting point of $212\text{--}218^{\circ}\text{C}$ as determined by DSC at $10^{\circ}\text{C}/\text{min}$.

Step 3

Preparation of 4,4'-(2,5-diphenylphosphineoxydiphenylenedioxy)diphthalic anhydride (PPODA-1)



37

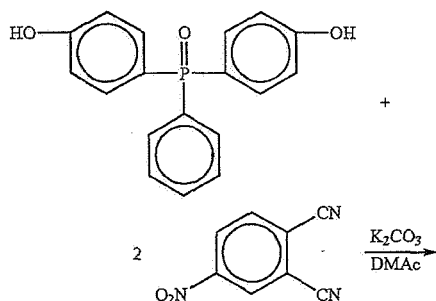
Into a 100 mL round bottom flask equipped with a magnetic stirrer and reflux condenser fitted with a nitrogen gas inlet was placed [2,5-bis(3,4-dicarboxyphenoxy)phenyl] diphenylphosphine oxide (12.19 g, 0.0191 mol), glacial acetic acid (25 mL), and acetic anhydride (25 mL). The mixture was heated to reflux for 14 hours. The reaction was cooled and a fine off-white crystalline solid formed after several hours. The solid was collected, taken up in hot glacial acetic acid, treated with charcoal, and filtered. A white crystalline solid formed after several hours of standing undisturbed. The solid was collected and dried for 4 hours in a vacuum oven at 130° C. (7.19 g, 62%). The solid exhibited a broad melting point of 141–146° C. as determined by DSC at a heating rate of 10° C./min.

Example 9

Preparation of 4,4'-bis(3,4-dicarboxyphenoxy)phenylphosphine oxide dianhydride (PPODA-2)

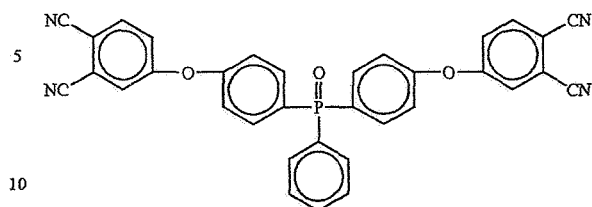
Step 1

Preparation of
4,4'-Bis(3,4-dicyanophenoxy)phenylphosphine
oxide



38

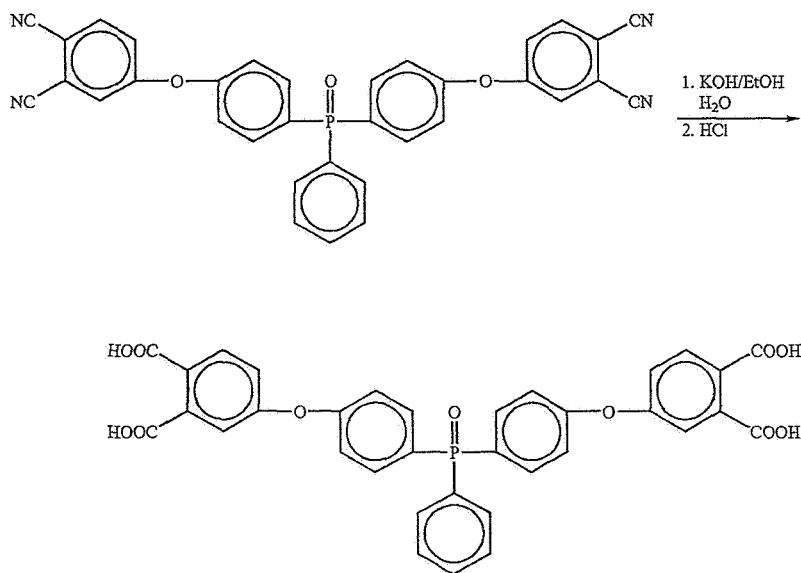
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Into a 500 mL three neck round bottomed flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed 4-nitrophthalonitrile (22.32 g, 0.1289 mol), bis(4-hydroxyphenyl)phenyl phosphine oxide (20.0 g, 0.0645 mol), and N,N-dimethylacetamide (DMAc, 200 mL). The mixture was stirred for 15 minutes at room temperature and then pulverized anhydrous potassium carbonate (22.29 g, 0.1613 mol, 2.5 eq.) was added. The reaction mixture was heated to 150° C. for 12 hours. The dark reaction mixture was poured into ~1200 mL of stirred water and the resulting green precipitate was collected and washed with water. The solid was stirred in refluxing isopropanol and filtered. A solid formed in the yellow filtrate upon cooling. The yellow solid was collected and dried for 2 hours in a vacuum oven at 125° C.

Step 2

Preparation of 4,4'-bis(3,4-dicarboxyphenoxy)phenylphosphine oxide

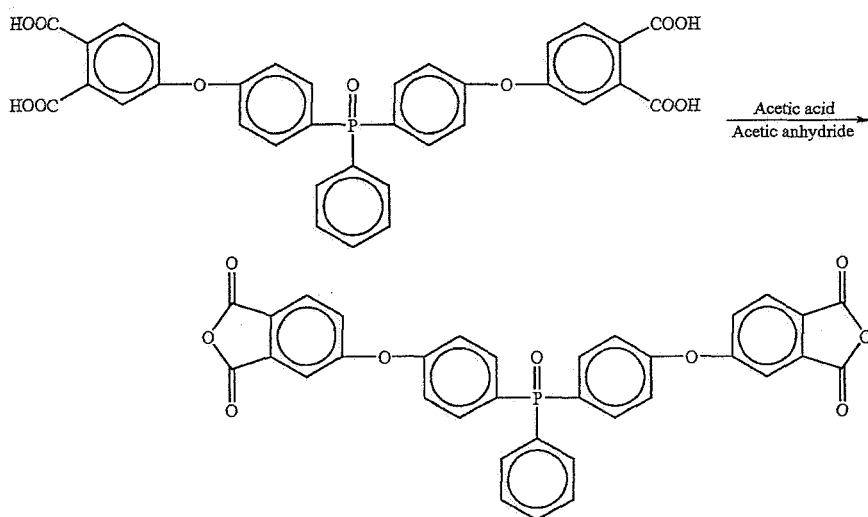


39

Into a 250 mL round bottom flask equipped with a magnetic stirrer was placed 4,4'-Bis(3,4-dicyanophenoxy)phenylphosphine oxide (12.0 g, 0.0213 mol), EtOH (30 mL), potassium hydroxide (11.32 g, 0.1715 mol), and water (30 mL). A condenser was placed on the flask and the mixture was heated to reflux for 24 hours. The reaction was cooled and the ethanol was removed under reduced pressure. The aqueous solution was poured into stirred aqueous HCl and the resulting precipitate was collected and stirred in 1 L of refluxing water. The solid was collected and dried for 2 hours in a vacuum oven at 150° C.

Step 3

Preparation of 4,4'-bis(3,4-dicarboxyphenoxy)phenylphosphine oxide dianhydride



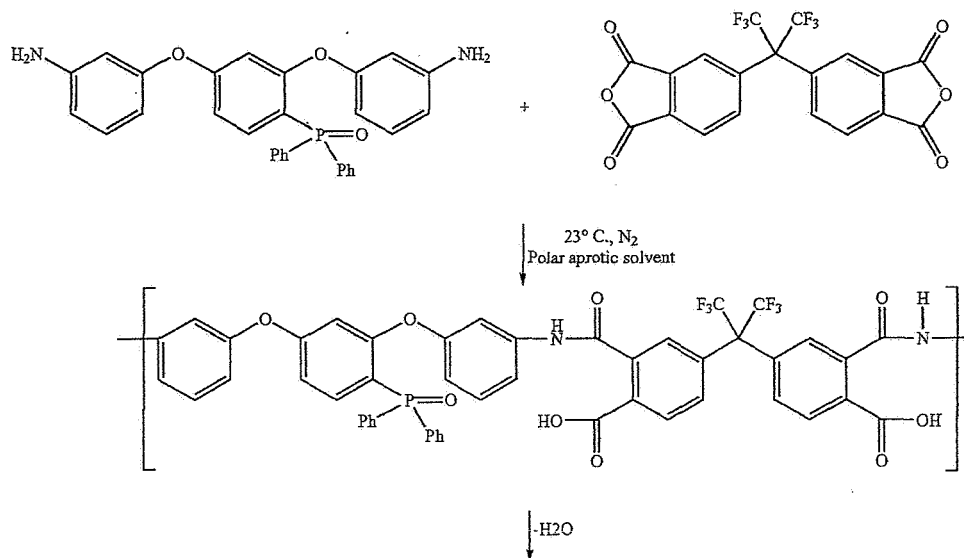
40

gas inlet was placed 4,4'-bis(3,4-dicarboxyphenoxy)phenylphosphine oxide (10.0 g, 0.0157 mol), glacial acetic acid (25 mL), and acetic anhydride (25 mL). The mixture was heated to reflux for 14 hours. The reaction was cooled and a crystalline solid formed after several hours. The solid was collected, taken up in hot glacial acetic acid, treated with charcoal, and filtered. A crystalline solid formed after several hours of standing undisturbed. The solid was collected and dried for 4 hours in a vacuum oven at 130° C.

Example 10

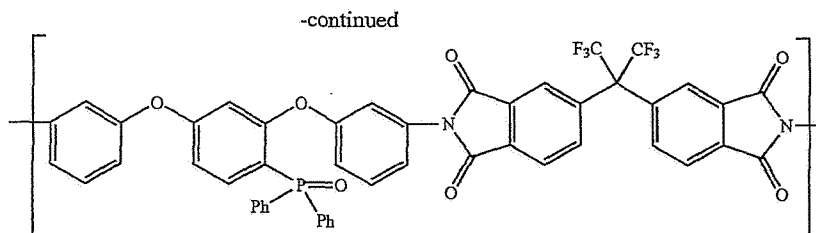
Preparation of polyimide from 4,4'-perfluoroisopropylidene dianhydride and [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry

Into a 100 mL round bottom flask equipped with a magnetic stirrer and reflux condenser fitted with a nitrogen



41

42

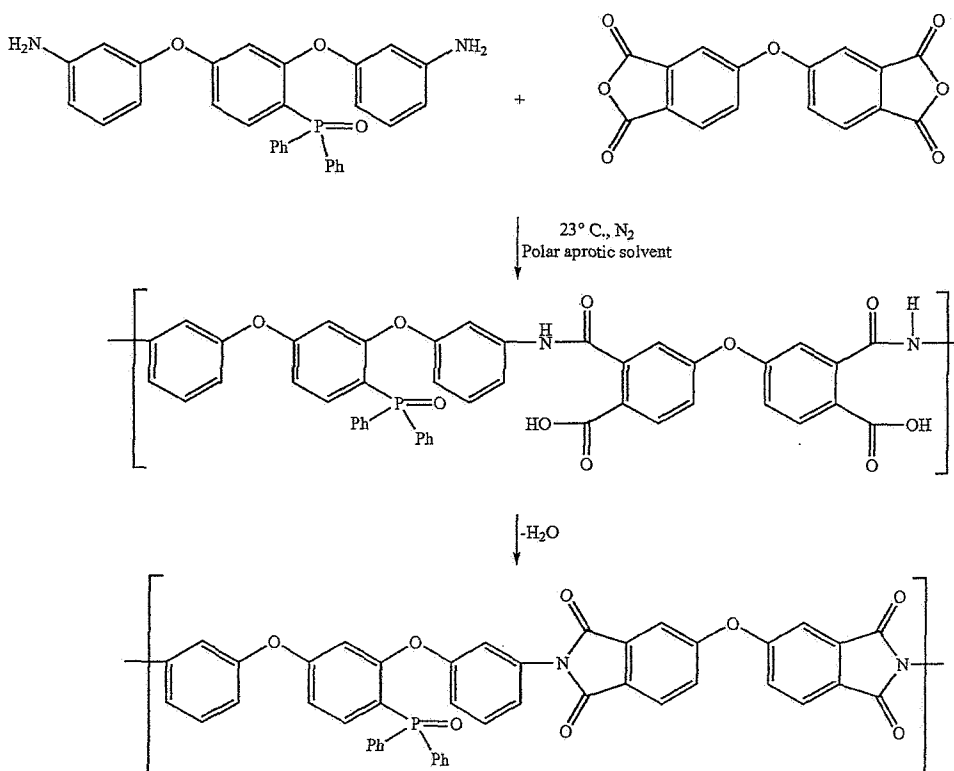


Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (3-APPO, 2.0367 g, 4.1353×10^{-3} mol) and NMP (8.0 mL). Once dissolved, perfluoroisopropylidene dianhydride (1.8371 g, 4.1353×10^{-3} mol) was added along with additional NMP (7.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 0.66 dL/g at 25° C. The remaining polymer solution was chemically imidized by the

dimethylacetamide (DMAc) on a glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The transparent colorless film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 230° C. as determined by DSC at a heating rate of 20° C./min.

Example 11

Preparation of polyimide from oxydipthalic dianhydride and [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry



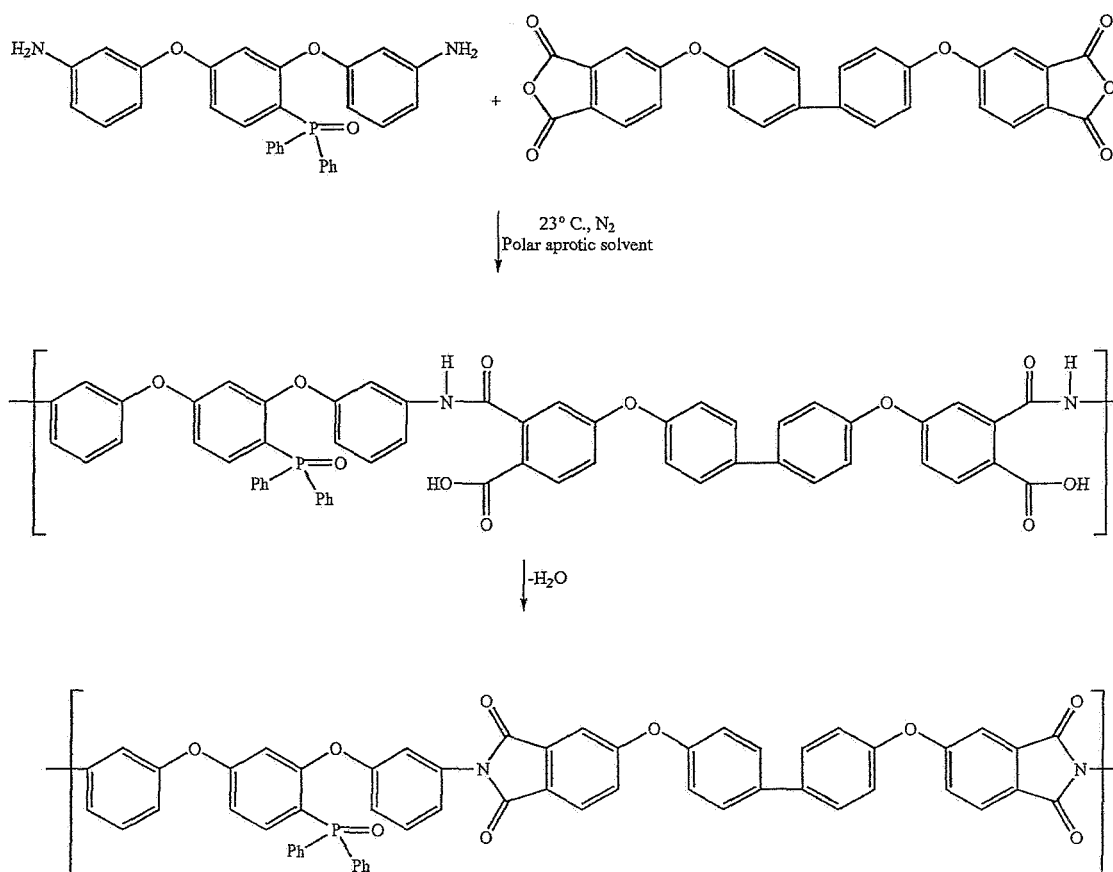
addition of 1.27 g of acetic anhydride and 0.98 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A film cast from N,N-

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed the diamine (2.3768 g, 4.8258×10^{-3} mole) and NMP (7.0 mL). Once dissolved oxydipthalic dianhydride (1.4970 g, 4.8258×10^{-3} mole) was added along with additional NMP (8.0 mL) to give a

solution with a concentration of 20% (w/v) solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% solution in NMP exhibited an inherent viscosity of 1.01 dL/g at 25° C. The remaining polymer solution was chemically imidized by the addition of 1.49 g of acetic anhydride and 1.15 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A film cast from DMAc (12% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The transparent colorless film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 212° C. as DSC at a heating rate of 20° C./min.

Example 12

Preparation of polyimide from 4,4'-biphenoxy dianhydride and [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry

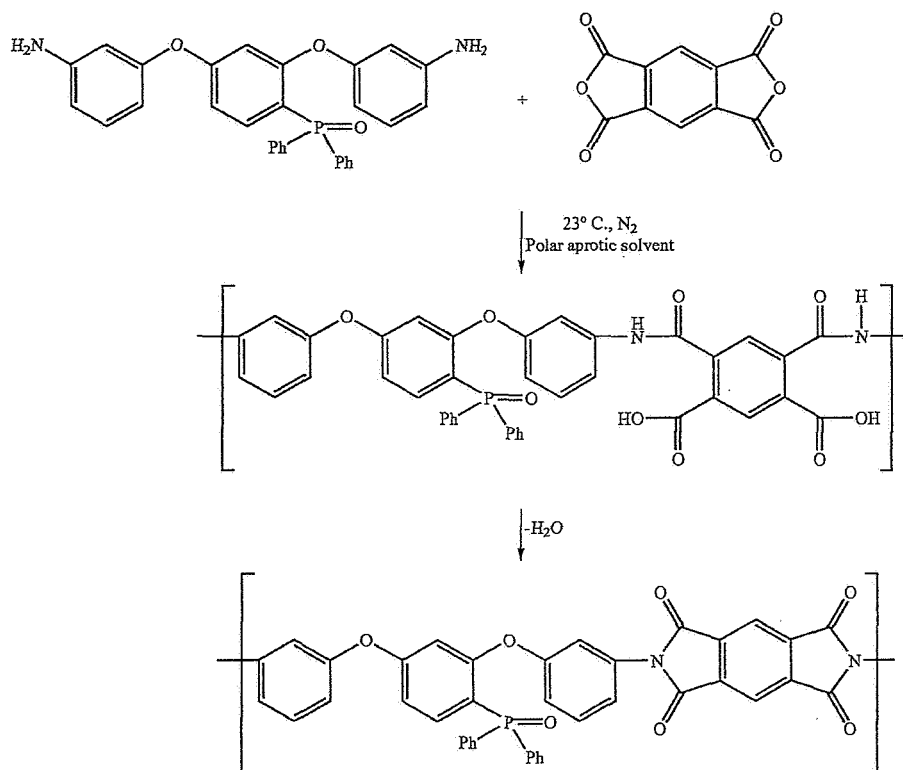


Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed the diamine (2.8200 g, 5.3197×10^{-3} mole) and NMP (10.0 mL). Once dissolved 4,4'-biphenoxy dianhydride (2.5450 g, 5.3197×10^{-3} mole) was added along with additional NMP (10.0 mL) to give a solution with a concentration of 20% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 0.81 dL/g at 25° C. The remaining polymer solution was chemically imidized by the addition of 1.68 g of acetic anhydride and 1.29 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A film cast from DMAc (12% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The transparent colorless film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 227° C. as determined by DSC at a heating rate of 20° C./min.

45

Example 13

Preparation of polyimide from pyromellitic dianhydride and [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry



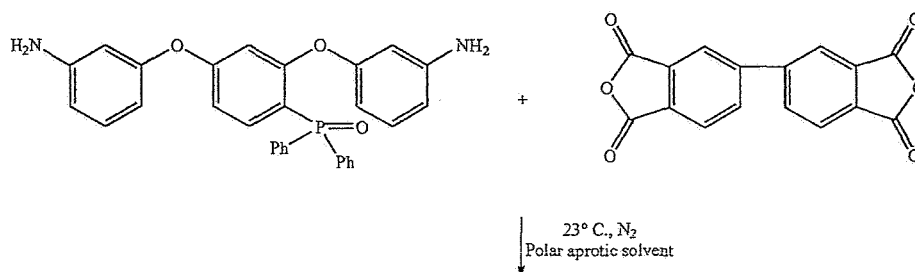
Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed the diamine (2.6848 g, 5.4512×10^{-3} mole) and NMP (7.0 mL). Once dissolved pyromellitic dianhydride (1.1890 g, 5.4512×10^{-3} mole) was added along with additional NMP (8.0 mL) to give a solution with a concentration of 20% solids. The mixture was stirred overnight at room temperature under a nitrogen atmosphere. The orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in

NMP exhibited an inherent viscosity of 0.53 dL/g at 25° C. The remaining polymer solution was chemically imidized by the addition of 1.68 g of acetic anhydride and 1.29 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C.

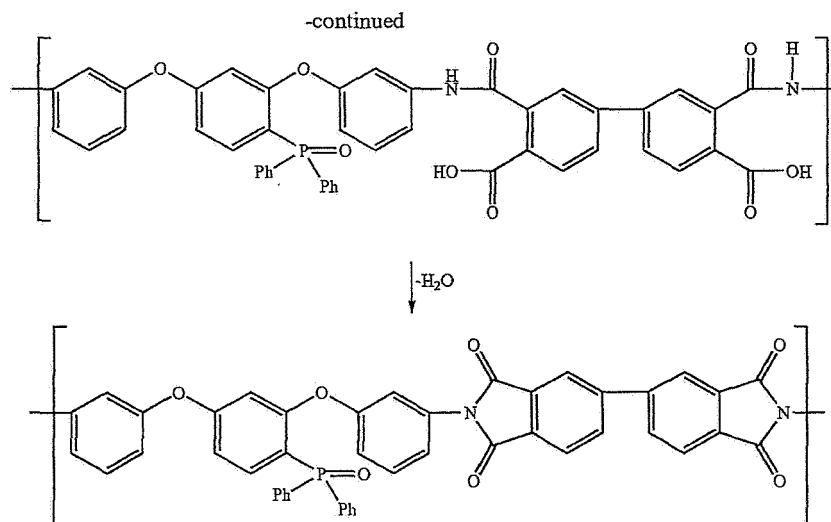
46

Example 14

Preparation of polyimide from 3,3',4,4'-biphenyl tetracarboxylic dianhydride and [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry



overnight to afford a yellow powder with a T_g of 251° C. as determined by DSC at a heating rate of 20° C./min.

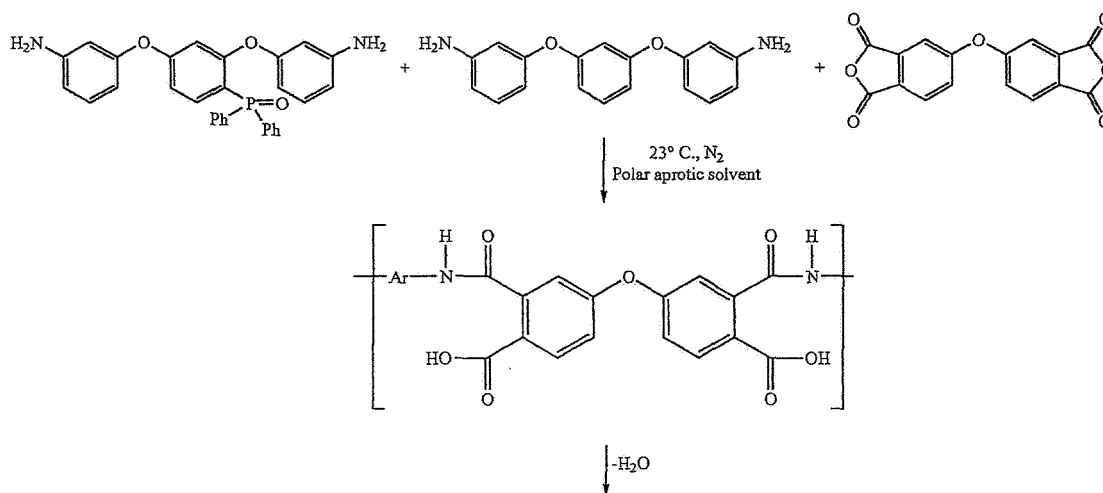


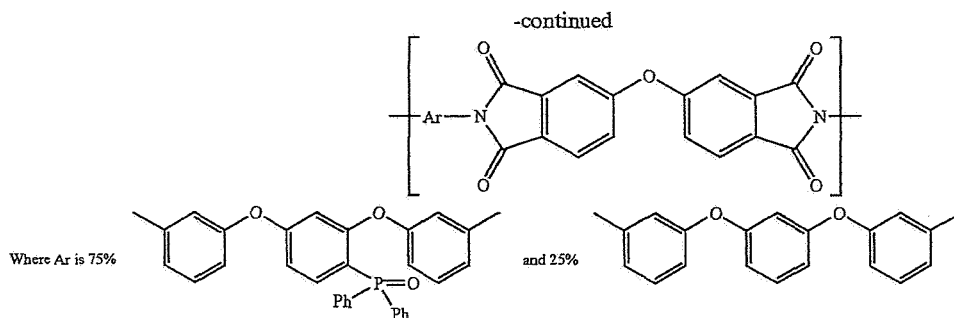
Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed the diamine (2.4251 g, 4.9239×10^{-3} mole) and NMP (7.0 mL). Once dissolved, 3,3',4,4'-biphenyl tetracarboxylic dianhydride (1.4487 g, 4.9239×10^{-3} mole) was added along with additional NMP (8.0 mL) to give a solution with a concentration of 20% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 0.97 dL/g at 25° C. The remaining polymer solution was chemically imidized by the addition of 1.49 g of acetic anhydride and 1.15 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford an off-white, fibrous material. A film cast from DMAc onto plate glass using a

doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The transparent light-yellow film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 234° C. as determined by DSC at a heating rate of 20° C./min.

Example 15

Preparation of random copolyimide from oxydiphthalic dianhydride and 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % 1,3-bis(3-aminophenoxy)benzene using 1:1 stoichiometry



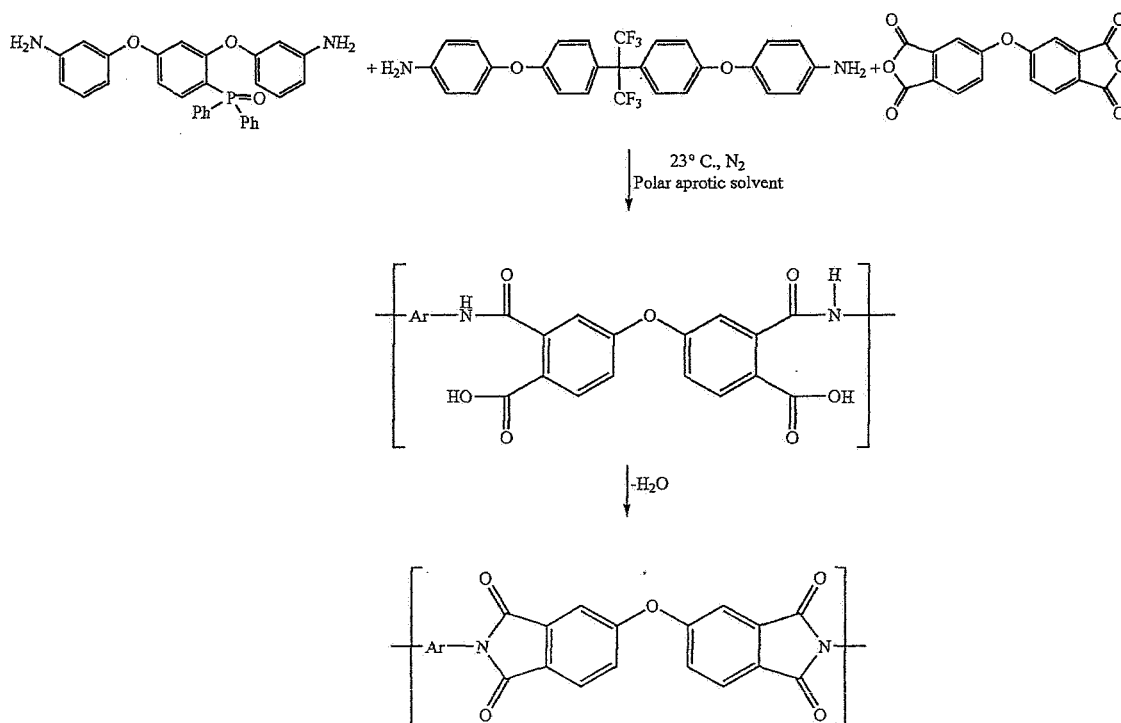


Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.5347 g, 5.1464×10^{-3} mole), 1,3-bis(3-aminophenoxy)benzene (0.5015 g, 1.7155×10^{-3} mole) and NMP (10.0 mL). Once dissolved, oxydipthalic dianhydride (2.1287 g, 6.8619×10^{-3} mole) was added along with additional NMP (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 1.07 dL/g at 25° C. The remaining polymer solution was chemically imidized by the addition of 2.12 g of acetic anhydride and 1.63 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50

mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A film cast from DMAc onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 203° C. as determined by DSC at a heating rate of 20° C./min.

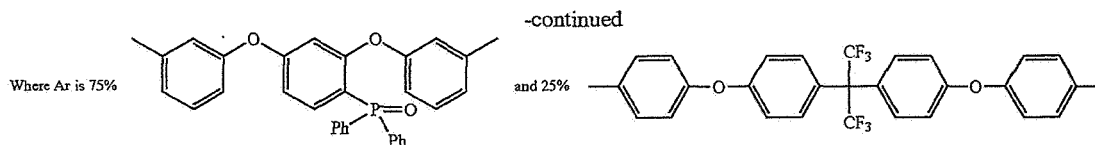
Example 16

Preparation of random copolyimide from oxydipthalic dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of 2,2-bis(4-(4-aminophenoxy)phenyl)hexafluoropropane using 1:1 stoichiometry



51

52



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.1377 g, 4.340×10^{-3} mole), 2,2-bis(4-(4-aminophenoxy)phenyl)hexafluoropropane (0.7501 g, 1.447×10^{-3} mole) NMP (10.0 mL). Once dissolved, oxydiphthalic dianhydride (1.7953 g, 5.787×10^{-3} mole) was added along with additional NMP (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.78 g of acetic anhydride and 1.37 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated

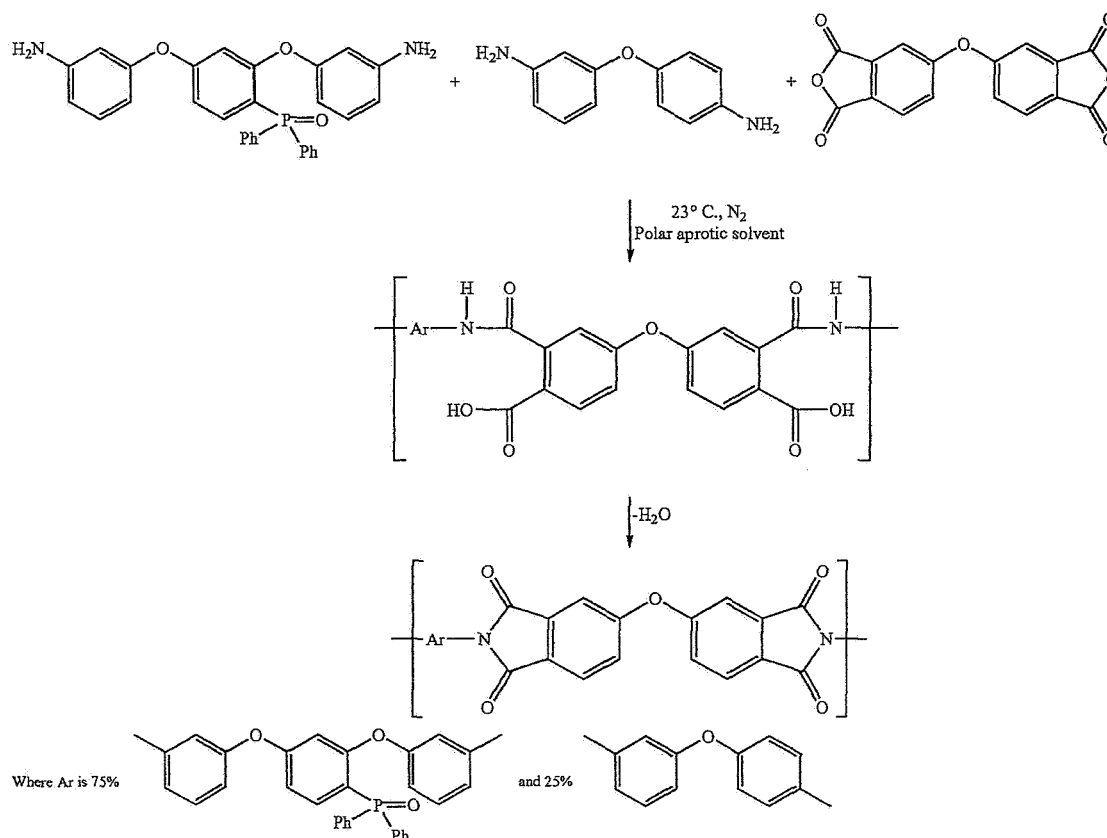
10 free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 216° C. as determined by DSC at a heating rate of 20° C./min.

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Example 17

Preparation of random copolyimide from oxydiphthalic dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of 3,4'-oxydianiline using 1:1 stoichiometry



in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.66 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust

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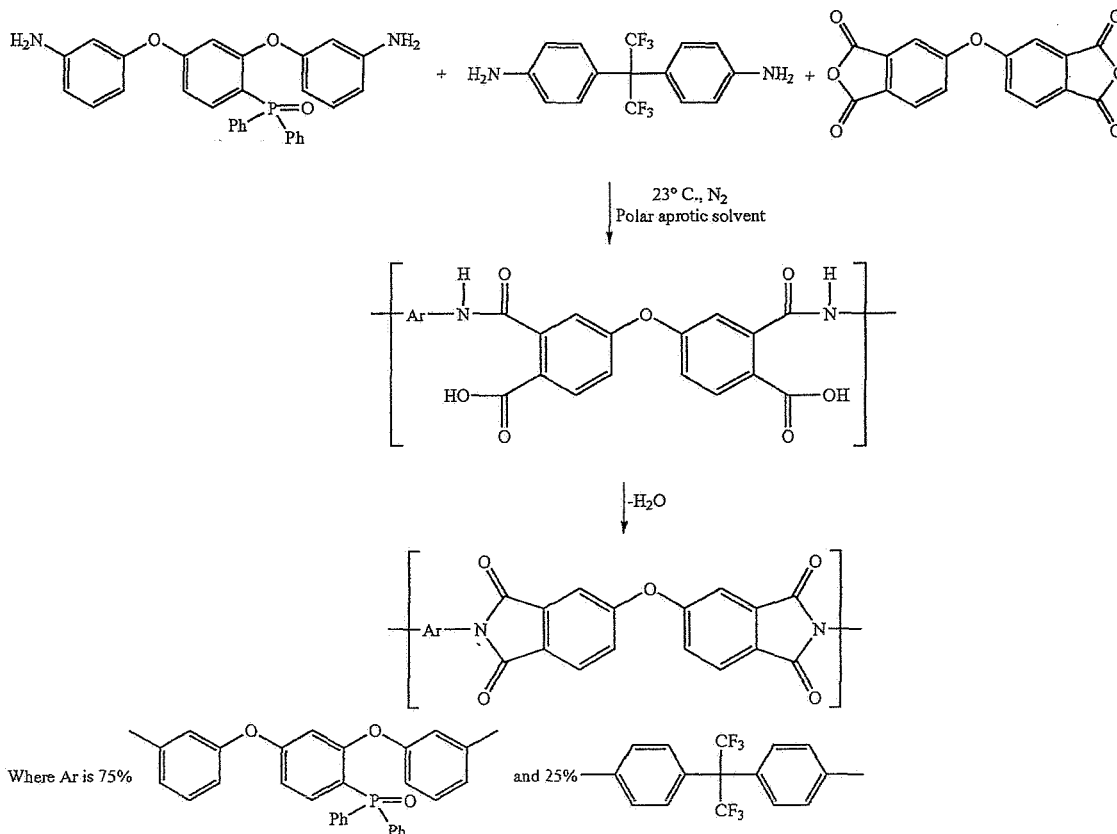
Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.3707 g, 4.814×10^{-3} mole), 3,4'-oxydianiline (0.3213 g, 1.605×10^{-3} mole) and DMAc (10.0 mL). Once dissolved oxydiphthalic dianhy-

53

dride (1.9910 g, 6.412×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids weight/volume. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.93 g of acetic anhydride and 1.45 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% solution in NMP exhibited an inherent viscosity of 0.57 dL/g at 25° C. A film was cast from DMAc (15% solids w/w) onto a plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 218° C. as determined by DSC at a heating rate of 20° C./min.

Example 18

Preparation of random copolyimide from oxydiphthalic dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of 2,2-bis(4-aminophenyl)hexafluoropropane using 1:1 stoichiometry

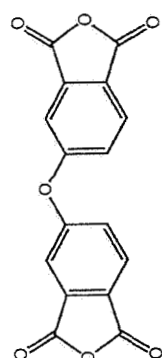


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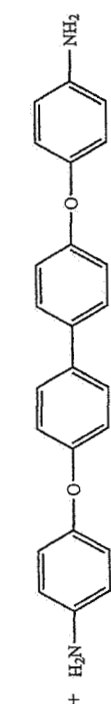
Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.4999 g, 5.076×10^{-3} mol), 2,2-bis(4-aminophenyl)hexafluoropropane (0.5656 g, 1.692×10^{-3} mole) and NMP (10.0 mL). Once dissolved, oxydiphthalic dianhydride (2.0995 g, 6.768×10^{-3} mole) was added along with additional NMP (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.93 g of acetic anhydride and 1.45 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 0.57 dL/g at 25° C. A film cast from DMAc onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 220° C. as determined by DSC at a heating rate of 20° C./min.

Example 19

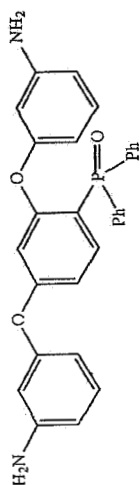
Preparation of random copolyimide from oxydiphthalic dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of bis(4-aminophenoxy)biphenyl using 1:1 stoichiometry



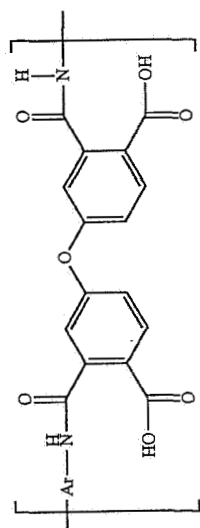
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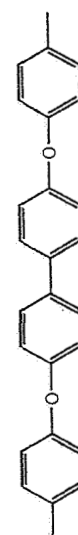
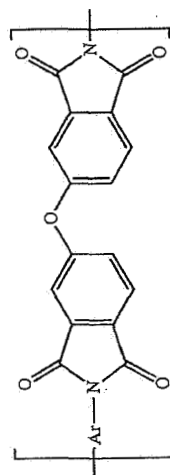
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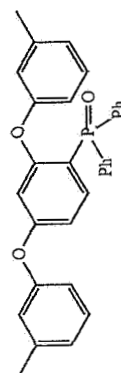
23° C., N₂
Polar aprotic solvent



-H₂O



and 25%



Where Ar is 75%

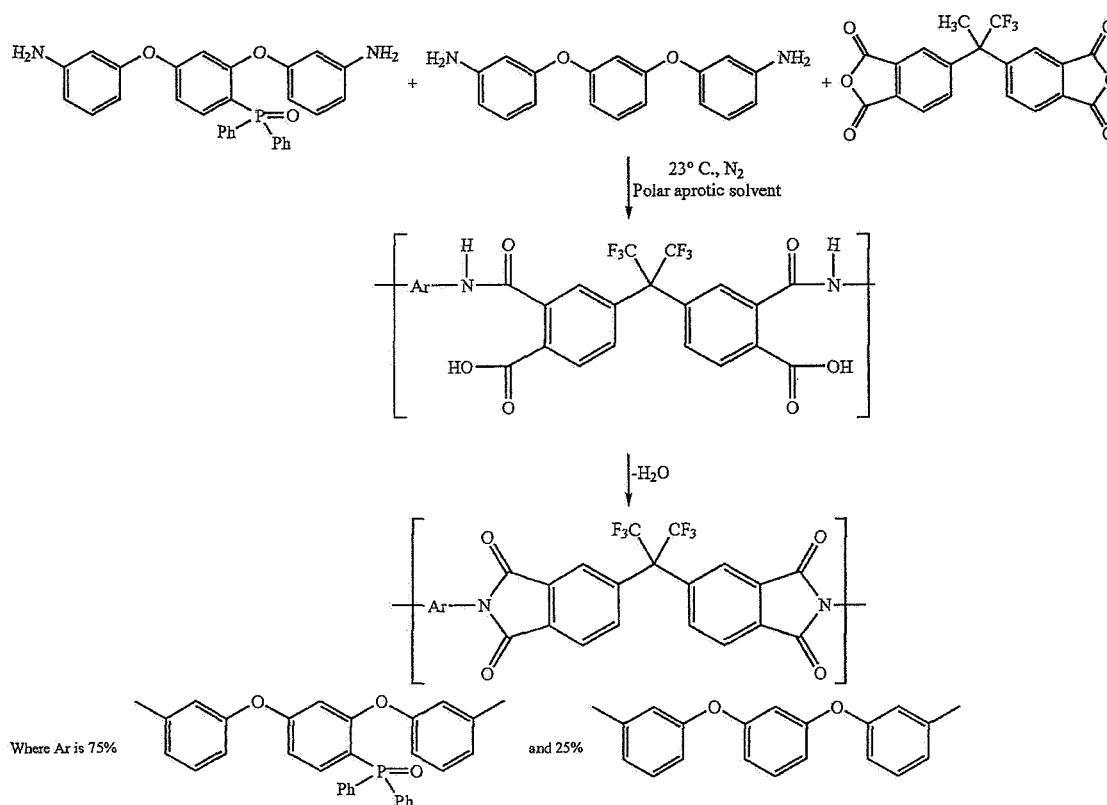
57

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.4723 g, 5.020×10^{-3} mole), bis(4-aminophenoxy)biphenyl (0.6165 g, 1.617×10^{-3} mole) and DMAc (10.0 mL). The diamines dissolved within a few minutes and oxydiphthalic dianhydride (2.0763 g, 6.693×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concen-

58

Example 20

Preparation of random copolyimide from
4,4'-perfluoroisopropylidene dianhydride, 75 mole
% of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of
1,3-bis(3-aminophenoxy)benzene using 1:1
stoichiometry



tration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.93 g of acetic anhydride and 1.45 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.73 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 222° C. as determined by DSC at a heating rate of 20° C./min.

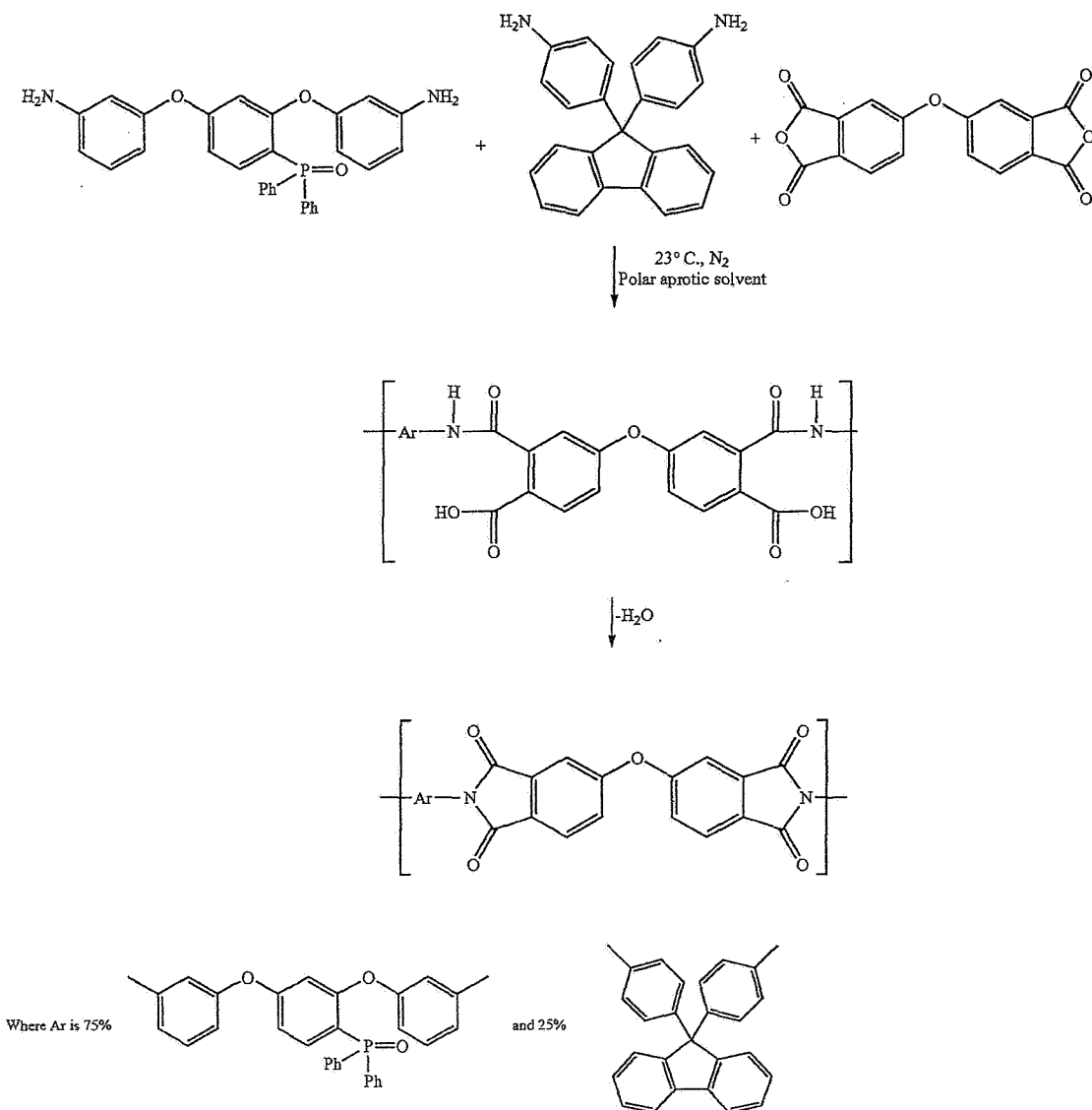
Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.1516 g, 4.369×10^{-3} mole), 1,3-bis(3-aminophenoxy)benzene (0.4257 g, 1.456×10^{-3} mole) and DMAc (10.0 mL). The diamines dissolved within a few minutes and 4,4'-perfluoroisopropylidene dianhydride (2.5877 g, 5.824×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.93 g of acetic anhydride and 1.45 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 0.53 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a

59

doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 224° C. as determined by DSC at a heating rate of 20° C./min.

Example 21

Preparation of random copolyimide from oxydiphthalic dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % 9,9-bis(4-aminophenyl)fluorene using 1:1 stoichiometry



60

filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.2562 g, 4.581×10^{-3} mole), 9,9-bis(4-aminophenyl)fluorene (0.5321 g, 1.527×10^{-3} mole) and DMAc (10.0 mL). Once dissolved, oxydiphthalic dianhydride (1.8945 g, 6.107×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.93 g of acetic anhydride and 1.45 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution in

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube

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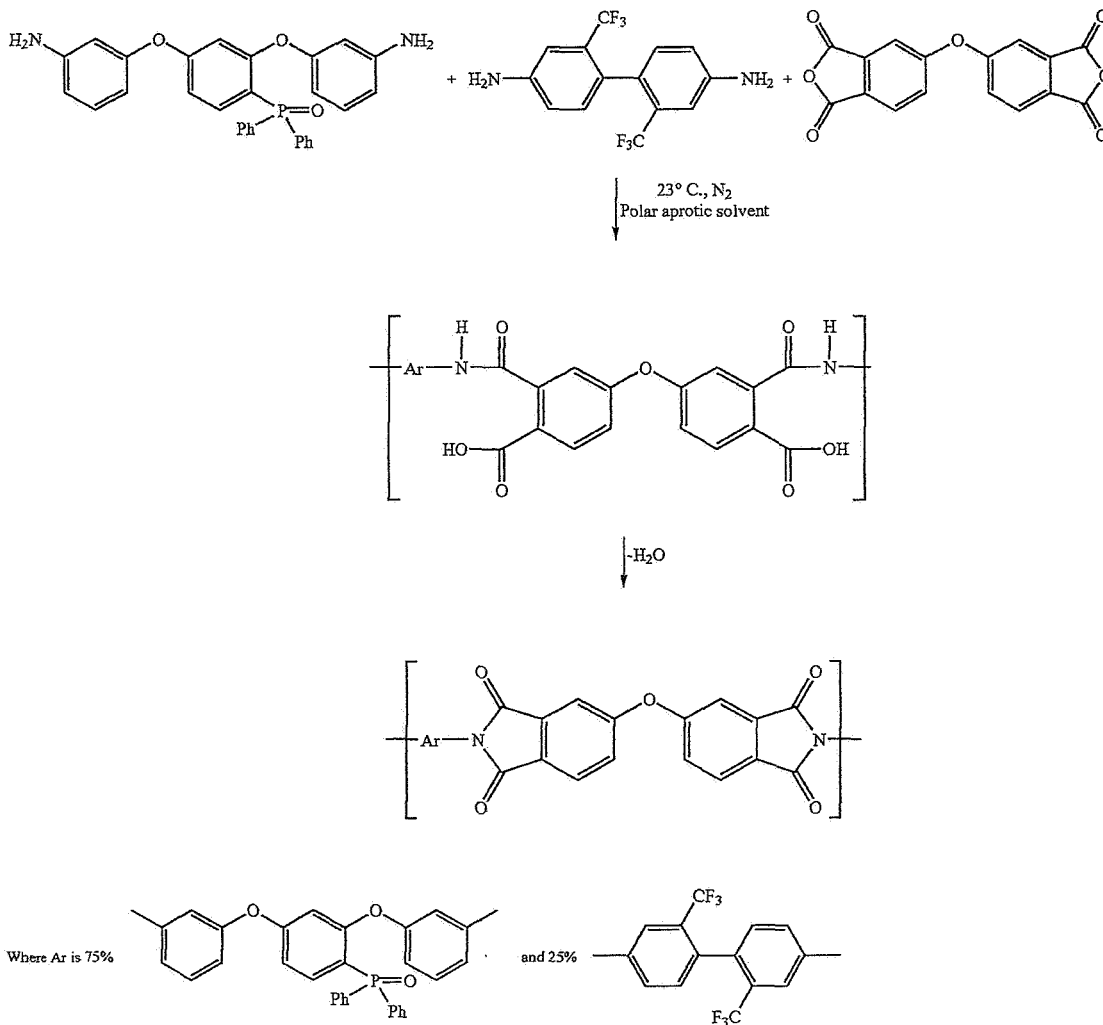
NMP exhibited an inherent viscosity of 0.39 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass

61

using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited a T_g of 226° C. as determined by DSC at a heating rate of 20° C./min.

Example 22

Preparation of random copolyimide from oxydiphthalic dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % 2,2'-bis(trifluoromethyl)benzidine using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.5035 g, 5.083×

62

10^{-3} mole), bis(trifluoromethyl)benzidine (0.5438 g, 1.694×10^{-3} mole) and DMAc (10.0 mL). Once dissolved, oxydiphthalic dianhydride (2.1025 g, 6.777×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.93 g of acetic anhydride and 1.45 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.46 dL/g at 25° C. A film

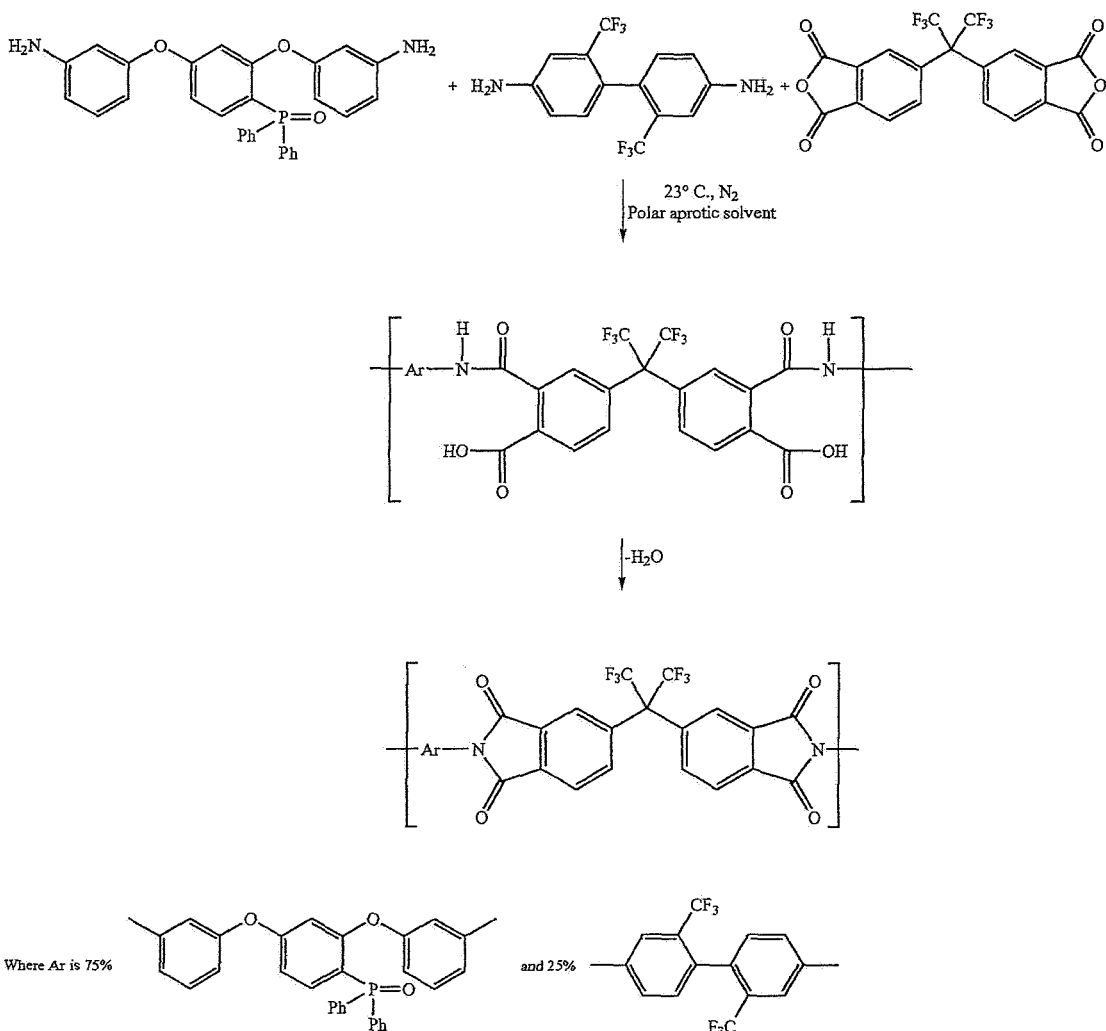
cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and

63

200° C. and one hour each at 225 and 250° C. The film exhibited a T_g of 227° C. as determined by DSC at a heating rate of 20° C./min.

Example 23

Preparation of random copolyimide from
4,4'-perfluoroisopropylidene dianhydride, 75 mole
% of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of
2,2'-bis(trifluoromethyl)benzidine using 1:1
stoichiometry



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Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.1344 g, 4.337×10⁻³ mole), 2,2'-bis(trifluoromethyl)benzidine (0.4636 g, 1.445×10⁻³ mole) and DMAc (10.0 mL). Once dissolved

64

4,4'-perfluoroisopropylidene dianhydride (2.5670 g, 5.778×10⁻³ mole) was added along with DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.34 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a

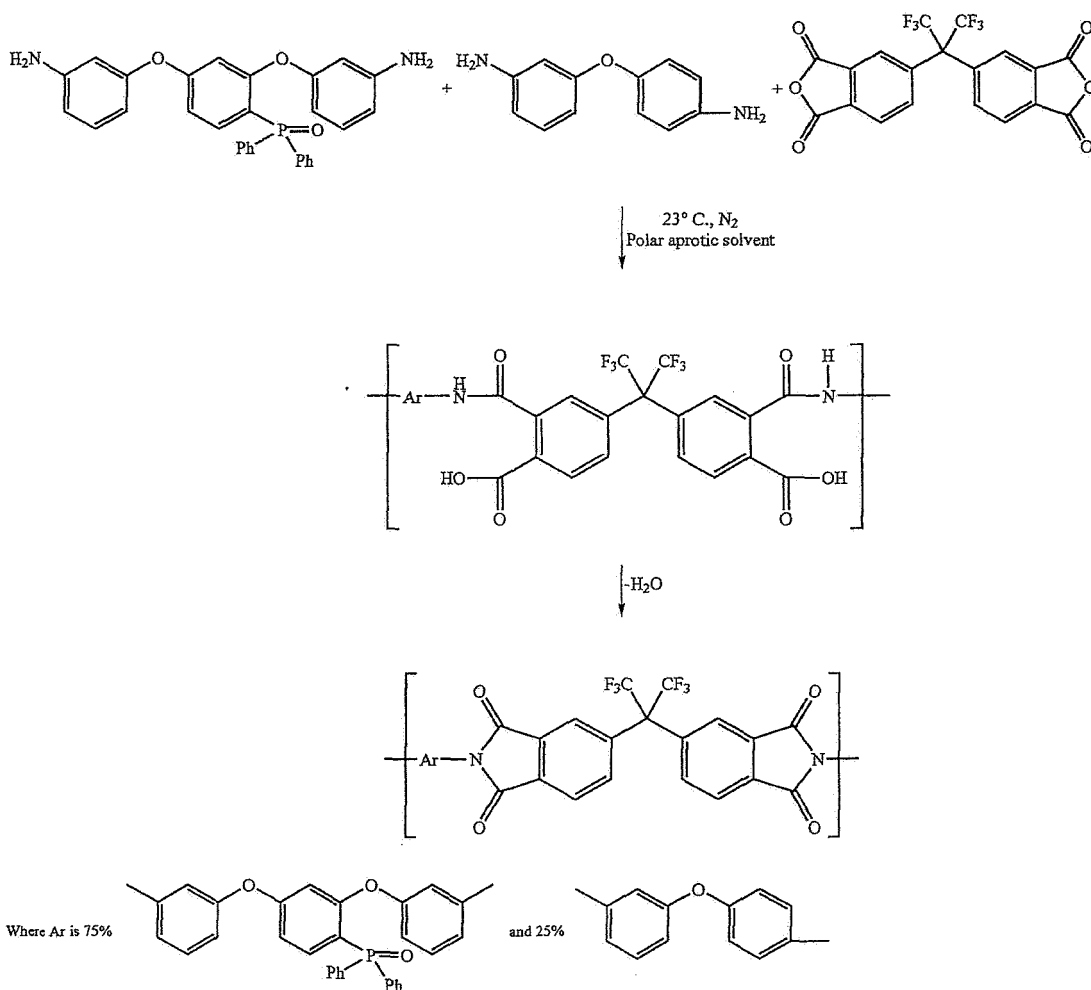
doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 233° C. as determined by DSC at a heating rate of 20° C./min.

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Example 24

Preparation of random copolyimide from from
4,4'-perfluoroisopropylidene dianhydride, 75 mole
% of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of 3,4'-oxydianiline using 1:1
stoichiometry



Into a 100 mL three neck round bottom flask equipped
with a mechanical stirrer, nitrogen gas inlet and drying tube
filled with calcium sulfate was placed [2,4-bis(3-aminophe-
noxy)phenyl]diphenylphosphine oxide (2.0028 g, 4.067×10^{-3} mole), 3,4'-oxydianiline (0.2714 g, 1.356×10^{-3} mole)
and DMAc (10.0 mL). Once dissolved, 4,4'-perfluoroiso-
propylidene dianhydride (2.4087 g, 5.5422×10^{-3} mole) was
added along with additional DMAc (10.0 mL) to give a
solution with a concentration of 20% solids. The light
yellow solution was stirred overnight at room temperature
under a nitrogen atmosphere. The polymer solution was
chemically imidized by the addition of 1.67 g of acetic
anhydride and 1.28 g of pyridine. The solution was stirred at

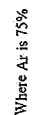
66

room temperature overnight. The polymer was precipitated
in a blender containing water, filtered, washed with excess
water and dried in a vacuum oven at 110° C. overnight to
afford a white, fibrous material. A 0.5% (w/v) solution NMP
exhibited an inherent viscosity of 0.42 dL/g at 25° C. A film
cast from DMAc (15% solids w/w) onto plate glass using a
doctor blade was allowed to dry to a tack-free state in a dust
free chamber. The film on the glass plate was placed in a
forced air oven for 30 minutes each at 75, 100, 125, 150 and

200° C. and one hour each at 225 and 250° C. The film
exhibited good flexibility and a T_g of 234° C. as determined
by DSC at a heating rate of 20° C./min.

Example 25

Preparation of random copolyimide from 4,4'-per-
fluoroisopropylidene dianhydride, 75 mole % of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of 2,2-bis(4-(4-aminophe-
noxy)phenyl)hexafluoropropane using 1:1 stoichi-
ometry



69

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.0227 g, 4.107×10^{-3} mole), 2,2-Bis(4-(4-aminophenoxy)phenyl)hexafluoropropane (0.7097 g, 1.369×10^{-3} mole) DMAc (10.0 mL). Once dissolved, 4,4'-perfluoroisopropylidene dianhydride (2.4326 g, 5.476×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution in NMP exhibited an inherent vis-

70

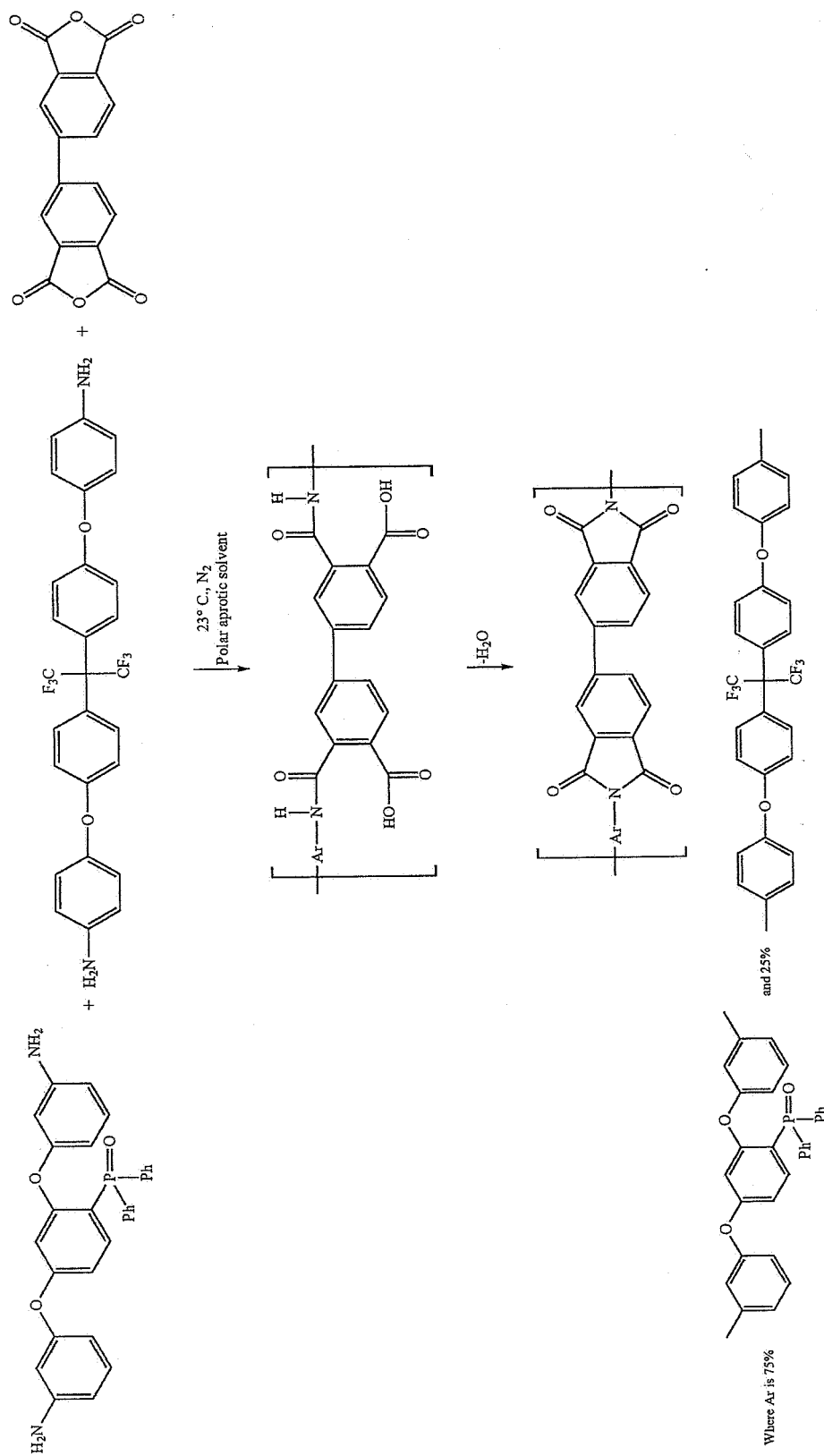
cosity of 0.58 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 234° C. as determined DSC at a heating rate of 20° C./min.

Example 26

Preparation of random copolyimide from 3,3',4',4'-biphenyl tetracarboxylic dianhydride 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of 2,2-bis(4-(4-aminophenoxy)phenyl)hexafluoropropane using 1:1 stoichiometry

71

72



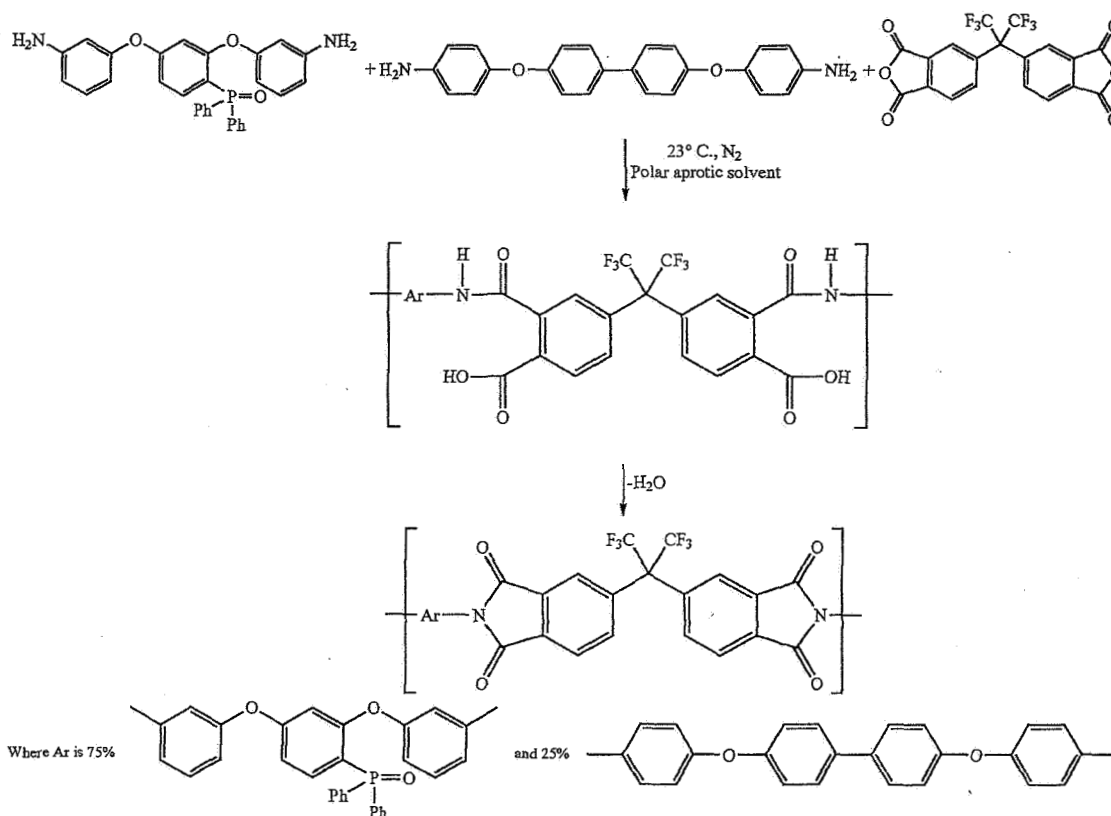
73

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.4052 g, 4.884×10^{-3} mole), 2,2-bis(4-(4-aminophenoxy)phenyl)hexafluoropropane (0.8440 g, 1.628×10^{-3} mole) and DMAc (10.0 mL). Once dissolved, 3,3',4',4'-biphenyl tetracarboxylic dianhydride (1.9158 g, 6.511×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a

74

Example 27

Preparation of random copolyimide from 4,4'-perfluoroisopropylidene dianhydride, 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of bis(4-aminophenoxy)biphenyl using 1:1 stoichiometry



concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution in NMP exhibited an inherent viscosity of 0.49 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 237° C. as determined DSC at a heating rate of 20° C./min.

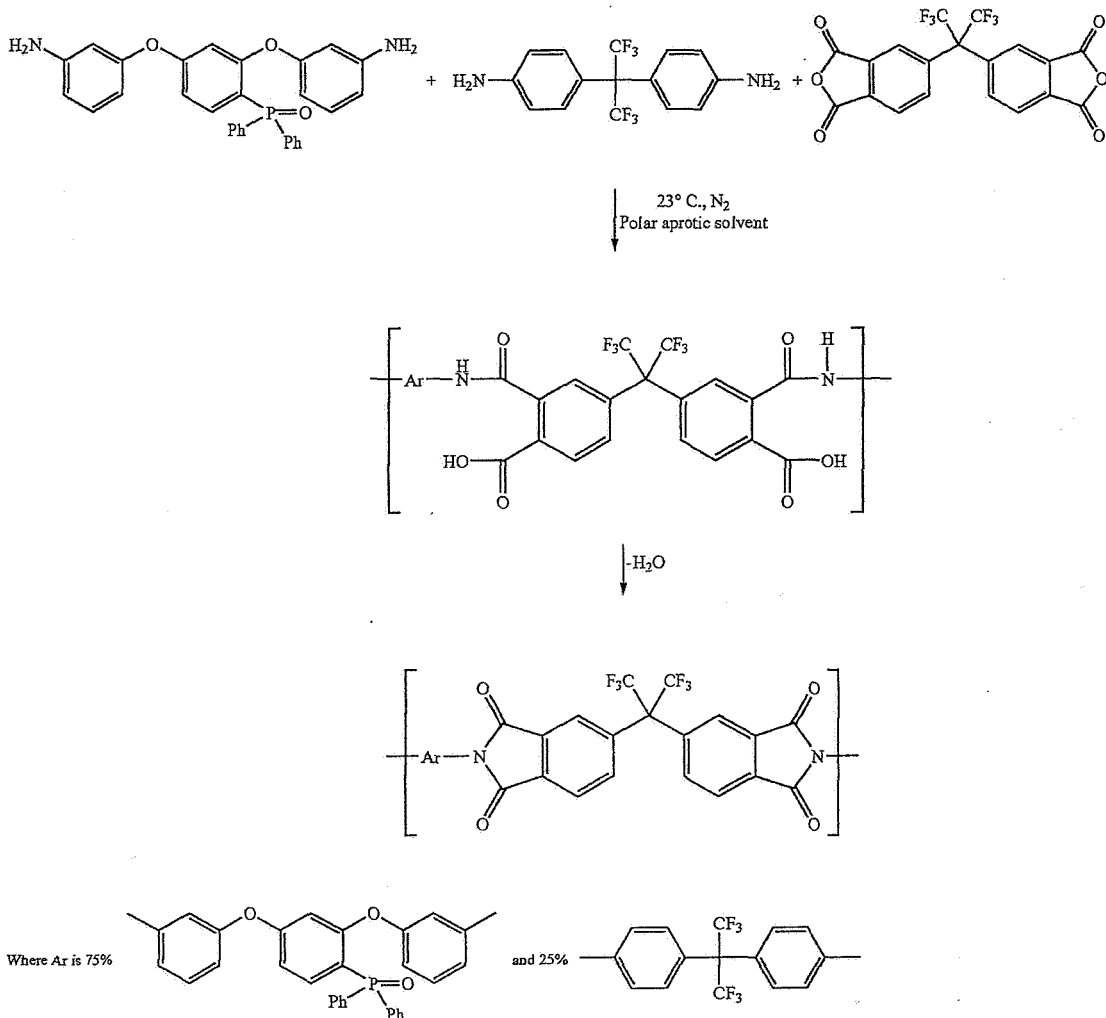
Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.1064 g, 4.277×10^{-3} mole), bis(4-aminophenoxy)biphenyl (0.5253 g, 1.426×10^{-3} mole) and DMAc (10.0 mL). Once dissolved, 4,4'-perfluoroisopropylidene dianhydride (2.5333 g, 5.703×10^{-3} mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.57 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate

75

glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 238° C. as determined by DSC at a heating rate of 20° C./min.

Example 28

Preparation of random copolyimide from
4,4'-perfluoroisopropylidene dianhydride, 75 mole
% of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of
2,2-bis(4-aminophenyl)hexafluoropropane using 1:1
stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.1265 g, 4.318×10⁻³ mol), 2,2-bis(4-aminophenyl)hexafluoropropane

76

(0.4811 g, 1.439×10⁻³ mole) and DMAc (10.0 mL). Once dissolved, 4,4'-perfluoroisopropylidene dianhydride (2.5579 g, 5.757×10⁻³ mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.39 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on

the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 238° C. as determined by DSC at a heating rate of 20° C./min.

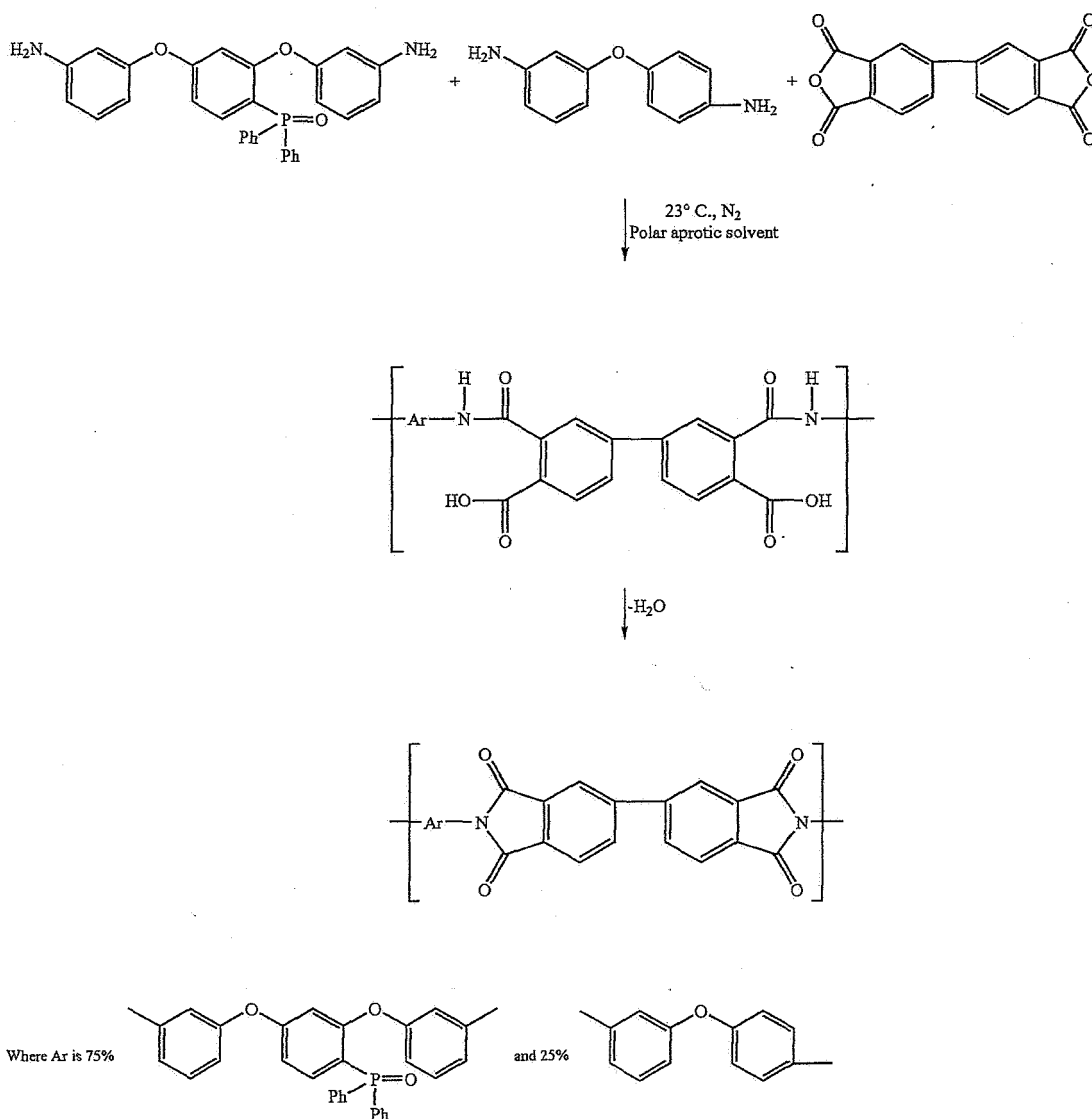
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Example 29

Preparation of random copolyimide from
3,3',4',4'-biphenyl tetracarboxylic dianhydride, 75
mole % of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of 3,4'-oxydianiline using 1:1
stoichiometry

78

with a concentration of 20% solids. The light yellow solu-
tion was stirred overnight at room temperature under a
nitrogen atmosphere. The polymer solution was chemically
imidized by the addition of 1.67 g of acetic anhydride and
1.28 g of pyridine. The solution was stirred at room tem-
perature overnight. The polymer was precipitated in a
blender containing water, filtered, washed with excess water
and dried in a vacuum oven at 110° C. overnight to afford a
white, fibrous material. A 0.5% (w/v) solution in NMP



Into a 100 mL three neck round bottom flask equipped
with a mechanical stirrer, nitrogen gas inlet, and drying tube
filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.6733 g, 5.428×10^{-3} mole), 3,4'-oxydianiline (0.3623 g, 1.809×10^{-3} mole) and DMAc (10.0 mL). Once dissolved, 3,3',4',4'-biphenyl
tetracarboxylic dianhydride (2.1294 g, 7.237×10^{-3} mole)
was added along with DMAc (10.0 mL) to give a solution

exhibited an inherent viscosity of 0.26 dL/g at 25° C. A film
cast from DMAc (15% solids w/w) onto plate glass using a
doctor blade was allowed to dry to a tack-free state in a dust
free chamber. The film on the glass plate was placed in a
forced air oven for 30 minutes each at 75, 100, 125, 150 and
200° C. and one hour each at 225 and 250° C. The film
exhibited good flexibility and a T_g of 240° C. as determined
by DSC at a heating rate of 20° C./min.

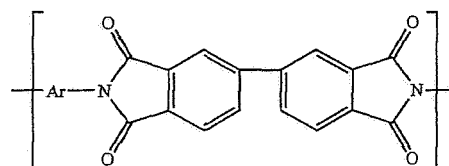
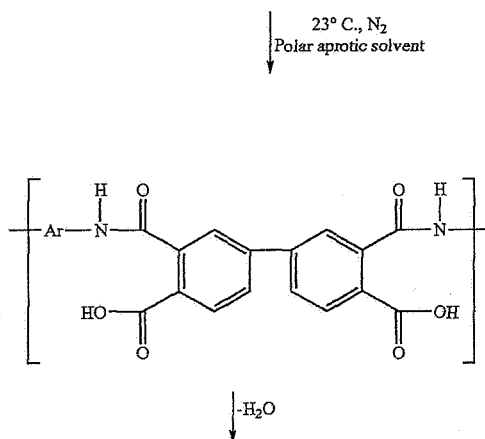
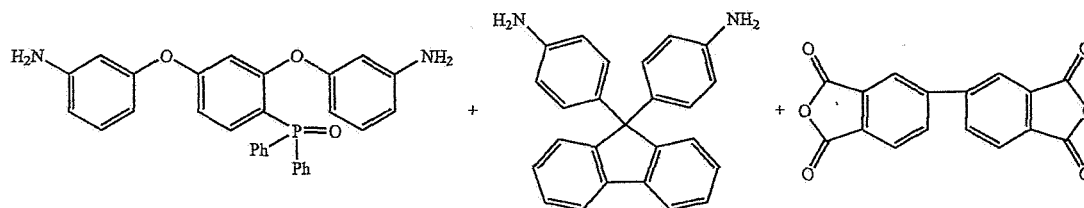
79

Example 30

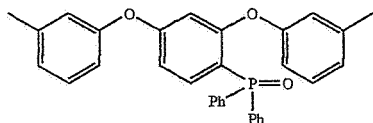
Preparation of random copolyimide from 3,3',4,4'-biphenyl tetracarboxylic dianhydride 75 mole % of [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide and 25 mole % of 9,9-bis(4-aminophenyl) fluorene using 1:1 stoichiometry

80

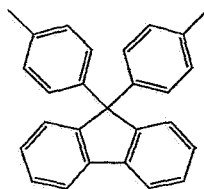
1.720 $\times 10^{-3}$ mole) and DMAc (10.0 mL). Once dissolved, 3,3',4,4'-biphenyl tetracarboxylic dianhydride (2.0243 g, 6.880 $\times 10^{-3}$ mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The



Where Ar is 75%



and 25%



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.5414 g, 5.160 $\times 10^{-3}$ mole), 9,9-bis(4-aminophenyl)fluorene (0.5993 g,

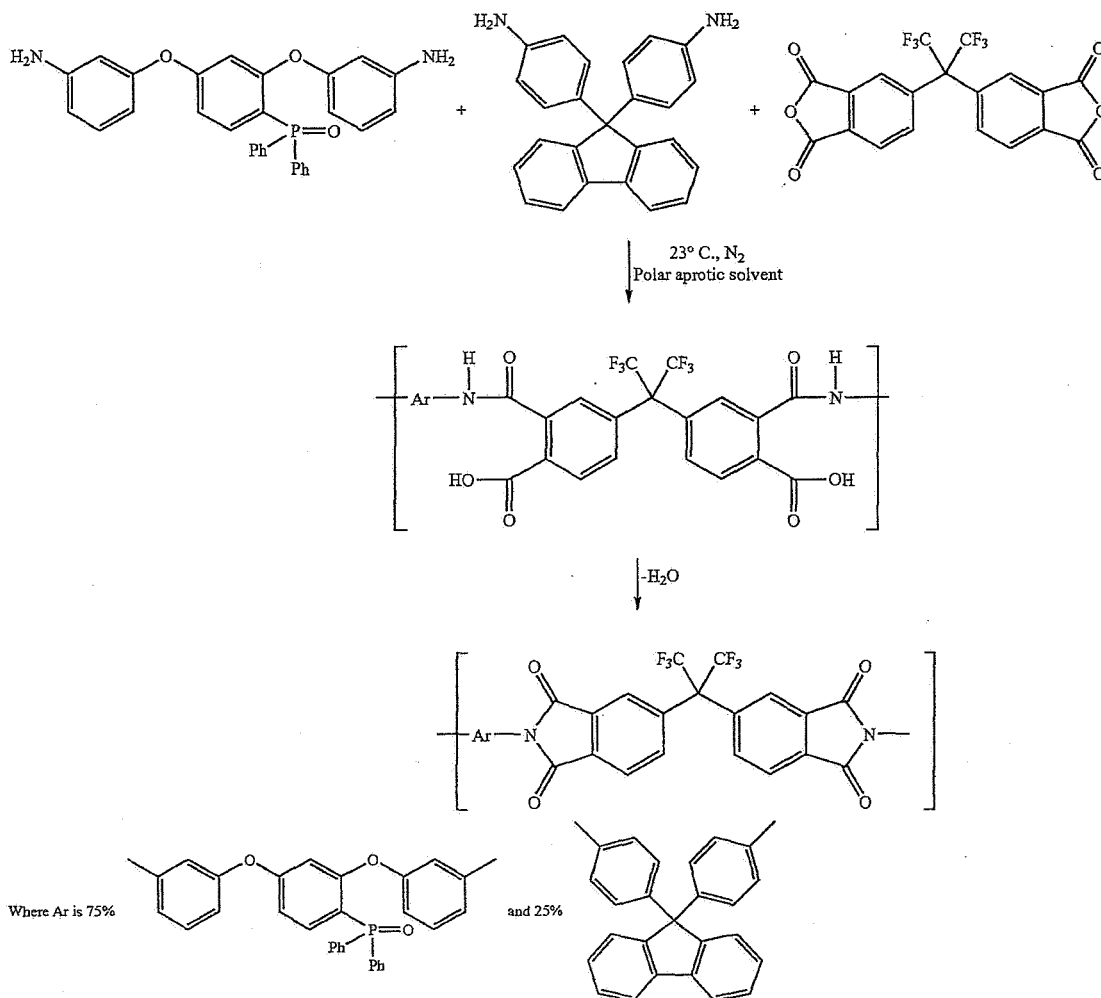
solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity

81

of 0.28 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 246° C. as determined by DSC at a heating rate of 20° C./min.

Example 31

Preparation of random copolyimide from
4,4'-perfluoroisopropylidene dianhydride, 75 mole
% of
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide and 25 mole % of
9,9-bis(4-aminophenyl)fluorene using 1:1
stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (2.1181 g, 4.301×

82

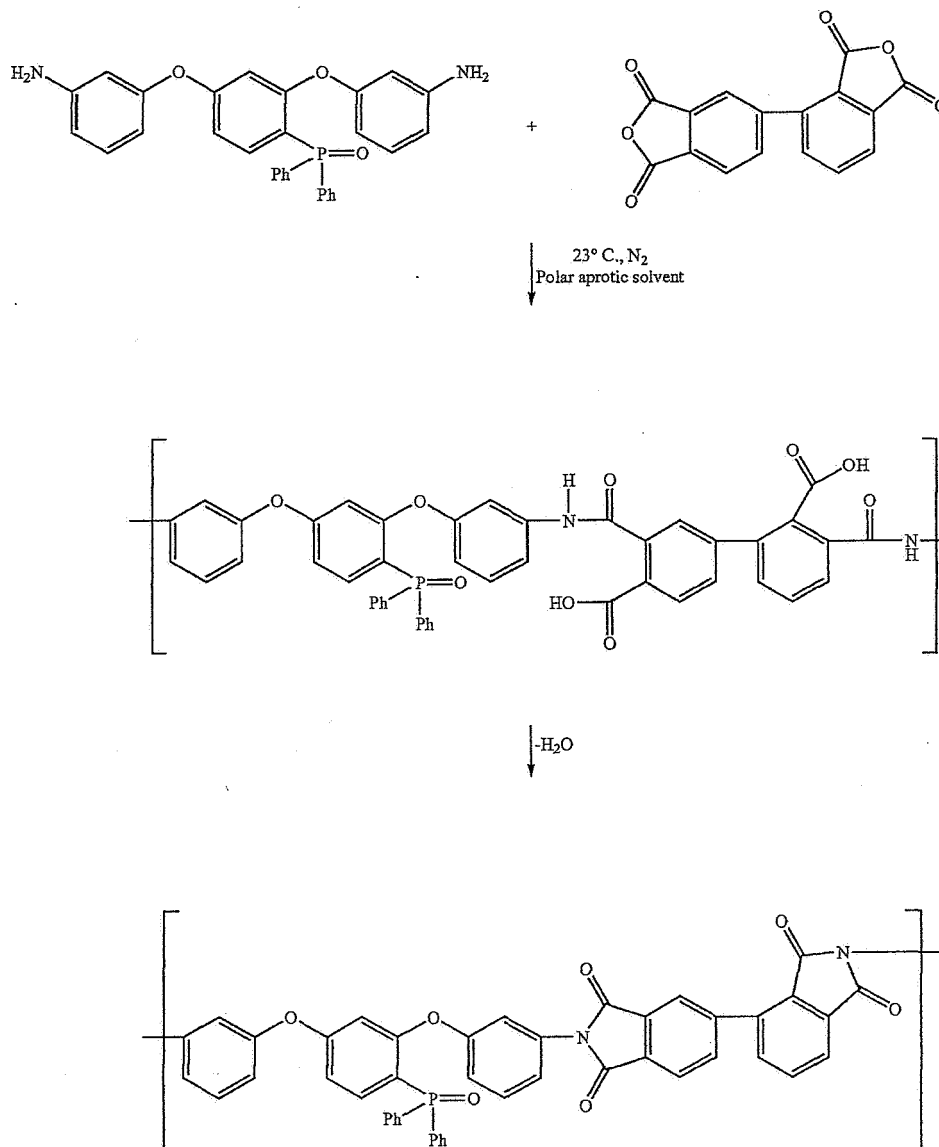
10⁻³ mol), 9,9-bis(4-aminophenyl)fluorene (0.4995 g, 1.434×10⁻³ mole) and DMAc (10.0 mL). Once dissolved, 4,4'-perfluoroisopropylidene dianhydride (2.5474 g, 5.734×10⁻³ mole) was added along with additional DMAc (10.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. The polymer solution was chemically imidized by the addition of 1.67 g of acetic anhydride and 1.28 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing water, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a white, fibrous material. A 0.5% (w/v) solution NMP exhibited an inherent viscosity of 0.48 dL/g at 25° C. A film cast from DMAc (15% solids w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was

placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The film exhibited good flexibility and a T_g of 249° C. as determined by DSC at a heating rate of 20° C./min.

83

Example 32

Preparation of polyimide from 2,3,3',4'-biphenyl
tetracarboxylic dianhydride and
[2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine
oxide using 1:1 stoichiometry



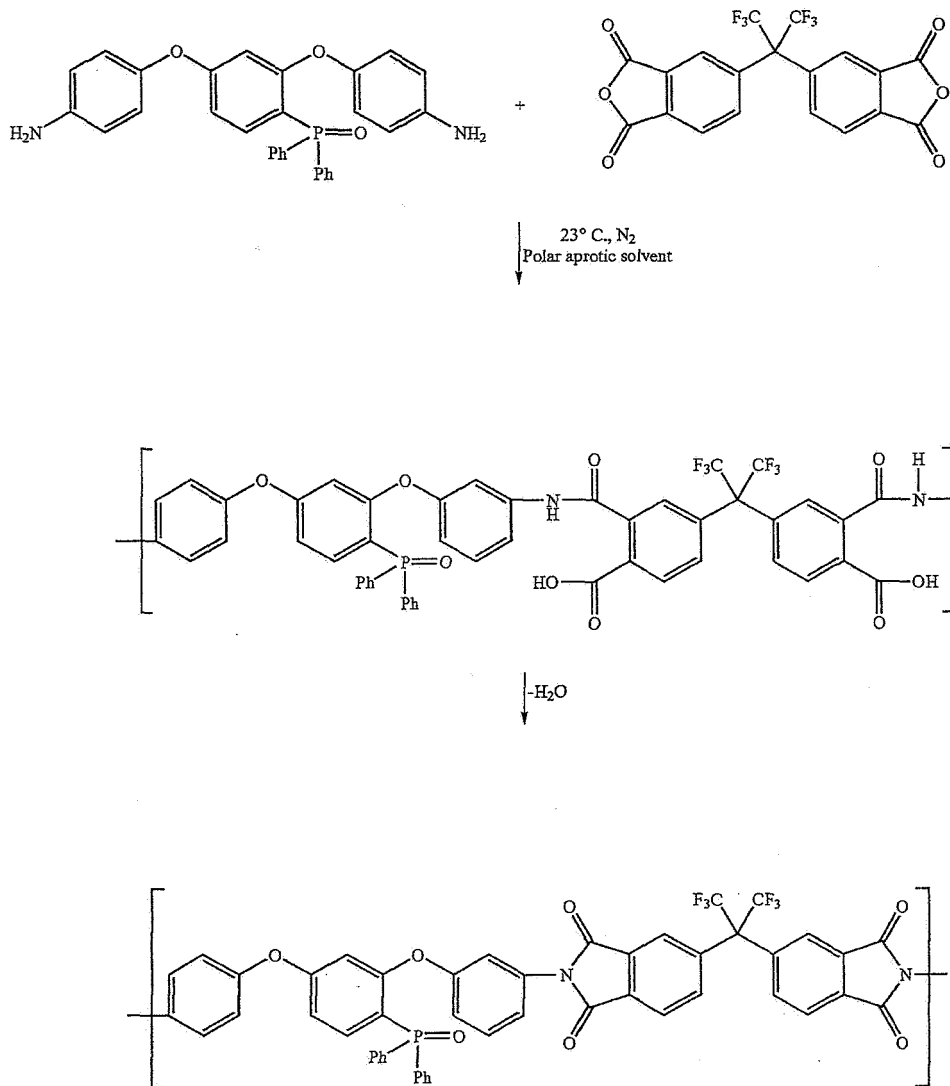
84

four hours under a nitrogen atmosphere. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 150° C. overnight to afford a white, fibrous material. A 0.5 g/dL solution in DMAc had a viscosity of 0.49 dL/g. A film cast from DMAc (20% solids

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and condenser was placed the diamine (3.0000 g, 6.0912×10^{-3} mole) and m-cresol (10.0 g). Once dissolved 2,3,3',4'-biphenyl tetracarboxylic dianhydride (1.7922 g, 6.0912×10^{-3} mole) was added along with additional m-cresol (9.2 g) and 0.5 mL of isoquinoline to give a solution with a concentration of 20% (w/v) solids. The orange solution was stirred at 200° C. for

w/w) onto plate glass using a doctor blade was allowed to dry to a tack-free state in a dust free chamber. The film on the glass plate was placed in a forced air oven for 30 minutes each at 75, 100, 125, 150 and 200° C. and one hour each at 225 and 250° C. The transparent low color film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 230° C. as DSC at a heating rate of 20° C./min.

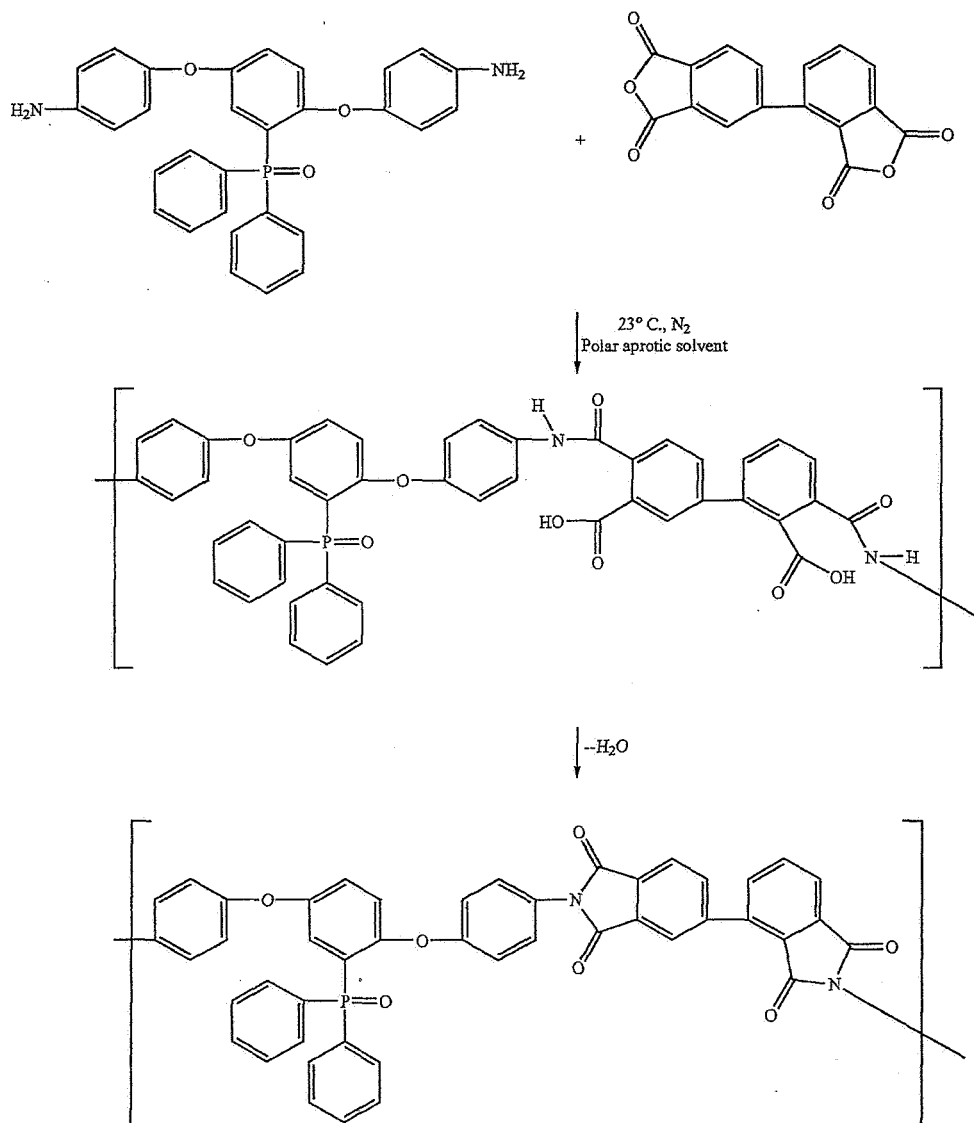
Preparation of polyimide from
4,4'-perfluoroisopropylidene dianhydride and
[2,4-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide using 1:1 stoichiometry 5



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,4-bis(4-aminophenoxy)-phenyl]diphenylphosphine oxide (1,3,4-APPO, 2.0367 g, 4.1353×10^{-3} mol) and NMP (8.0 mL). Once dissolved, perfluoroisopropylidene dianhydride (1.8371 g, 4.1353×10^{-3} mol) was added along with additional NMP (7.0 mL) to give a solution with a concentration of 20% solids. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v)

solution in NMP exhibited an inherent viscosity of 0.31 dL/g at 25° C. The remaining polymer solution was chemically imidized by the addition of 1.27 g of acetic anhydride and 0.98 g of pyridine. The solution was stirred at room temperature overnight. The polymer was precipitated in a blender containing a 50/50 mixture of water/methanol, filtered, washed with excess water and dried in a vacuum oven at 110° C. overnight to afford a quantitative yield of an amber colored material.

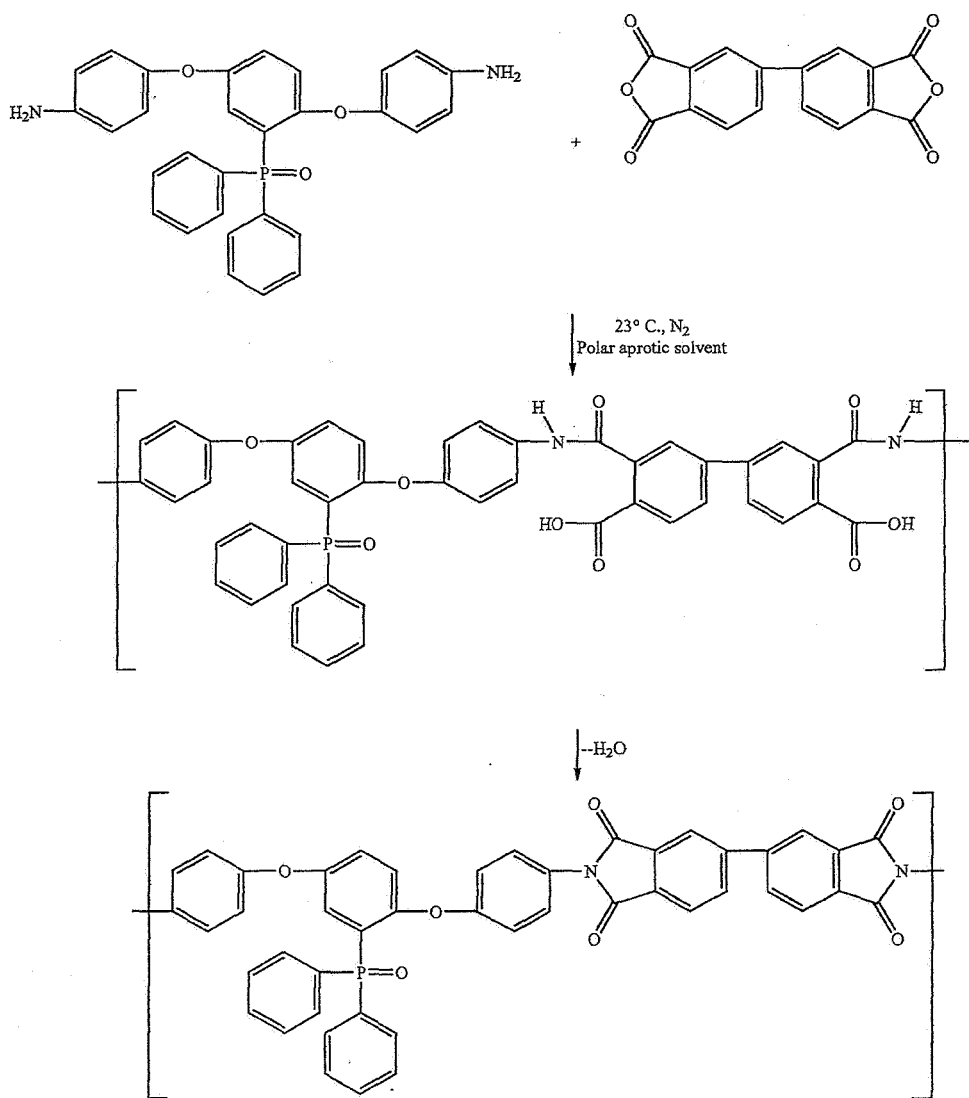
Preparation of polyimide from
2,3,3',4'-biphenyltetracarboxylic dianhydride and
[2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,5-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (4,4'-APPO, 2.0465 g, 0.0042 mol) and N,N-dimethylacetamide (DMAc, 4.0 mL). Once dissolved, 2,3,3',4'-biphenyl tetracarboxylic dianhydride (1.2225 g, 0.0042 mol) was added as a slurry in 5.0 mL DMAc and rinsed in with additional DMAc (5.0 mL) to give a solution with a concentration of 19.86% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.59 dL/g at 25° C.

The solution was centrifuged and cast on plate glass in a low humidity chamber. The film on plate glass was placed in a forced air oven for 1 hour each at 100, 200, and 300° C. The transparent light amber film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 259° C. as determined by DSC at a heating rate of 20° C./min. Unoriented thin film tensile properties at room temperature were: 15.8 ksi strength, 491 ksi modulus, and 13% elongation at break. For a film thickness of 1.5 mil, the thermal emissivity (ϵ) was 0.622 and the solar absorptance (α) was 0.159. The ratio α/ϵ was 0.256.

Preparation of polyimide from
3,3',4,4'-biphenyltetracarboxylic dianhydride and
[2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,5-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (4,4'-APPO, 2.0119 g, 0.0041 mol) and N,N-dimethylacetamide (DMAc, 4.0 mL). Once dissolved, 3,3',4,4'-biphenyl tetracarboxylic dianhydride (1.2019 g, 0.0041 mol) was added as a slurry in 5.0 mL DMAc and rinsed in with additional DMAc (5.0 mL) to give a solution with a concentration of 19.59% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 1.00 dL/g at 25° C.

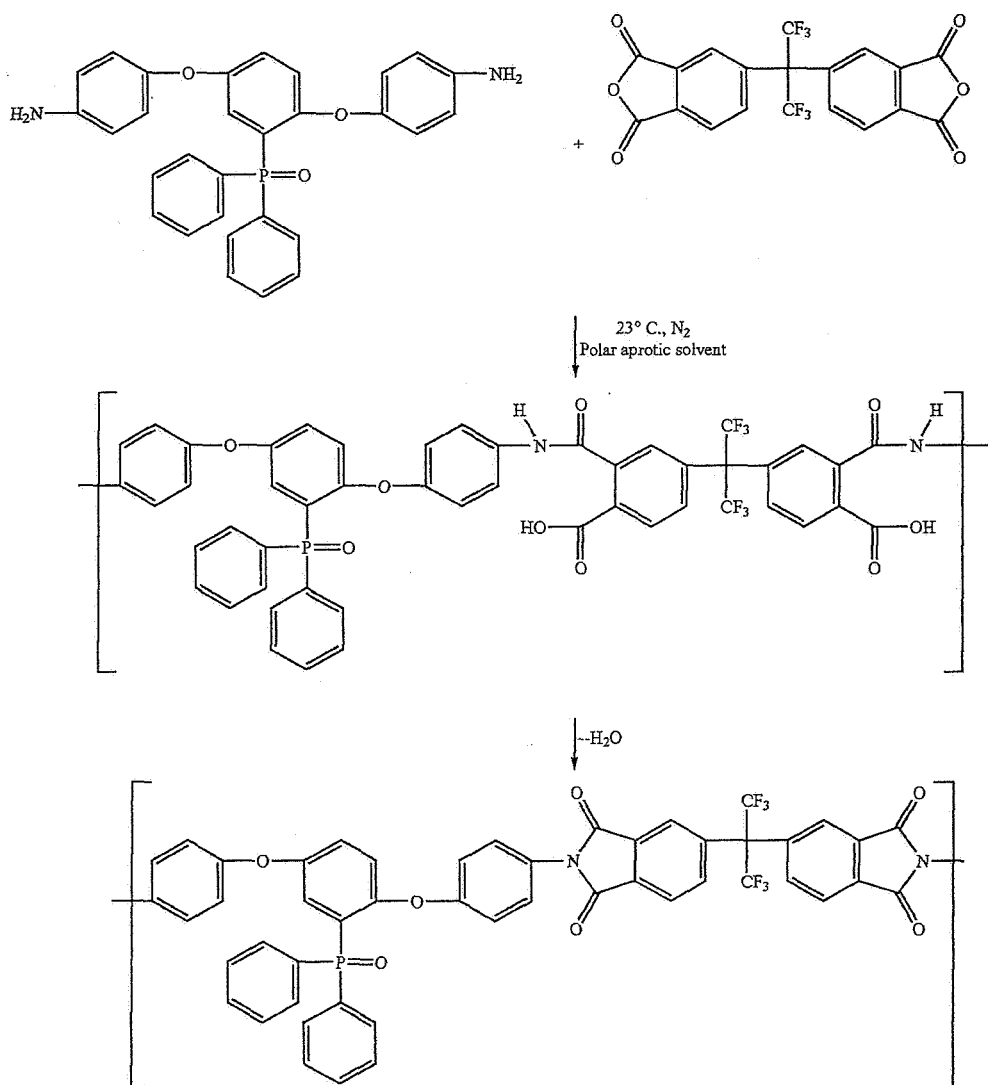
55

The solution was centrifuged and cast on plate glass in a low humidity chamber. The film on plate glass was placed in a forced air oven for 1 hour each at 100, 200, and 300° C. The transparent light amber film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 258° C. as determined by DSC at a heating rate of 20° C./min. Unoriented thin film tensile properties at room temperature were: 21.9 ksi strength, 630 ksi modulus, and 31% elongation at break. For a film thickness of 0.9 mil, the thermal emissivity (ϵ) was 0.533 and the solar absorptance (α) was 0.153. The ratio α/ϵ was 0.287.

60

65

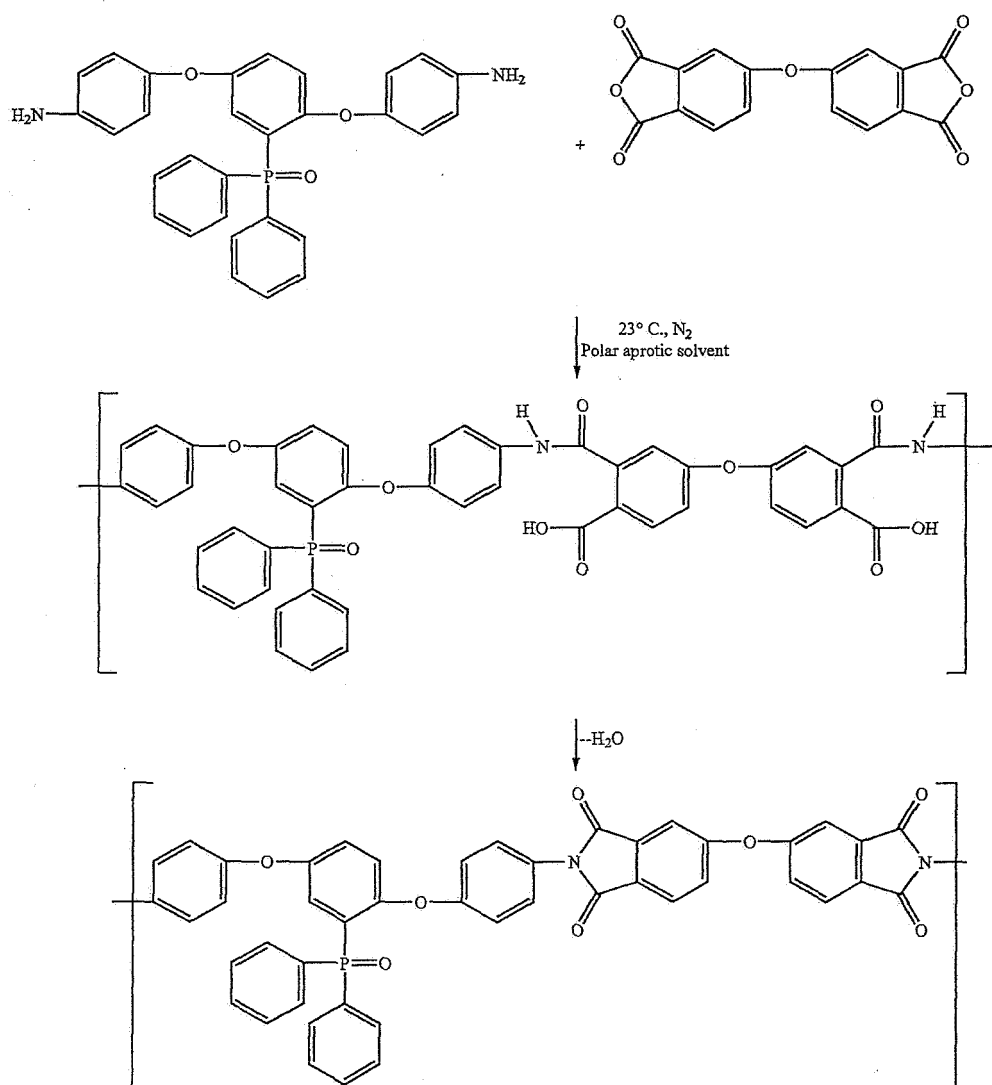
Preparation of polyimide from
4,4'-perfluoroisopropylidene dianhydride and
[2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,5-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (4,4'-APPO, 1.7277 g, 0.0035 mol) and N,N-dimethylacetamide (DMAc, 3.0 mL). Once dissolved, 4,4'-perfluoroisopropylidene dianhydride (1.5584 g, 0.0035 mol) was added as a slurry in 5.0 mL DMAc and rinsed in with additional DMAc (6.0 mL) to give a solution with a concentration of 19.95% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.65 dL/g at 25° C.

The solution was centrifuged and cast on plate glass in a low humidity chamber. The film on plate glass was placed in a forced air oven for 1 hour each at 100, 200, and 300° C. The transparent light amber film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 257° C. as determined by DSC at a heating rate of 20° C./min. Unoriented thin film tensile properties at room temperature were: 19.6 ksi strength, 570 ksi modulus, and 10% elongation at break. For a film thickness of 1.3 mil, the thermal emissivity (ϵ) was 0.606 and the solar absorptance (α) was 0.145. The ratio α/ϵ was 0.239.

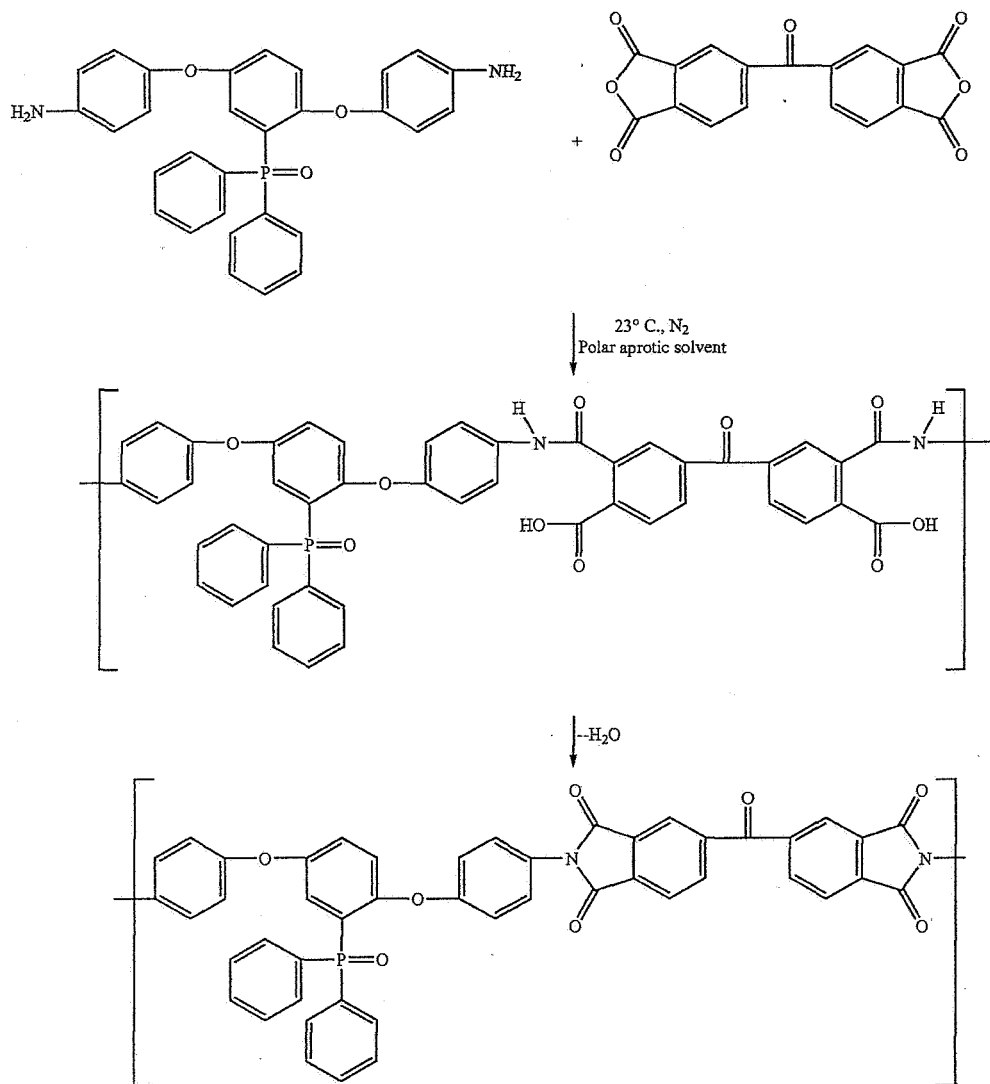
Preparation of polyimide from 4,4'-oxydiphthalic anhydride and [2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,5-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (4,4'-APPO, 2.3840 g, 0.0048 mol) and N,N-dimethylacetamide (DMAc, 5.0 mL). Once dissolved, 4,4'-oxydiphthalic anhydride (1.5016 g, 0.0048 mol) was added as a slurry in 7.0 mL DMAc and rinsed in with additional DMAc (5.0 mL) to give a solution with a concentration of 19.53% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.80 dL/g at 25° C. The

55 solution was centrifuged and cast on plate glass in a low humidity chamber. The film on plate glass was placed in a forced air oven for 1 hour each at 100, 200, and 300° C. The transparent light amber film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 236° C. as determined by DSC at a heating rate of 20° C./min. 60 Unoriented thin film tensile properties at room temperature were: 18.1 ksi strength, 542 ksi modulus, and 14% elongation at break. For a film thickness of 1.5 mil, the thermal emissivity (ε) was 0.622 and the solar absorptance (α) was 0.165. The ratio α/ε was 0.266. 65

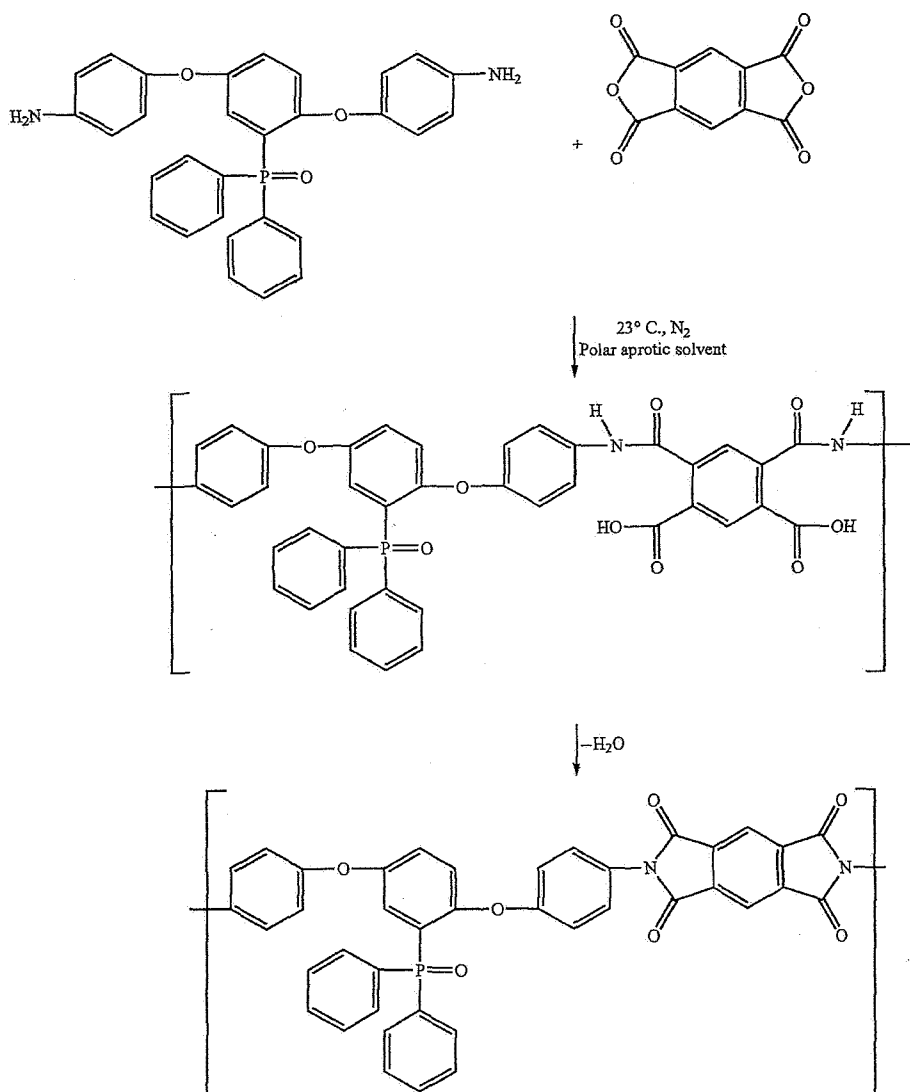
Preparation of polyimide from
4,4'-benzophenonetetracarboxylic dianhydride
and
[2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine
oxide using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,5-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (4,4'-APPO, 2.1134 g, 0.0043 mol) and N,N-dimethylacetamide (DMAc, 5.0 mL). Once dissolved, 4,4'-benzophenone tetracarboxylic dianhydride (1.3827 g, 0.0043 mol) was added as a slurry in 5.0 mL DMAc and rinsed in with additional DMAc (5.0 mL) to give a solution with a concentration of 19.83% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 1.18 dL/g at 25° C.

The solution was centrifuged and cast on plate glass in a low humidity chamber. The film on plate glass was placed in a forced air oven for 1 hour each at 100, 200, and 300° C. The transparent light amber film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 248° C. as determined by DSC at a heating rate of 20° C./min. Unoriented thin film tensile properties at room temperature were: 19.4 ksi strength, 563 ksi modulus, and 9% elongation at break. For a film thickness of 1.3 mil, the thermal emissivity (ϵ) was 0.591 and the solar absorptance (α) was 0.200. The ratio α/ϵ was 0.338.

Preparation of polyimide from pyromellitic dianhydride and [2,5-bis(4-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed [2,5-bis(3-aminophenoxy)-phenyl]diphenylphosphine oxide (4,4'-APPO, 2.2136 g, 0.0045 mol) and N,N-dimethylacetamide (DMAc, 4.0 mL). Once dissolved, pyromellitic dianhydride (0.9803 g, 0.0045 mol) was added as a slurry in 5.0 mL DMAc and rinsed in with additional DMAc (5.0 mL) to give a solution with a concentration of 19.50% solids. The light orange solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.78 dL/g at 25° C. The

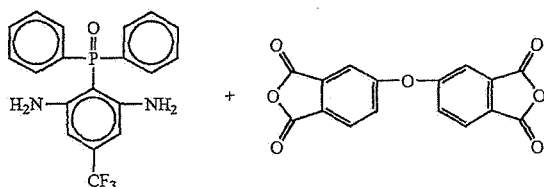
55

solution was centrifuged and cast on plate glass in a low humidity chamber. The film on plate glass was placed in a forced air oven for 1 hour each at 100, 200, and 300° C. The transparent amber film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 281° C. as determined by DSC at a heating rate of 20° C./min. Unoriented thin film tensile properties at room temperature were: 18.4 ksi strength, 553 ksi modulus, and 15% elongation at break. For a film thickness of 1.5 mil, the thermal emissivity (ε) was 0.650 and the solar absorptance (α) was 0.218. The ratio α/ε was 0.335.

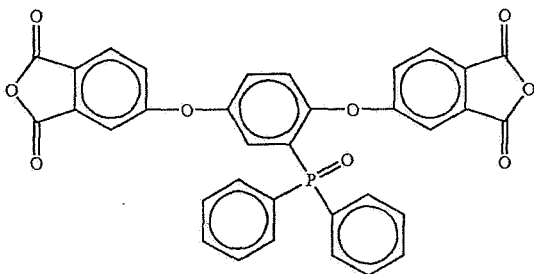
65

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Example 40

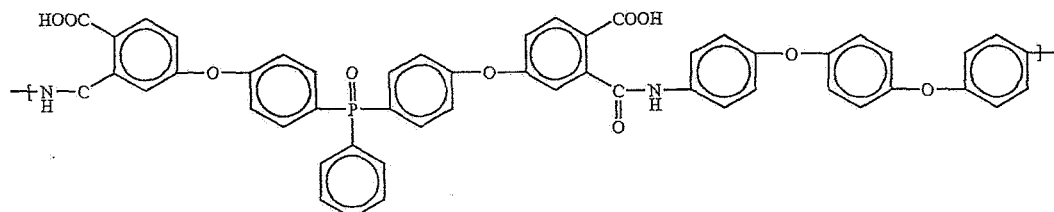
Preparation of polyimide from 4,4'-oxydiphthalic anhydride and (2,6-diamino-4-trifluoromethylphenyl)diphenylphosphine oxide using 1:1 stoichiometry



m-cresol
N₂/200° C.



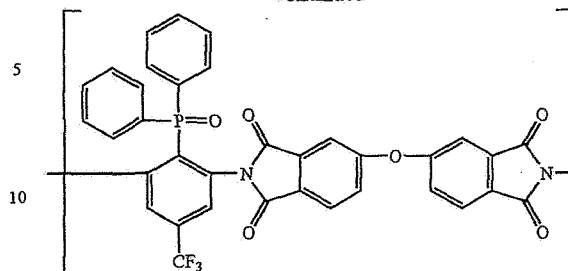
N₂ 23° C.
poplar aprotic solvent



-H₂O

100

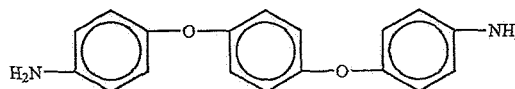
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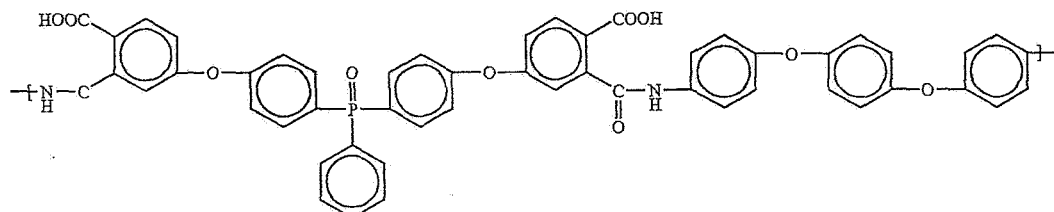
15 Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was placed (2,6-diamino-4-trifluoromethylphenyl)diphenylphosphine oxide (1.6385 g, 0.0045 mol), 4,4'-oxydiphthalic anhydride (1.3507 g, 0.0044 mol), and m-cresol (12.0 mL) to give a solution with a concentration of 19.41% solids. The orange solution was stirred for ~24 hours at ~200° C. A 0.5% (w/v) solution of the polyimide in DMAc exhibited an inherent viscosity of 0.14 dL/g at 25° C. The T_g was 295° C. as determined by DSC at a heating rate of 20° C./min on a powdered sample.

Example 41

30 Preparation of polyimide from 4,4'-(2,5-diphenylphosphineoxidephenylenedioxy)diphthalic anhydride and 1,4-bis(4-aminophenoxy)benzene using 1:1 stoichiometry



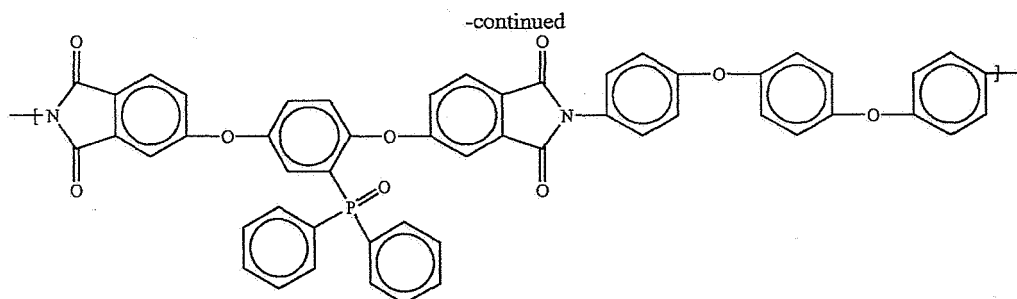
N₂ 23° C.
poplar aprotic solvent



-H₂O

101

102



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed 1,4-bis(4-aminophenoxy)benzene (0.4831 g, 0.0017 mol), 4,4'-(2,5-diphenylphosphineoxidephenylenedioxy)diphthalic anhydride (0.9956 g, 0.0017 mol), and 6 mL of DMAc to give a solution with a concentration of 20% solids. The resulting clear solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.64 dL/g at 25° C. The remaining polymer solution was cast upon a clean glass plate, which was dried to a tack free state in a low humidity chamber. The film was placed in a forced air oven for 30

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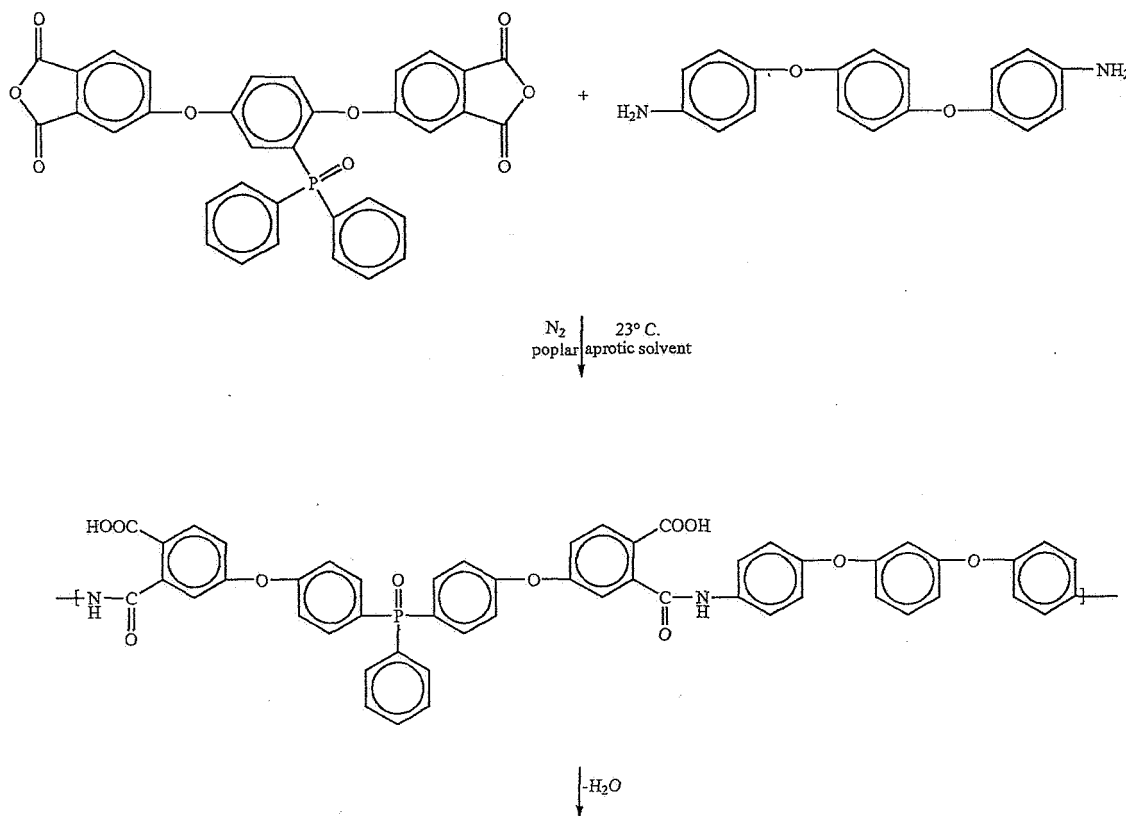
minutes each at 50, 100, and 150° C. and one hour each at 200, 250, and 300° C. The transparent yellow film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 220° C. as determined by DSC at a heating rate of 20° C./min.

20

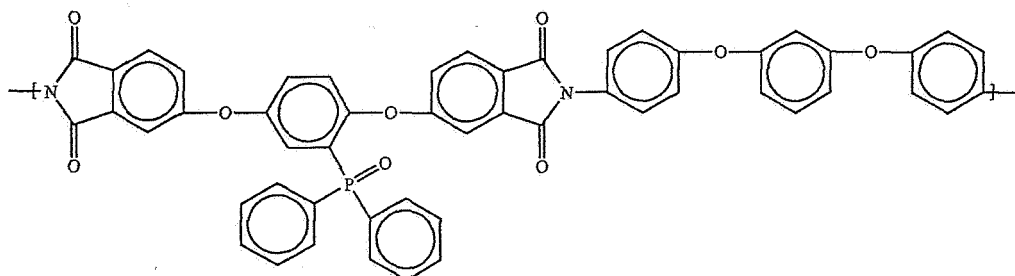
25

Example 42

Preparation of polyimide from 4,4'-(2,5-diphenylphosphineoxidephenylenedioxy)diphthalic anhydride and 1,3-bis(4-aminophenoxy)benzene using 1:1 stoichiometry



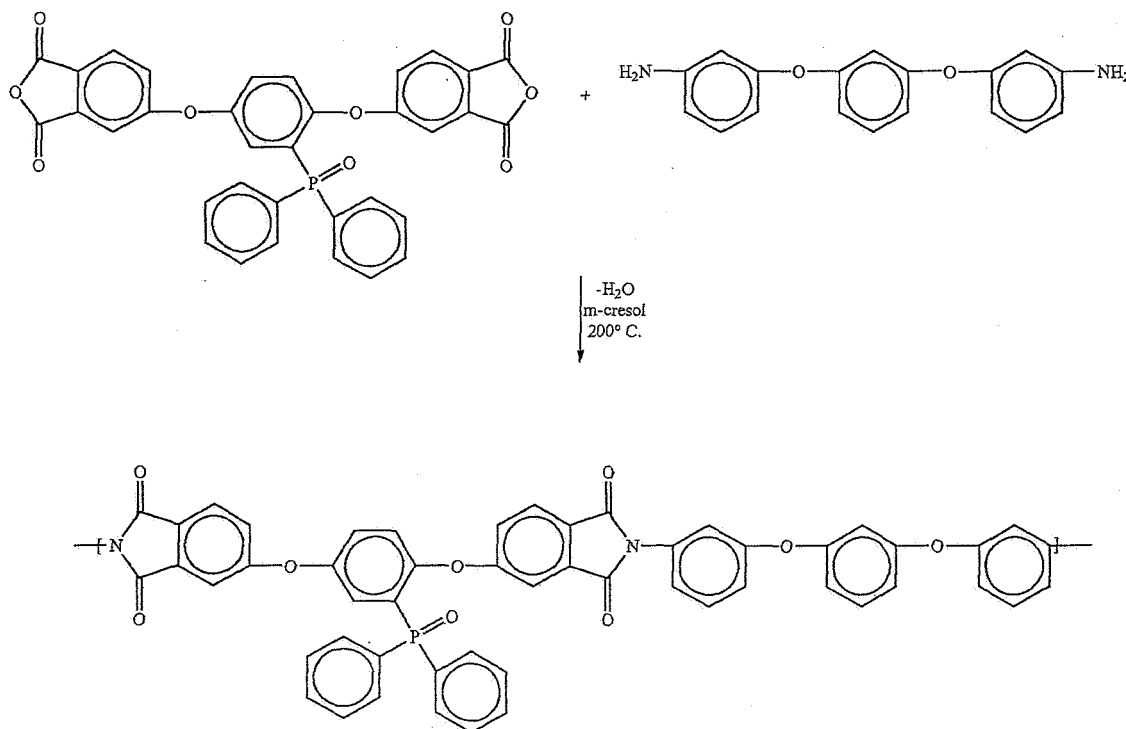
-continued



Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and drying tube filled with calcium sulfate was placed 1,3-bis(4-aminophenoxy)benzene (1.0145 g, 0.0035 mol), 4,4'-(2,5-diphenylphosphineoxydiphenylenedioxy)diphthalic anhydride (2.0909 g, 0.0035 mol), and 12.5 mL of DMAc to give a solution with a concentration of 20% solids. The resulting clear solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.49 dL/g at 25° C. The remaining polymer solution was cast upon a clean glass plate, which was dried to a tack free state in a low humidity chamber. The film was placed in a forced air oven for 30 minutes each at 50, 100, and 150° C. and one hour each at 175, 200, 250, and 300° C. The transparent yellow film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 207° C. as determined by DSC at a heating rate of 20° C./min.

Example 43

Preparation of polyimide from 4,4'-(2,5-diphenylphosphineoxydiphenylenedioxy)diphthalic anhydride and 1,3-bis(3-aminophenoxy)benzene using 1:1 stoichiometry

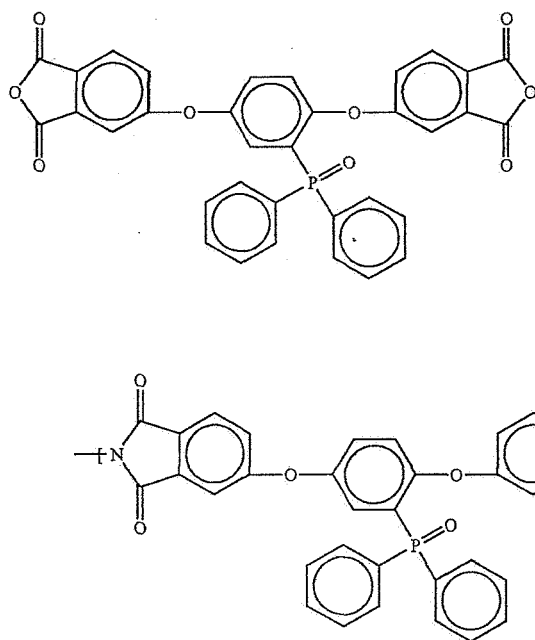


105

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and condenser was placed 1,3-bis(3-aminophenoxy)benzene (0.7294 g, 0.0025 mol), 4,4'-(2,5-diphenylphosphineoxidephenylenedioxy)diphthalic anhydride (1.5033 g, 0.0025 mol), and 8.5 mL of m-cresol. The mixture was heated to 190° C. with an oil bath to give a solution with a concentration of 20% solids. The reaction was stirred at 190° C. under nitrogen for 14 hours. The reaction was cooled and 10 mL of DMAc was added to dilute the viscous yellow solution, and the resulting mixture was precipitated into methanol. The white fibrous solid was collected, stirred in 300 mL of refluxing methanol twice, and stirred in 300 mL of refluxing water for 30 minutes. The solid was collected and dried for 2 hours at 150° C. in a vacuum oven (1.94 g, 90% yield). A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.53 dL/g at 25° C. The remaining solid was used to cast a film from a 20% solids solution in DMAc on to plate glass. The film was dried overnight in a low humidity chamber and then was heated in a forced air oven for one hour each at 50, 100, 150, 175, and 200° C. The transparent colorless film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 182° C. as determined by DSC at a heating rate of 20° C./min.

Example 44

Preparation of polyimide from 4,4'-(2,5-diphenylphosphineoxidephenylenedioxy)diphthalic anhydride and [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide using 1:1 stoichiometry

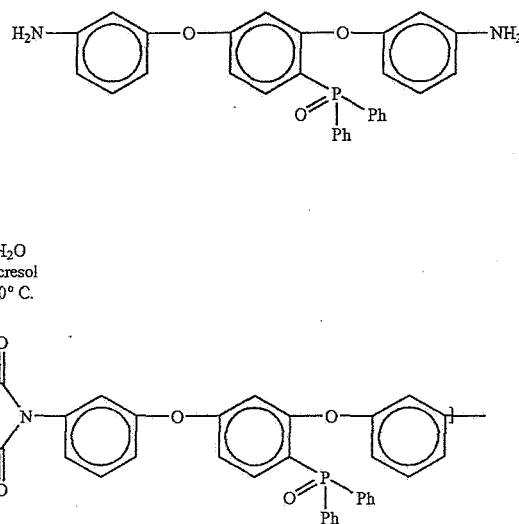


106

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet, and condenser was placed [2,4-bis(3-aminophenoxy)phenyl]diphenylphosphine oxide (1.3148 g, 0.0027 mol), 4,4'-(2,5-diphenylphosphineoxidephenylenedioxy)diphthalic anhydride (1.6080 g, 0.0027 mol), and 10 mL of m-cresol. The mixture was heated to 200° C. with an oil bath to give a solution with a concentration of 22% solids. The reaction was stirred at 200° C. under nitrogen for 14 hours. The reaction was cooled and 10 mL of DMAc was added to dilute the viscous yellow solution, and the resulting mixture was precipitated into methanol. The white fibrous solid was collected, stirred in 400 mL of refluxing methanol twice, and stirred in 500 mL of refluxing water for an hour. The solid was taken up in 13 mL of DMAc and the resulting solution was precipitated into water. The white fibrous precipitate was collected and dried for 6 hours at 125° C. in a vacuum oven (2.63 g, 94% yield). A 0.5% (w/v) solution in DMAc exhibited an inherent viscosity of 0.55 dL/g at 25° C. A solution of 2.13 g polymer in 9 mL of DMAc was cast onto plate glass. The film was dried overnight in a low humidity chamber and then was heated in a forced air oven for one hour each at 50, 100, 150, 175, 200 and 220° C. The transparent colorless film was subsequently removed from the glass. The film exhibited good flexibility and a T_g of 203° C. as determined by DSC at a heating rate of 20° C./min.

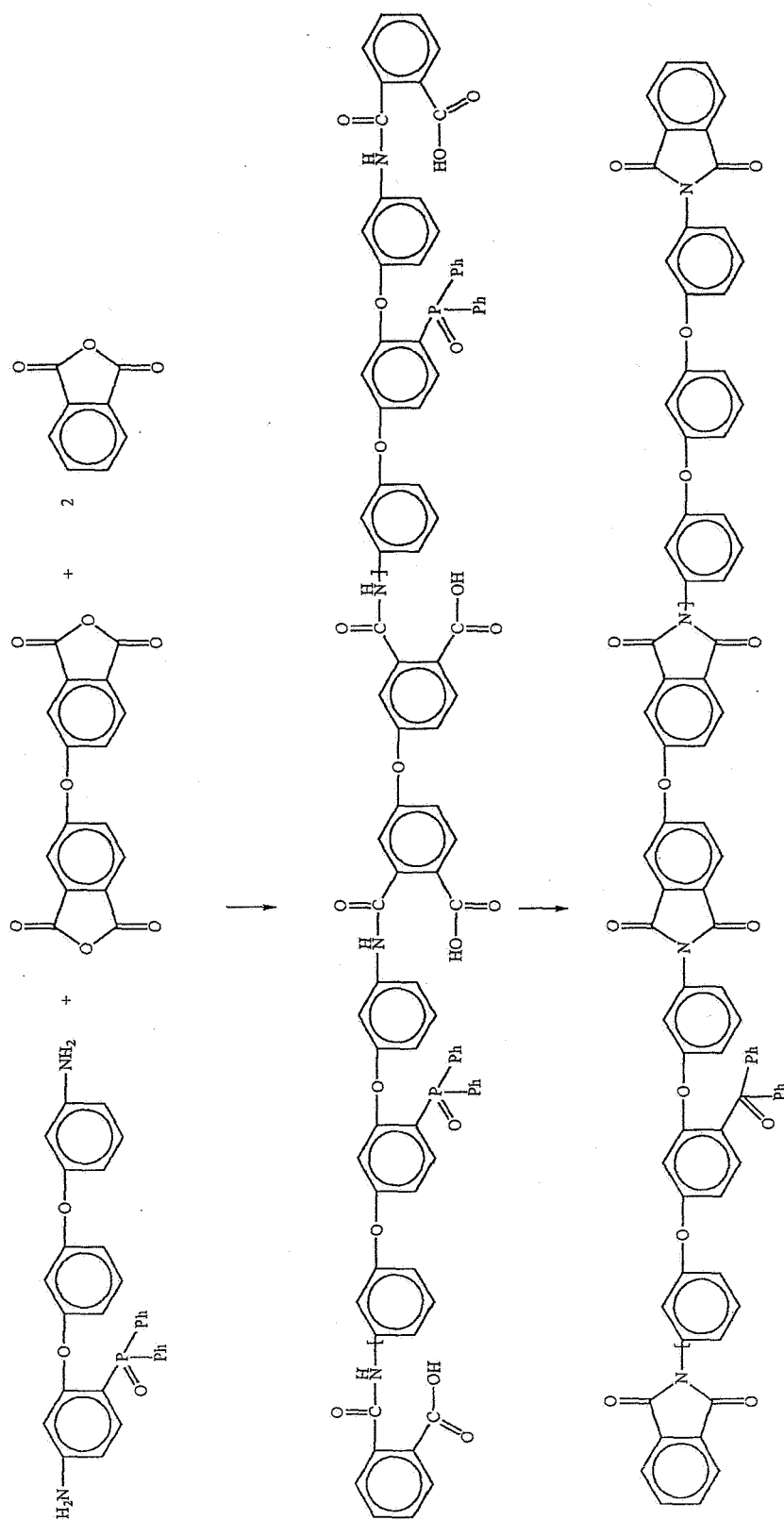
Example 45

Preparation of a poly(amide acid) solution and polyimide film from [2,4-bis(3-aminophenoxy)phenyl]-diphenylphosphine oxide and oxydiphthalic dianhydride endcapped with phthalic anhydride with a calculated molecular weight of 20,000 grams/mole



107

108



109

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was [2,4-bis(3-aminophenoxy)phenyl]-diphenylphosphine oxide (3.0697 g, 6.2328×10^{-3} mole) and N,N-dimethylacetamide (10.0 g). The diamine dissolved within a few minutes and oxydiphthalic dianhydride powder (1.8608 g, 5.9984×10^{-3} mole) was added followed by phthalic anhydride (0.0695 g, 4.6888×10^{-4} mole) along with additional N,N-dimethylacetamide (10 g) to give a solution with a concentration of 20% solids weight/weight. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% solution in N,N-dimethylacetamide exhibited an inherent viscosity of 0.39 dL/g at 25° C. A thin film was cast at 15 mils thick onto plate glass using a doctor blade and

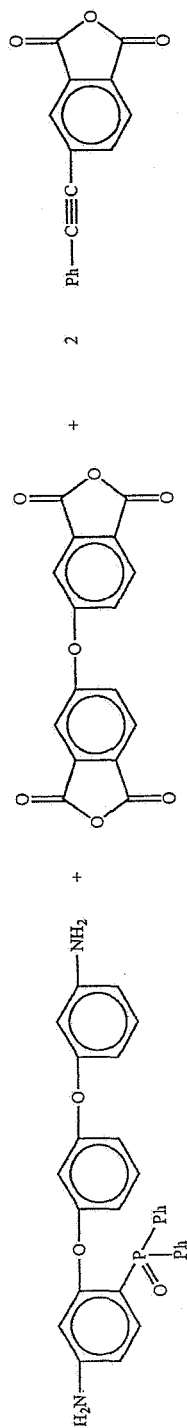
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allowed to dry to a tack-free state in a dust free chamber. The film on plate glass was stage dried in a forced air oven for 1 hour each at 100, 200 and 250° C. The brittle yellow film exhibited a T_g of 196° C.

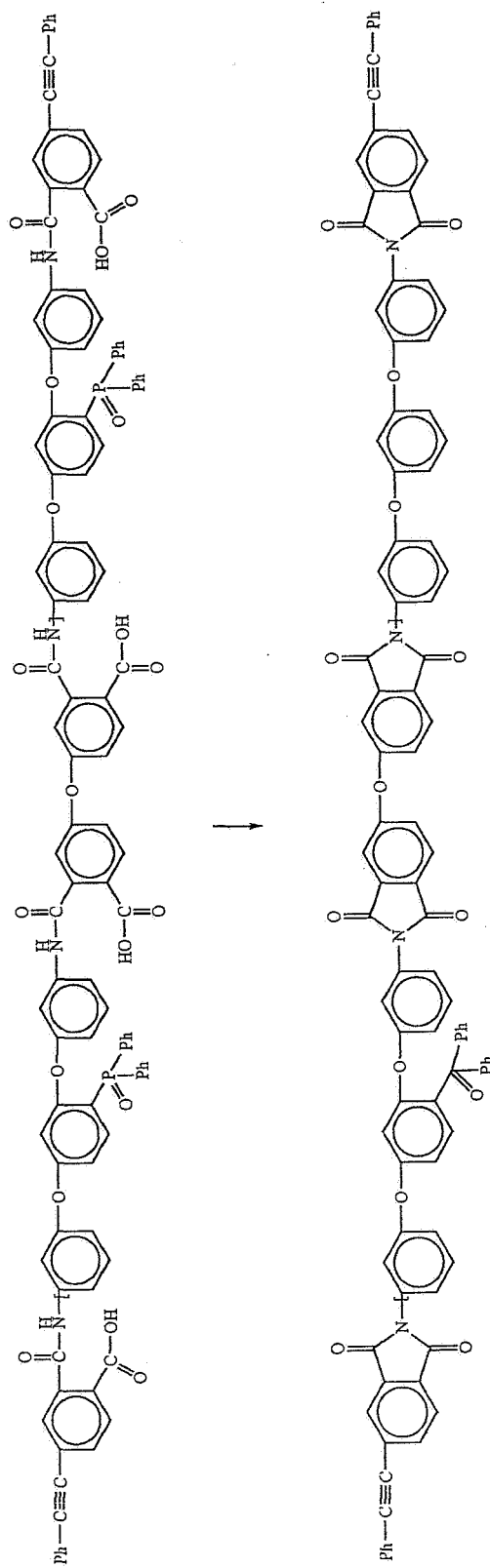
Example 46

Preparation of a poly(amide acid) solution and a polyimide film from
[2,4-bis(3-aminophenoxy)phenyl]-diphenylphosphine oxide and oxydiphthalic dianhydride endcapped with phenylethynylphthalic anhydride with an estimated molecular weight of 5,000 grams/mole

111



112



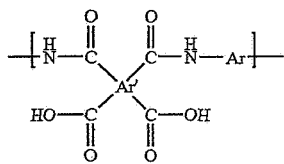
113

Into a 100 mL three neck round bottom flask equipped with a mechanical stirrer, nitrogen gas inlet and drying tube filled with calcium sulfate was [2,4-bis(3-aminophenoxy)phenyl]-diphenylphosphine oxide (2.9894 g, 6.0698×10^{-3} mole) and N,N-dimethylacetamide (7.0 g). The diamine dissolved within a few minutes and oxydiphthalic dianhydride powder (1.6148 g, 5.2053×10^{-3} mole) was added followed by phenylethynylphthalic anhydride (0.4292 g, 1.7289×10^{-3} mole) along with additional N,N-dimethylacetamide (6.74 g) to give a solution with a concentration of 30% solids weight/weight. The light yellow solution was stirred overnight at room temperature under a nitrogen atmosphere. A 0.5% solution in N,N-dimethylacetamide exhibited an inherent viscosity of 0.21 dL/g at 25° C. A thin film was cast at 15 mils thick onto plate glass using a doctor blade. The film on plate glass was stage dried in a forced air oven for 1 hour each at 100, 200, 300 and 371° C. The brittle dark film exhibited a T_g 190° C.

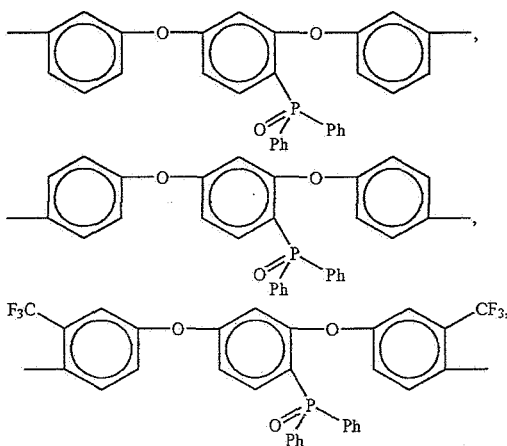
The invention described herein produces polyimides and copolyimides with a unique combination of properties that make these materials particularly useful for a variety of applications on spacecraft. It pertains to the synthesis of diamines and dianhydrides that are subsequently used to prepare polyimides and copolyimides that exhibit low color, low solar absorptivity, high optical transparency, atomic oxygen resistance, VUV and UV resistance, solubility in organic solvents in the imide form, high T_g s, and high thermal stability. This combination of properties in aromatic polyimides or copolyimides is unprecedented.

We claim:

1. Poly(amide acid)s comprising the general structural formula:

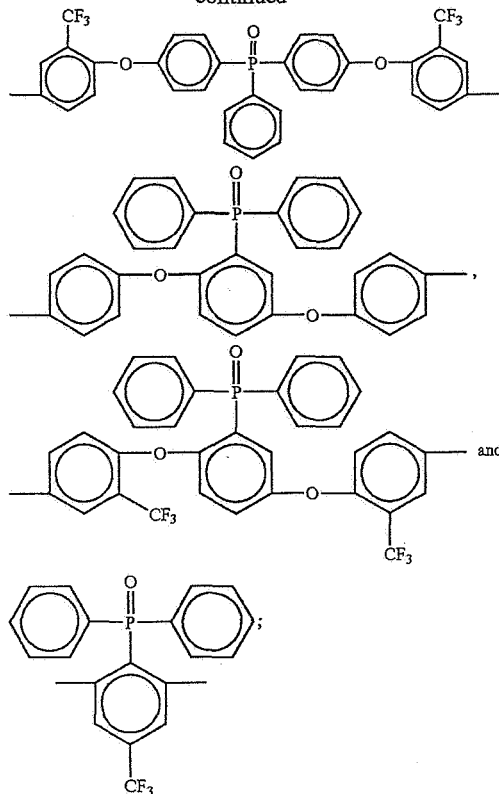


wherein Ar is a member selected from the group consisting of:



114

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wherein Ar' is a tetravalent radical,

wherein Ph is phenyl,

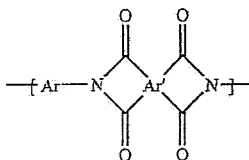
and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

2. A product prepared from the poly(amide acid)s of claim 1, said product being selected from the group consisting of film, fiber, molding, adhesive, composite, and foam.

3. The poly(amide acid)s of claim 1, wherein said poly(amide acid)s are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

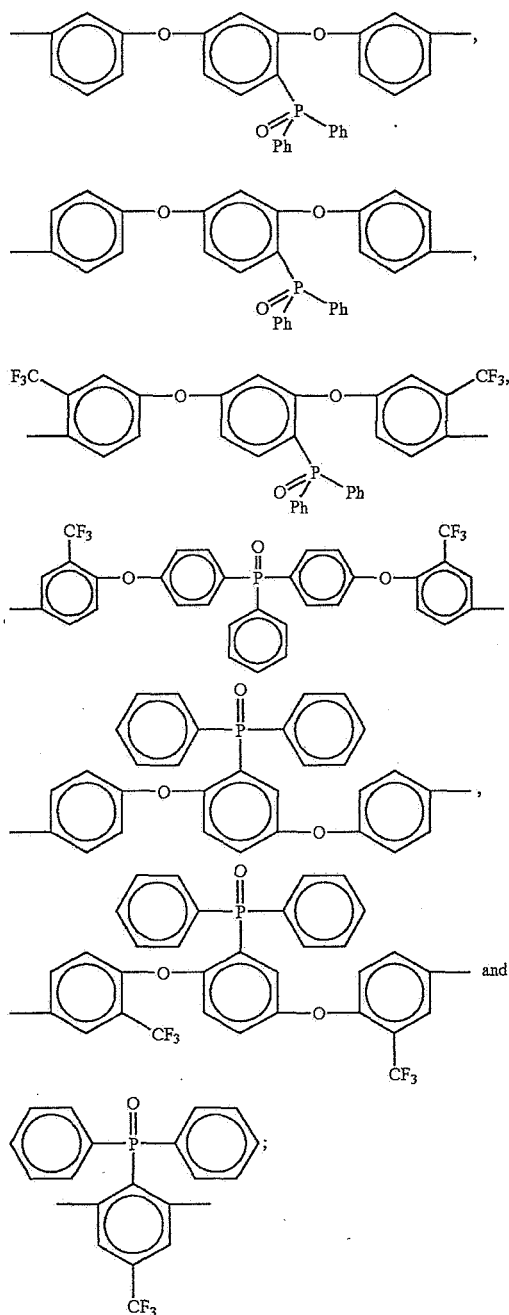
4. A product prepared from the poly(amide acid)s of claim 3, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

5. Polyimides comprising the general structural formula:



wherein Ar is a member selected from the group consisting of:

115



wherein Ar' is a tetravalent radical,
wherein Ph is phenyl,

and wherein the number average molecular weight
approximately ranges from 700 g/mole to 100,000 g/mole.

6. A product prepared from the polyimides of claim 5, said
product being selected from the group consisting of a film,
a fiber, a molding, an adhesive, a composite, and a foam.

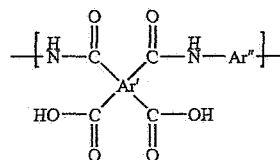
7. The polyimides of claim 5, wherein said polyimides are
endcapped with a member selected from the group consist-

116

ing of an optionally substituted monofunctional amine and
an optionally substituted monofunctional anhydride com-
pound.

8. A product prepared from polyimides of claim 7, said
product being selected from the group consisting of a film,
a fiber, a molding, an adhesive, a composite, and a foam.

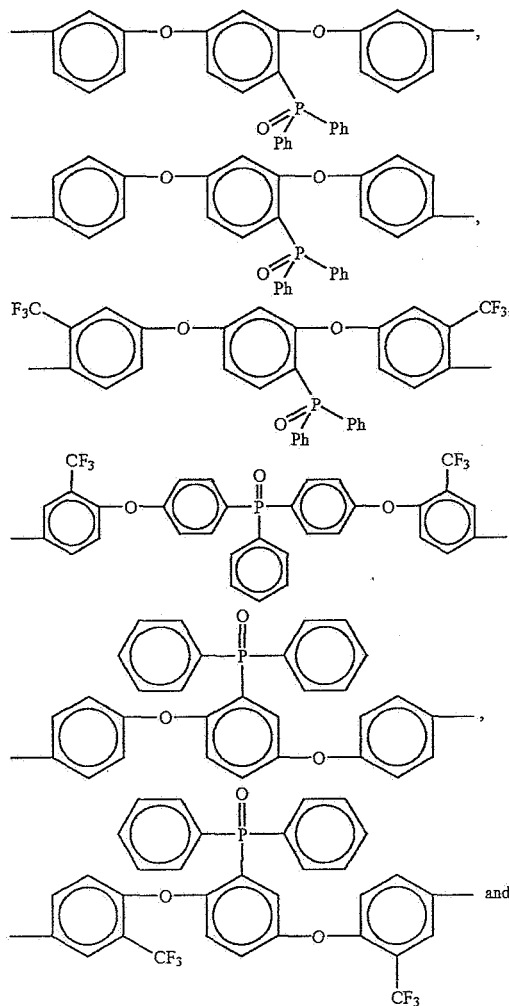
9. Copoly(amide acid)s comprising the general structural
formula:



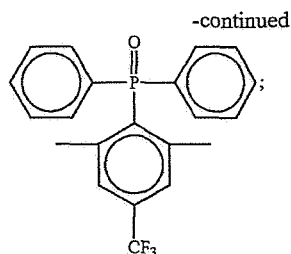
wherein Ar' is a tetravalent radical,

wherein Ar'' is a mixture of first and second divalent
radicals,

wherein said first divalent radical is a member selected
from the group consisting of:



117



wherein said second divalent radical is different from said first divalent radical,

wherein Ph is phenyl,

wherein the molar ratio of said first divalent radical to said second divalent radical approximately ranges from 1 to 99,

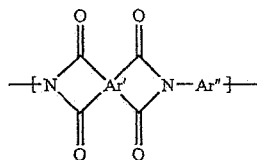
and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

10. A product prepared from the copoly(amide acid)s of claim 9, said product being selected from the group consisting of film, fiber, molding, adhesive, composite, and foam.

11. The copoly(anlide acid)s of claim 9, wherein said copoly(amide acid)s are encapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

12. A product prepared from the copoly(amide acid)s of claim 11, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

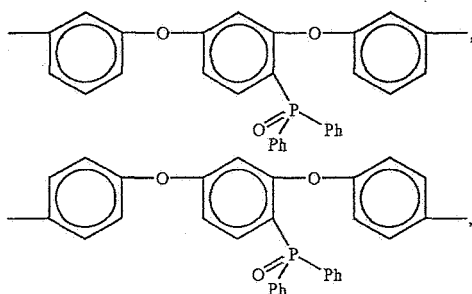
13. Copolyimides comprising the general structural formula:



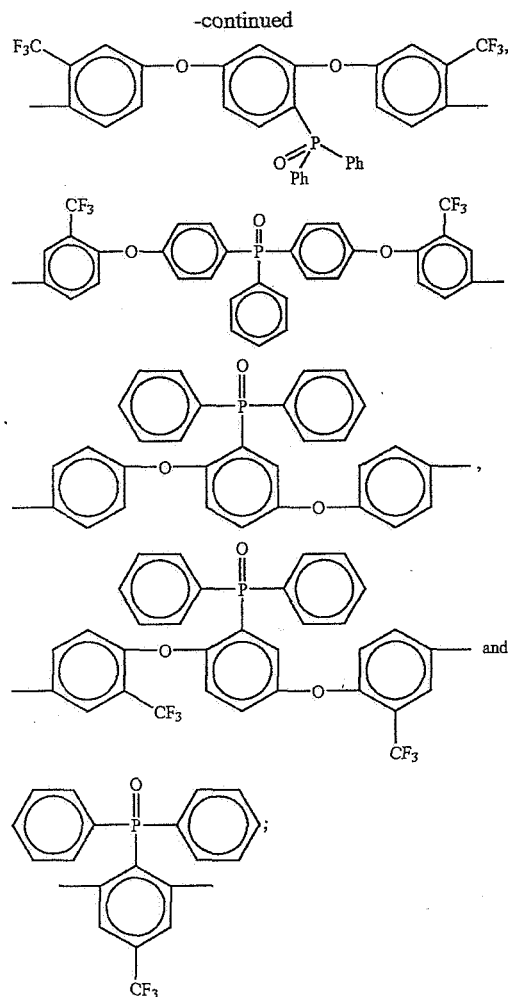
wherein Ar' is a tetravalent radical,

wherein Ar'' is a mixture of first and second diamine-derived divalent radicals,

wherein said first diamine-derived divalent radical is a member selected from the group consisting of:



118



wherein said second diamine-derived divalent radical is different from said first diamine-derived divalent radical,

wherein the molar ratio of said first diamine-derived divalent radical to said second diamine-derived divalent radical approximately ranges from 1 to 99,

and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

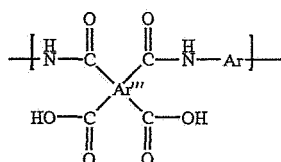
14. A product prepared from the copolyimides of claim 13, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

15. The copolyimides of claim 13, wherein said copolyimides are encapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

16. A product prepared from the copolyimides of claim 15, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

119

17. Copoly(amide acid)s comprising the general structural formula:

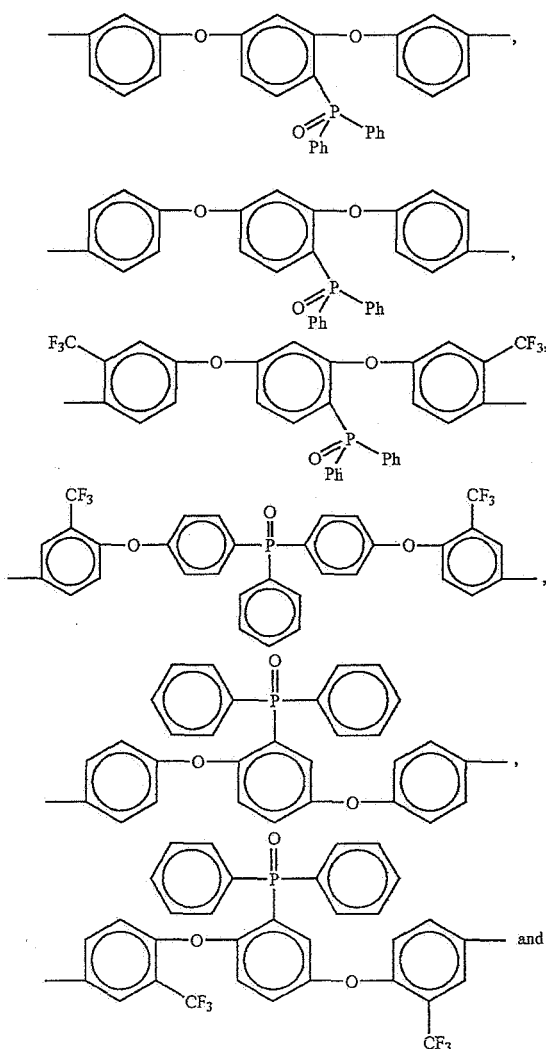


wherein Ar''' is a mixture of first and second dianhydride-derived tetravalent radicals,

wherein said second dianhydride-derived tetravalent radical is different from said first dianhydride-derived tetravalent radical,

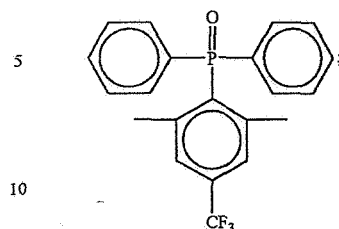
wherein the molar ratio of said first dianhydride-derived tetravalent radical to said second dianhydride-derived tetravalent radical approximately ranges from 1 to 99,

wherein Ar is a member selected from the group consisting of:



120

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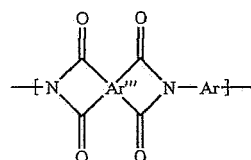
and wherein the number average molecular weight ranges from approximately 700 g/mole to 100,000 g/mole.

18. A product prepared from the copoly(amide acid)s of claim 17, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

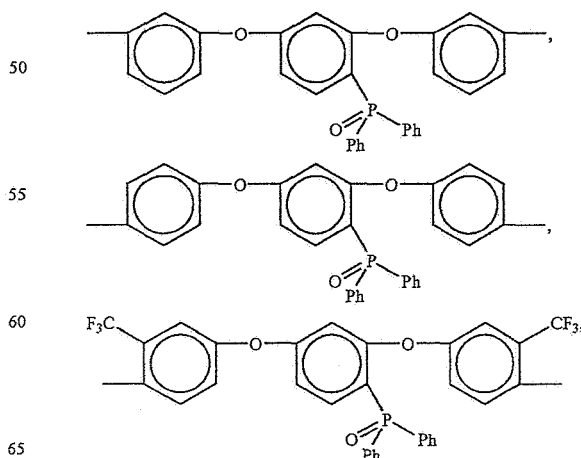
19. The copoly(amide acid)s of claim 17 wherein said copoly(amide acid)s are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

20. A product prepared from copoly(amide acid)s of claim 19, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

21. Copolyimides comprising the general structural formula:

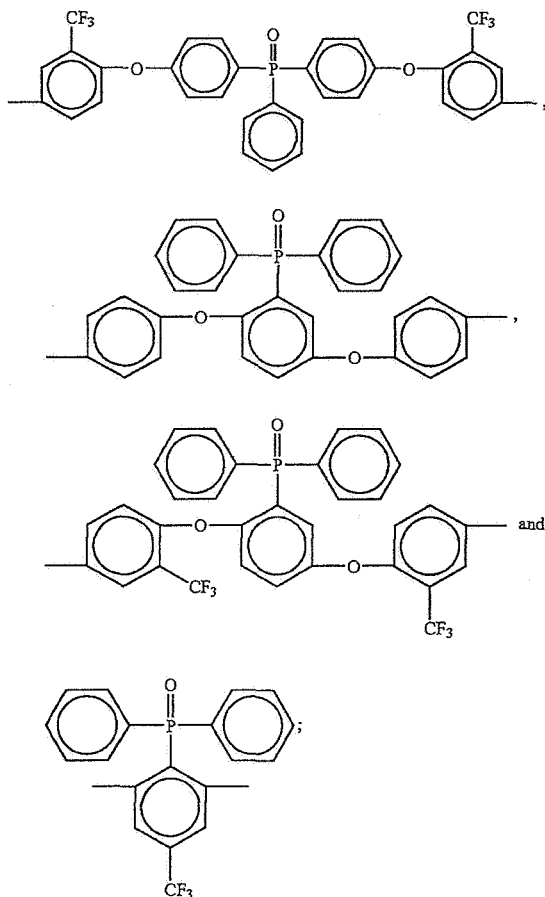


wherein Ar is a member selected from the group consisting of:



121

-continued



wherein Ar^{III} represents a mixture of first and second dianhydride-derived tetravalent radicals,

wherein said second dianhydride-derived tetravalent radical is different from said first dianhydride-derived divalent radical,

wherein the molar ratio of said first dianhydride-derived tetravalent radical to said second dianhydride-derived tetravalent radical approximately ranges from 1 to 99, and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

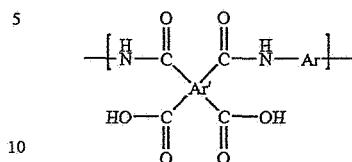
22. A product prepared from the copolyimides of claim 21, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

23. The copolyimides of claim 21, wherein said copolyimides are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

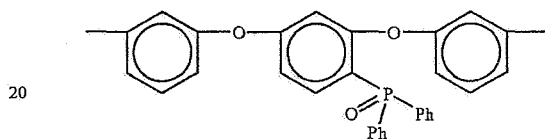
24. A product prepared from copolyimides of claim 23, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

122

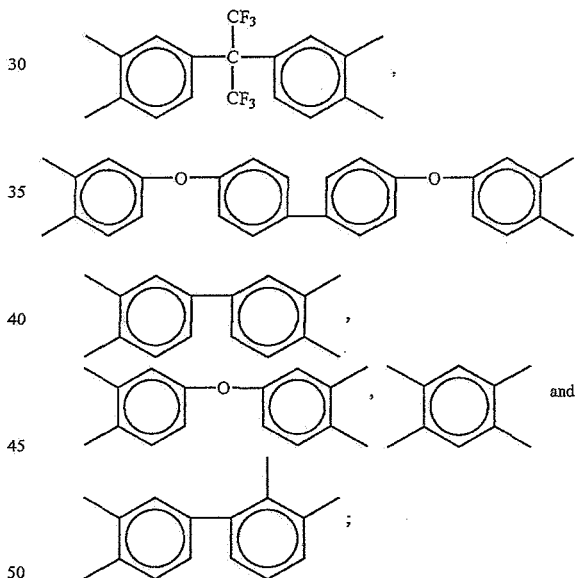
25. Poly(amide acid)s comprising the general structural formula:



wherein Ar is



wherein Ar' is a member selected from the group consisting of:



and wherein Ph is phenyl.

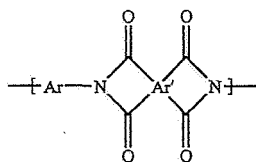
26. A product prepared from the poly(amide acid)s of claim 25, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

27. The poly(amide acid)s of claim 25, wherein said poly(amide acid)s are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

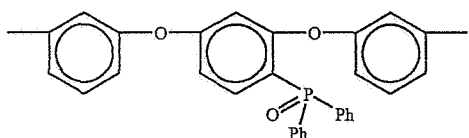
28. A product prepared from poly(amide acid)s of claim 27, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

123

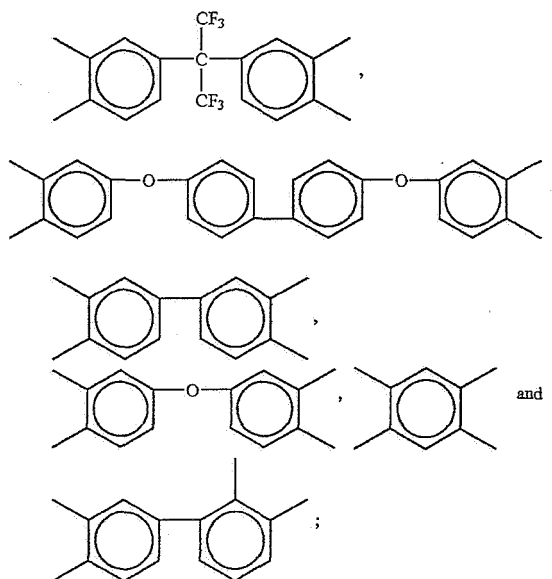
29. Polyimides comprising the general structural formula:



wherein Ar is



wherein Ar' is a member selected from the group consisting of:



and wherein Ph is phenyl.

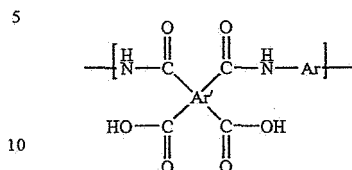
30. A product prepared from the polyimides of claim 29, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

31. The polyimides of claim 29, wherein said polyimides are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

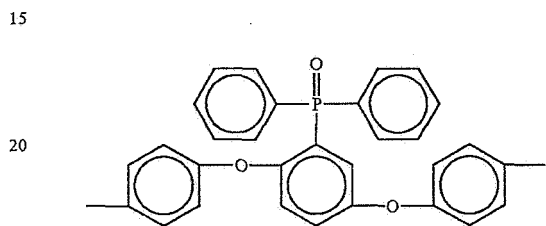
32. A product prepared from the polyimides of claim 31, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

124

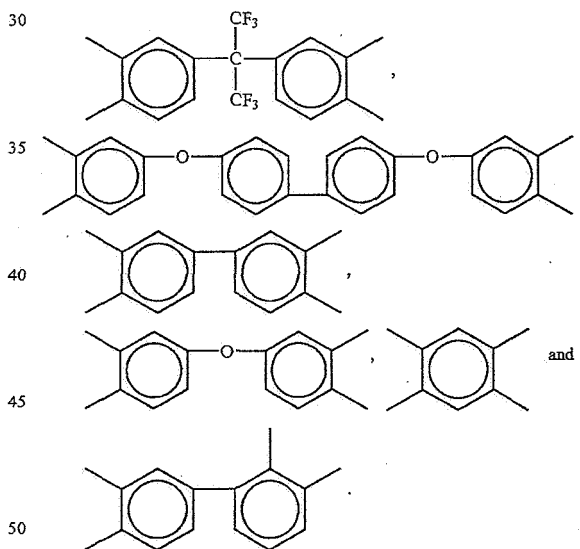
33. Poly(amide acid)s comprising the general structural formula:



wherein A_r is



wherein Ar' is a member selected from the group consisting of:



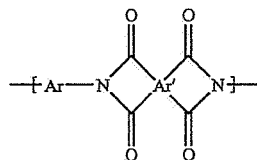
34. A product prepared from the poly(amide acid)s of claim 33, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

35. The poly(amide acid)s of claim 33, wherein said poly(amide acid)s are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

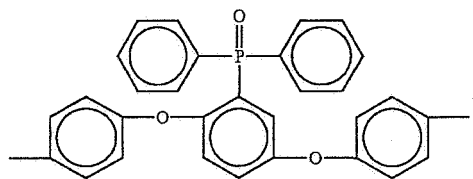
36. A product prepared from poly(amide acid)s of claim 35, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

125

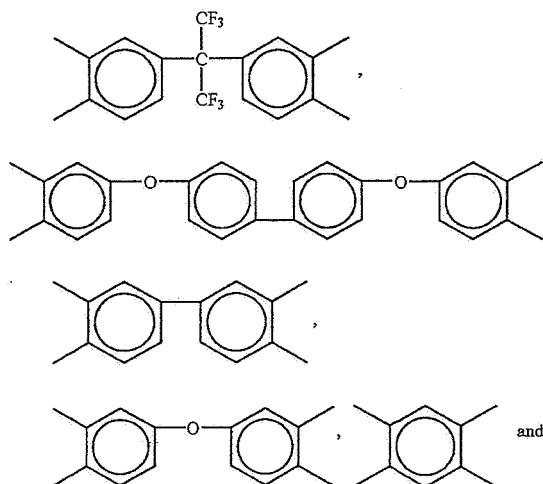
37. Polyimides comprising the general structural formula:



wherein Ar is

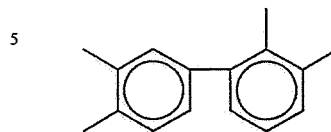


wherein Ar' is a member selected from the group consisting of:



126

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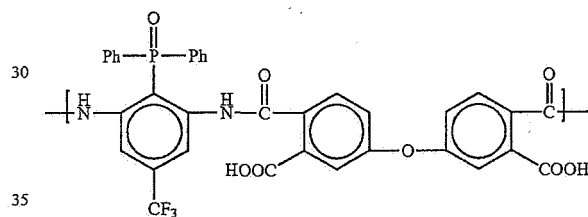


38. A product prepared from the polyimides of claim 37, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

39. The polyimides of claim 37, wherein said polyimides are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

40. A product prepared from polyimides of claim 39, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

41. Poly(amide acid)s comprising the general structural formula:



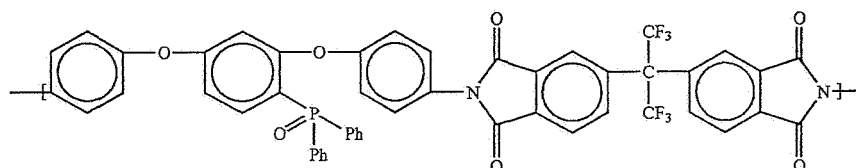
and wherein Ph is phenyl.

42. A product prepared from the poly(amide acid)s of claim 41, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

43. The poly(amide acid)s of claim 41, wherein said poly(amide acid)s are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

44. A product prepared from poly(amide acid)s of claim 43, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

45. Polyimides comprising the general structural formula:



and wherein Ph is phenyl.

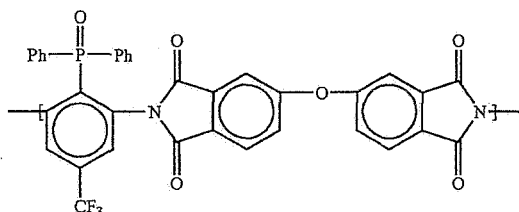
127

46. A product prepared from the polyimides of claim 45, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

47. The polyimides of claim 45, wherein said polyimides are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

48. A product prepared from polyimides of claim 47, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

49. Polyimides comprising the general structural formula:



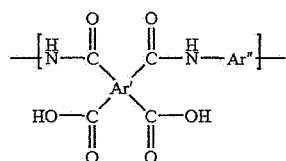
and wherein Ph is phenyl.

50. A product prepared from the polyimides of claim 49, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

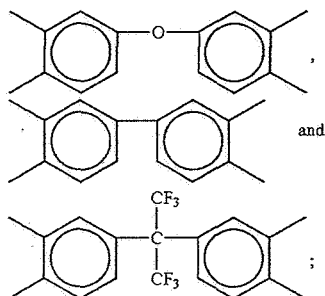
51. The polyimides of claim 49, wherein said polyimides are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

52. A product prepared from polyimides of claim 51, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

53. Copoly(amide acid)s comprising the general structural formula:



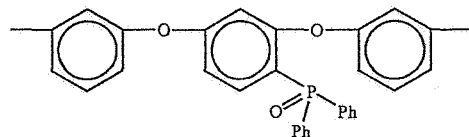
wherein Ar' is a member selected from the group consisting of:



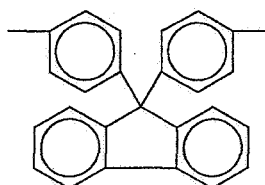
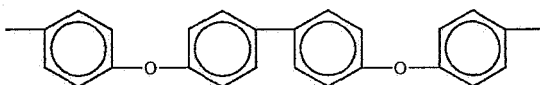
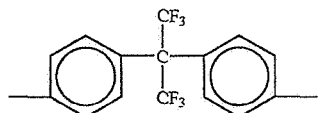
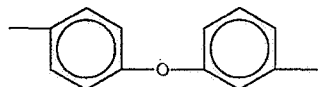
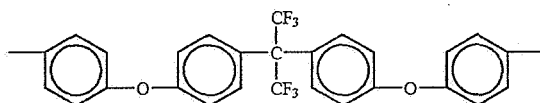
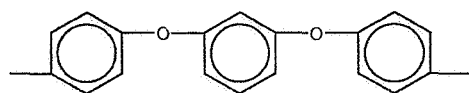
128

wherein Ar'' is a mixture of Ar and X;

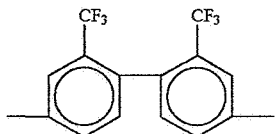
wherein Ar has the general structural formula:



wherein X is a member selected from the group consisting of:



and



wherein the molar ratio of Ar to X is approximately 75 to 25,

wherein Ph is phenyl,

and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

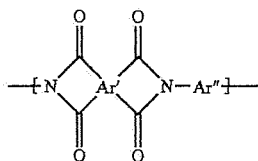
129

54. A product prepared from the copoly(amide acid)s of claim 53 said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

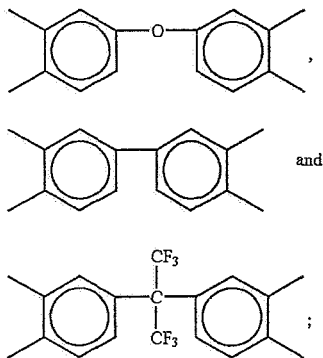
55. The copoly(amide acid)s of claim 53, wherein said copoly(amide acid)s are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

56. A product prepared from copoly(amide acid)s of claim 55, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

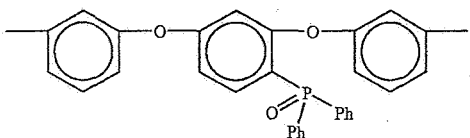
57. Copolyimides comprising the general structural formula:



wherein Ar' is a member selected from the group consisting of:

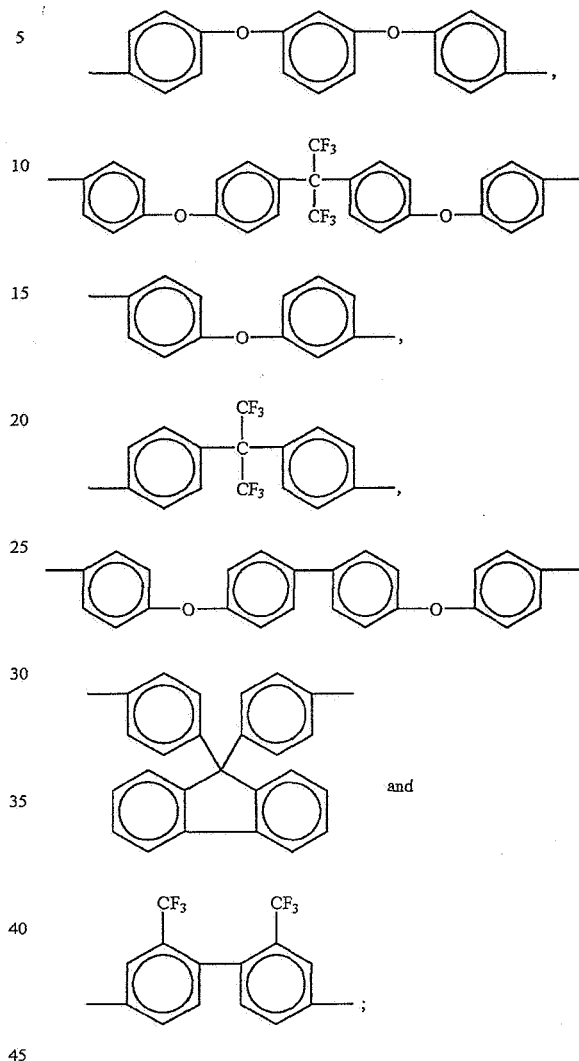


wherein Ar'' is a mixture of Ar and X,
wherein Ar has the general structural formula:



wherein Ph is phenyl,
wherein X is a member selected from the group consisting of:

130



wherein the molar ratio of Ar to X is approximately 75 to 25,

and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

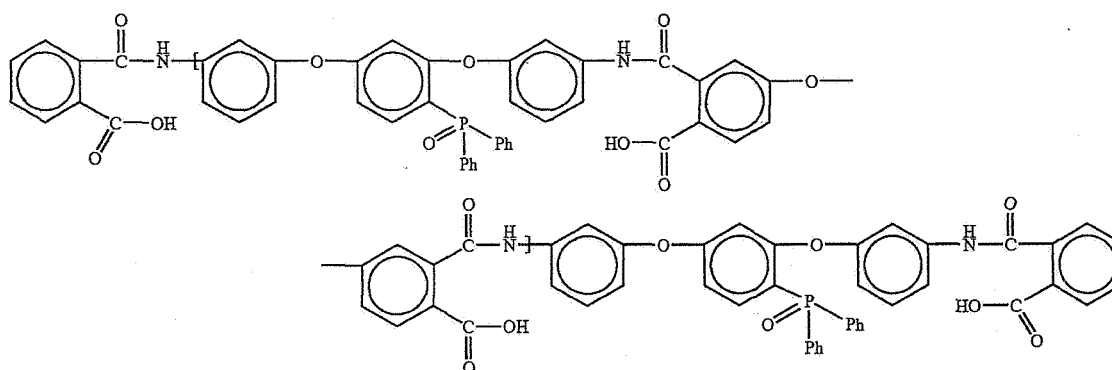
58. A product prepared from the copolyimides of claim 57, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

59. The copolyimides of claim 57, wherein said copolyimides are endcapped with a member selected from the group consisting of an optionally substituted monofunctional amine and an optionally substituted monofunctional anhydride compound.

60. A product prepared from copolyimides of claim 59, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

131

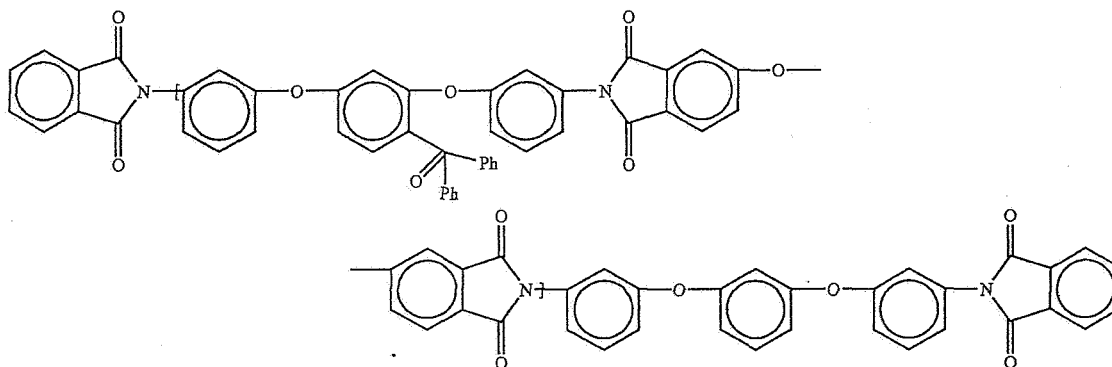
61. Phthalic anhydride poly(amide acid)s comprising the general structural formula:



wherein Ph is phenyl and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

62. A product prepared from the poly(amide acid)s of claim 61, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

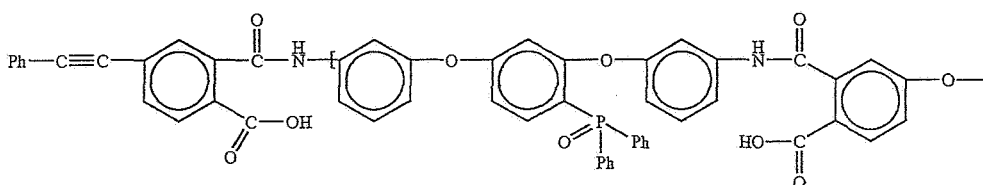
63. Phthalic anhydride terminated polyimides comprising the general structural formula:



wherein Ph is phenyl and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

64. A product prepared from the polyimides of claim 63, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

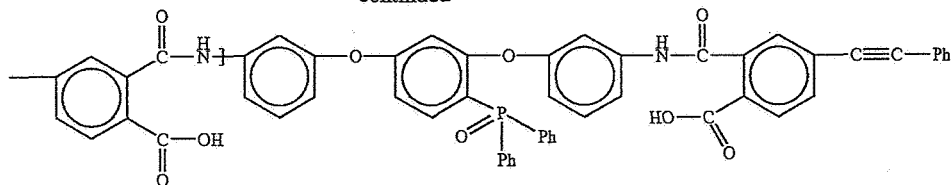
65. Phenylethynyl phthalic anhydride terminated poly(amide acid)s comprising the general structural formula:



133

134

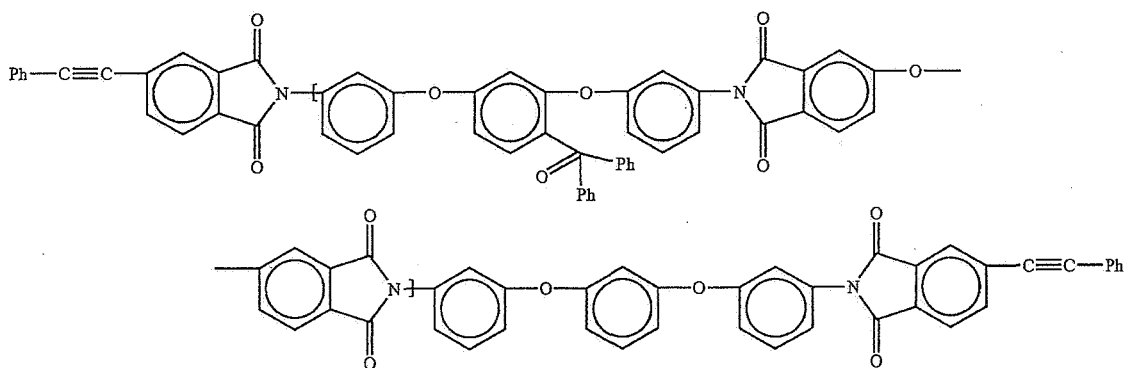
-continued



wherein Ph is phenyl, and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

66. A product prepared from the poly(amide acid)s of claim 65, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

67. Phenylethynyl phthalic anhydride terminated polyimides comprising the general structural formula:



wherein Ph is phenyl, and wherein the number average molecular weight approximately ranges from 700 g/mole to 100,000 g/mole.

68. A product prepared from the polyimides of claim 67, said product being selected from the group consisting of a film, a fiber, a molding, an adhesive, a composite, and a foam.

* * * * *